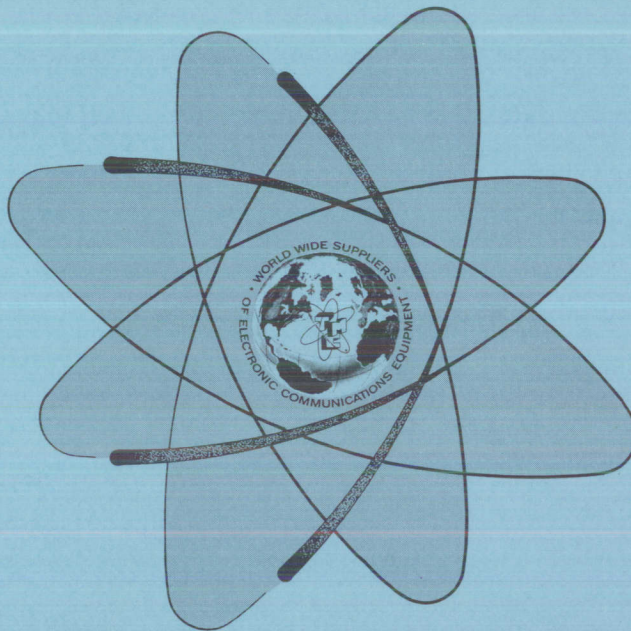


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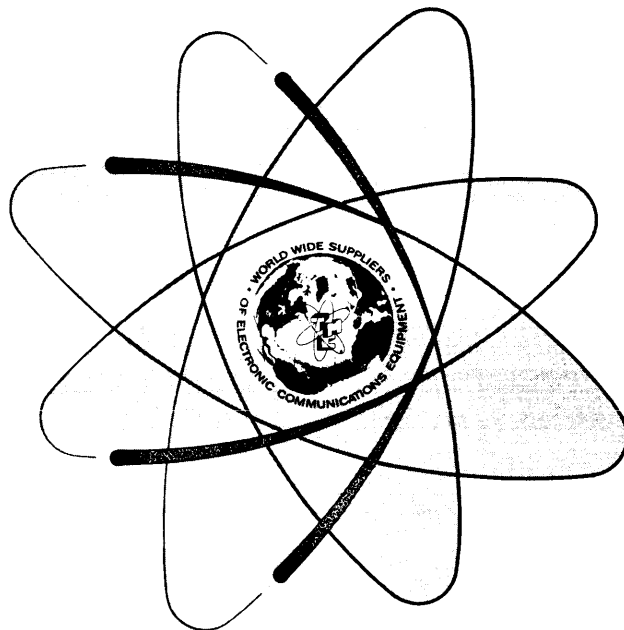
SERVICE MANUAL  
FOR  
MULTI-MODE,  
CHANNELIZED EXCITER  
MODEL MFER-1



THE TECHNICAL MATERIEL CORPORATION  
MAMARONECK, N.Y.

OTTAWA, ONTARIO

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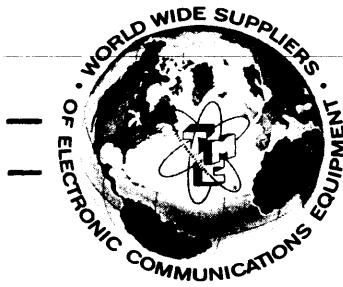


THE TECHNICAL MATERIEL CORPORATION  
MAMARONECK, N. Y.

OTTAWA, ONTARIO

NOTICE

THE CONTENTS AND INFORMATION CONTAINED  
IN THIS INSTRUCTION MANUAL IS PROPRIETARY  
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TO BE USED AS A GUIDE TO THE OPERATION  
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MATERIEL CORPORATION.



# THE TECHNICAL MATERIEL CORPORATION

C O M M U N I C A T I O N S   E N G I N E E R S

700 FENIMORE ROAD

MAMARONECK, N. Y.

## W a r r a n t y

The Technical Materiel Corporation, hereinafter referred to as TMC, warrants the equipment (except electron tubes,\*fuses, lamps, batteries and articles made of glass or other fragile or other expendable materials) purchased hereunder to be free from defect in materials and workmanship under normal use and service, when used for the purposes for which the same is designed, for a period of one year from the date of delivery F.O.B. factory. TMC further warrants that the equipment will perform in a manner equal to or better than published technical specifications as amended by any additions or corrections thereto accompanying the formal equipment offer.

TMC will replace or repair any such defective items, F.O.B. factory, which may fail within the stated warranty period, PROVIDED:

1. That any claim of defect under this warranty is made within sixty (60) days after discovery thereof and that inspection by TMC, if required, indicates the validity of such claim to TMC's satisfaction.
2. That the defect is not the result of damage incurred in shipment from or to the factory.
3. That the equipment has not been altered in any way either as to design or use whether by replacement parts not supplied or approved by TMC, or otherwise.
4. That any equipment or accessories furnished but not manufactured by TMC, or not of TMC design shall be subject only to such adjustments as TMC may obtain from the supplier thereof.

Electron tubes\*furnished by TMC, but manufactured by others, bear only the warranty given by such other manufacturers. Electron tube warranty claims should be made directly to the manufacturer of such tubes.

TMC's obligation under this warranty is limited to the repair or replacement of defective parts with the exceptions noted above.

At TMC's option any defective part or equipment which fails within the warranty period shall be returned to TMC's factory for inspection, properly packed with shipping charges prepaid. No parts or equipment shall be returned to TMC, unless a return authorization is issued by TMC.

No warranties, express or implied, other than those specifically set forth herein shall be applicable to any equipment manufactured or furnished by TMC and the foregoing warranty shall constitute the Buyers sole right and remedy. In no event does TMC assume any liability for consequential damages, or for loss, damage or expense directly or indirectly arising from the use of TMC Products, or any inability to use them either separately or in combination with other equipment or materials or from any other cause.

\*Electron tubes also include semi-conductor devices.

### *PROCEDURE FOR RETURN OF MATERIAL OR EQUIPMENT*

Should it be necessary to return equipment or material for repair or replacement, whether within warranty or otherwise, a return authorization must be obtained from TMC prior to shipment. The request for return authorization should include the following information:

1. Model Number of Equipment.
2. Serial Number of Equipment.
3. TMC Part Number.
4. Nature of defect or cause of failure.
5. The contract or purchase order under which equipment was delivered.

### *PROCEDURE FOR ORDERING REPLACEMENT PARTS*

When ordering replacement parts, the following information must be included in the order as applicable:

1. Quantity Required.
2. TMC Part Number.
3. Equipment in which used by TMC or Military Model Number.
4. Brief Description of the Item.
5. The *Crystal Frequency* if the order includes crystals.

### *PROCEDURE IN THE EVENT OF DAMAGE INCURRED IN SHIPMENT*

TMC's Warranty specifically excludes damage incurred in shipment to or from the factory. In the event equipment is received in damaged condition, the carrier should be notified immediately. Claims for such damage should be filed with the carrier involved and not with TMC.

All correspondence pertaining to Warranty Claims, return, repair, or replacement and all material or equipment returned for repair or replacement, within Warranty or otherwise, should be addressed as follows:

THE TECHNICAL MATERIEL CORPORATION  
Engineering Services Department  
700 Fenimore Road  
Mamaroneck, New York



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## 1. SCOPE

The servicing techniques for the MFER-1, Multi-Mode, Channelized Exciter are covered in this Service Manual under the following categories:

a. Preventive maintenance procedures are included in paragraph 2, to provide a basis for recognizing future probable causes of equipment malfunction. By adhering to a stringent program of preventive maintenance, the most probable causes of equipment malfunction can be avoided, thereby minimizing equipment downtime and the possibility of compromising important schedules.

b. Trouble shooting procedures are included in paragraph 3, to provide a quick and logical means for localizing the cause of an equipment malfunction. The trouble shooting procedures are covered on two levels (assembly and component). The major portion of MFER-1 circuitry is located on printed circuit board assemblies. When the cause of equipment malfunction has been localized to a particular printed circuit board assembly and if a spare for that assembly is available, the assembly may be replaced, allowing the equipment to become functional immediately and minimizing equipment downtime. Component level trouble shooting of an assembly may be accomplished during a scheduled downtime.

c. Alignment procedures are included in paragraph 4, to facilitate maintaining the MFER-1 in a satisfactory operating condition. Alignment and adjustment of the unit may become necessary when the periodic checks of preventive maintenance show equipment deterioration or when equipment malfunctions require replacement of assemblies or components.

d. The support documentation for servicing the MFER-1 is provided in paragraph 5. Support documentation includes servicing block diagrams, schematic and component location drawings, and parts listing.

## 2. PREVENTIVE MAINTENANCE

a. INSPECTION AND TESTING. The following paragraphs describe equipment inspection and power supply checks to be performed on a monthly and weekly basis, respectively.

(1) General Inspection. The most important and least expensive tool in the preventive maintenance program is visual inspection. Assemblies and their components should be examined periodically for tell-tale signs of deterioration prior to equipment malfunction and failure. Table 1 provides a monthly inspection checklist for the MFER-1.

TABLE 1. MONTHLY INSPECTION ROUTINE

Assembly	Check
Line Power Cord	Check line power cord for cracks, nicks or fraying.
Main Chassis Assembly	<ol style="list-style-type: none"> <li>1. Check underside of chassis for dirt and dust.</li> <li>2. Check all interconnect wiring for cracks, nicks or fraying.</li> <li>3. Check printed circuit board jacks for tightness against chassis.</li> <li>4. Check all ground connections for security.</li> </ol>
Printed Circuit Board Assemblies	<ol style="list-style-type: none"> <li>1. Check all printed circuit boards for cracks.</li> <li>2. Check components on printed circuit boards for loose connections and for evidence of deterioration from possible overheating.</li> </ol>
Front and Rear Panels	<ol style="list-style-type: none"> <li>1. Check panel for general cleanliness.</li> <li>2. Check all control knobs for smooth action from limit-to-limit; check all switches for positive action.</li> </ol>
<p><u>CAUTION</u></p> <p>The MODE and CHANNEL selector switches turn clockwise only, due to stepping switch drives. Do not attempt to force these switches in a counterclockwise direction; to do so may damage the stepping switch drive mechanisms.</p>	
	<ol style="list-style-type: none"> <li>3. Check MONITOR meter face for cracks, scratches, etc.</li> <li>4. Check indicator faces for cracks.</li> <li>5. Check all input and output jacks for security against panel.</li> </ol>

TABLE 1. MONTHLY INSPECTION ROUTINE (cont)

Assembly	Check
	<p>6. Remove both LINE and SPARES fuses. Check to insure that the fuses are the proper value (1 amp for 115vac, .5 amp for 230vac) and that they are not open.</p>

(2) Power Supply Checks. The following power supply checks should be performed on a weekly basis:

(a) Disconnect the line power cord for the MFER-1 at J116 on the rear panel of the unit.

(b) Remove power supply regulator assembly Z303 from its receptacle. (Refer to Figure 12 for location of Z303 assembly.) Insert the power supply extender board in the vacated receptacle and mount Z303 on the extender board.

(c) Disconnect remote control cable for the MFER-1 at J119 on the rear panel of the unit.

(d) Insure that the ON/STANDBY switch on the front panel is in the STANDBY position, and connect line power cord from vac power source to J116.

(e) Using an HP410B VTVM, or equivalent, check dc voltage at pin F of Z303; voltage should be +12 vdc  $\pm 5\%$ .

(f) Check voltage at pin 4 of Z303; voltage should be +24 vdc  $\pm 5\%$ .

(g) Check voltage at pin 3 of Z303; voltage should be +30 vdc  $\pm 5\%$ .

(h) Remove line cord from power source, and return Z303 to proper chassis socket (J303), after removing extender board.

(3) Functional Testing. Perform the following checkout procedure on the MFER-1, on a weekly basis after completing a check of the power supplies.

(a) Set ON/STANDBY switch to STANDBY position, and connect line power cord from vac power source to MFER-1 at J116. STANDBY indicator should illuminate.

(b) Insure that the remote control cable at J119 is disconnected from the MFER-1.

- (c) Set RF OUTPUT control fully counterclockwise.
- (d) Set EXCITER switch to ON position.
- (e) Set MODE switch to the A1 position and CHANNEL switch to channel 1 position.
- (f) Set ON/STANDBY switch to ON position. STANDBY indicator should extinguish and POWER indicator should illuminate.
- (g) Set METER switch to Q1 position. MONITOR meter should indicate in the green region marked Q1.
- (h) Set METER switch to Q2 position. MONITOR meter should indicate in the green region marked Q2.
- (i) Set METER switch to RF position. MONITOR meter should indicate zero with RF OUTPUT control fully counterclockwise.
- (j) Connect 50 ohm load to rf output jack J124, and connect VTVM (HP410B or equivalent) across load resistor.
- (k) Adjust RF OUTPUT control until VTVM indicates 3.5 volts rms.
- (l) Set CHANNEL selector switch to each of the remaining channel positions (2 thru 5), adjusting the RF OUTPUT control at the selected channel for a reading of 3.5 volts rms on the VTVM.
- (m) On the last channel checked in step (l) leave the RF OUTPUT control set for a 3.5 volts rms reading on the VTVM, and set the MODE switch to each of the remaining mode positions (A2, A2H and F1). The VTVM should indicate approximately 3.5 volts rms for each selected mode.

NOTE

The MFER-1 may be operated by remote control equipment (i.e. Analog Digital Control System, Model ADC-3(T)). The following procedural steps will check out the remotely controlled functions of the MFER-1, when the controlling system is interconnected with the MFER-1.

- (n) Set the EXCITER switch to PTT/VOX position. The MONITOR meter and the external VTVM readings should drop to zero.
- (o) Set the ON/STANDBY switch to the STANDBY position. The POWER indicator should go out, and the STANDBY indicator should illuminate.

J119. (p) Connect the remote control cable to the MFER-1 at

(q) Apply power to the MFER-1 using the remote control system. The STANDBY indicator should extinguish and the POWER indicator should illuminate.

(r) Select each mode using the remote control system. The MODE selector switch on the MFER-1 should position automatically as programmed.

(s) Select each channel using the remote control system. The CHANNEL selector switch on the MFER-1 should position automatically as programmed.

(t) Apply keyline closure to the MFER-1 using the remote control system. The MONITOR meter and the external VTVM should indicate rf output.

(u) Remove power from the MFER-1 using the remote control system.

(v) Disconnect test equipment.

b. CLEANING INSTRUCTIONS. In general, the MFER-1 should be cleaned once a month, using a soft camel's hair brush, forced air pressure of not more than 20 psi, and a suitable cleaning agent such as trichlorethylene or methylchloroform.

#### WARNING

When using toxic solvents, make certain that adequate ventilation is provided; prolonged or repeated breathing of the vapor shall be avoided. Avoid prolonged or repeated contact with skin. Flammable solvents shall not be used on energized equipment from which a spark may be received.

#### CAUTION

Trichlorethylene contains a paint removing solvent; avoid contact with painted surfaces.

Remove dirt or grease from wiring and chassis surfaces using cleaning solvent; dry with compressed air. Remove dust from printed circuit boards using a soft camel's hair brush. Blow out accumulated dust from inaccessible areas of chassis using forced air.

### 3. TROUBLE SHOOTING

a. GENERAL. Prior to trouble shooting the MFER-1, it should be determined that the MFER-1 unit itself is definitely the cause of failure or malfunction within a system and not faulty related equipment, external to the MFER-1. This may be accomplished by checking for proper external inputs to the unit and in certain instances, by isolating the MFER-1 from the external equipment. The following steps will help to determine that the MFER-1 is the cause of failure or malfunction within a system.

(1) Power Input. Insure that the MFER-1 is receiving proper input power (115 vac or 230 vac, depending upon specific wiring of equipment). Power input voltage can be measured across pins A and C of J301.

(2) Power On Control. Insure that an external closure is being provided to the MFER-1 across pins A and K of J119 for a power on condition, or bypass the external power on control by setting the ON/STANDBY switch on the MFER-1 front panel to the ON position..

(3) Keyline Closure. Insure that an external keyline closure is being provided to the MFER-1 across pins 19 and 20 of TB105, or bypass the external keyline closure by setting the EXCITER switch on the MFER-1 front panel to the ON position.

(4) RF Output Line. Disconnect rf output cable at J124 on the rear panel of the MFER-1. Connect a 50 ohm load to J124 and connect a VTVM (HP410B or equivalent) across the load resistor.

Upon completion of steps (1) thru (4), the operation of the MFER-1 should be checked. On each of the five channels and in each of the four modes, there should be a minimum rf output of 250 milliwatts (a minimum of 3.5 volts rms indicated on the external VTVM; the RF OUTPUT control may be adjusted to obtain this reading). If the MFER-1 continues to malfunction, the technician should proceed with trouble shooting the unit on an assembly level, in order to localize the cause of malfunction.

b. ASSEMBLY LEVEL TROUBLE SHOOTING. (Reference Figure 1. Overall Functional Block Diagram) The various functional assemblies of the MFER-1 are shown in Figure 1, along with the primary signal flow between assemblies. Convenient points for measurement of signal flow are also shown. Figure 1 and the paragraphs which follow, describing the functional assemblies of the MFER-1, will guide the technician in localizing the faulty assembly. Those assemblies which are referenced with Z numbers (Z101, Z102, etc.) are printed circuit board assemblies and may be replaced in entirety if spares are available. For trouble shooting a particular assembly, or to localize the faulty component(s), refer to paragraph 3.c. Component Level Trouble Shooting.

(1) Power Supply Assembly. The power supply assembly provides the dc operating potentials for all printed circuit boards. In some instances these supply voltages are routed via the MODE and CHANNEL selector switches, enabling certain assemblies only in a particular mode or on a particular channel. The power supply assembly also houses a frequency standard, which



provides a 1 mhz signal to the carrier generator Z104 and to frequency shift generator Z107, and an oscillator, which provides a 3 mhz VXCO signal to the frequency shift generator Z107. Refer to paragraph 3.c.(1) for component level trouble shooting of the power supply assembly.

(2) Carrier Generator Assembly Z104. The printed circuit board assembly Z104 utilizes the 1 mhz input signal to generate 250 khz and 1.666 mhz signals. The 1.666 mhz signal is routed to the converter/ALDC assembly Z103. The operation of the 250 khz circuitry is controlled by the keyline input, which is routed via the MODE switch, when in the A1, A2 or A2H positions, to the carrier generator Z104. There are three separate 250 khz outputs from Z104: (1) The 250 khz output signal at J104-K is routed via the MODE switch to the A2 modulator Z108 or to the A2H generator Z105, when the respective modes are selected. (2) The 250 khz output signal at J104-11 is routed via the MODE switch, when in the A1 position, to the converter/ALDC assembly Z103. (3) The 250 khz output signal at J104-12 is routed via the carrier suppression network, which controls the level of carrier reinsertion for the A2H mode. Refer to paragraph 3.c.(2) for component level trouble shooting of the carrier generator assembly.

(3) Tone Generator/A2 Modulator Assembly Z108. The tone generator section of the Z108 assembly generates an audio tone of approximately 1 khz. The audio tone is routed within the Z108 assembly to the A2 modulator section and also routed to Z105, the A2H generator. The Z108 assembly has an input of 250 khz from the MODE switch, when the A2 mode is selected. This 250 khz signal is mixed with the audio tone in the A2 modulator, providing the A2 output signal from Z108 (250 khz  $\pm$  1 khz) to the MODE switch. Refer to paragraph 3.c.(3) for component level trouble shooting of the tone generator/A2 modulator assembly.

(4) A2H Generator Z105. The printed circuit board assembly Z105 receives the audio tone input from Z108 and a 250 khz input from the MODE switch, when the MODE switch is in the A2H position. The operation of the A2H generator is controlled by the keyline input. When keyline closure is provided, the Z105 output signal is an upper sideband signal with the 250 khz sub-carrier suppressed. The 250 khz sub-carrier from the carrier suppression network is reinserted at the output of Z105. The 250 khz may be reinserted at fixed levels of 0db, -6db, -26 db, or fully suppressed. It may also be reinserted at any level between the fixed levels, since carrier suppression is continuously variable. For normal A2H operation, however, the carrier reinsertion is set by the CARR SUPPR (DB) switch at -6db suppression. The composite A2H signal from Z105 and from the carrier suppression network is routed to the MODE switch. Refer to paragraph 3.c.(4) for component level trouble shooting of the A2H generator assembly.

(5) Frequency Shift Generator/Oscillator-Mixer Z107. The printed circuit board assembly Z107 is divided into two sections. The oscillator-mixer section of Z107 utilizes the 3.0 mhz VXCO input from the power supply assembly to provide an output signal of 1.416 mhz to the converter/ALDC assembly Z103. The frequency shift generator section of Z107 utilizes the 1 mhz input from the power supply assembly and the keyline input or FSK input, via FS loop, SENSE, and SHIFT switches. Additionally, Z107 has a FAX input and output; however, this is only utilized in certain system configurations. The MODE switch routes the keying voltage for FSK in the F1 mode to the 3.0 mhz VXCO oscillator in the power supply assembly. In system configurations where facsimile is utilized,

the variable dc voltage (FAX output) from Z107 would be routed via the MODE switch in the FAX mode (not marked on front panel) to the same 3.0 mhz oscillator in the power supply assembly. Refer to paragraph 3.c.(5) for component level trouble shooting of the frequency shift generator/oscillator-mixer assembly.

(6) Converter/ALDC Assembly Z103. The printed circuit board assembly Z103 utilizes the 250 khz input signal from the MODE switch in the A2, A2H and A1 modes and the 1.666 mhz input from Z104 to provide an output signal of 1.416 mhz. In the F1 mode the 1.416 mhz input from Z107 is utilized. The 1.416 mhz output from Z103 is routed via R102, the RF OUTPUT control, to each of the five rf amplifiers, Z101, Z102, Z111, Z112 and Z113. The Z103 assembly also has ALDC circuitry which is utilized in certain system configurations, when an external rf voltage is applied at the ALDC jack J123. Refer to paragraph 3.c.(6) for component level trouble shooting of the converter/ALDC assembly.

(7) RF Amplifiers Z101, Z102, Z111, Z112, Z113. There are five rf amplifier printed circuit board assemblies; however, only one rf amplifier is operative at a time. The enabling of rf amplifiers is controlled by the CHANNEL selector switch S101. Each rf amplifier receives an input of 1.416 mhz from the RF OUTPUT control R102 and provides an rf output at the frequency (f) of the selected channel. Refer to paragraph 3.c.(7) for component level trouble shooting of the rf amplifier assemblies.

(8) RF Output Assembly Z115. The printed circuit board assembly Z115 receives an rf input from the enabled rf amplifier Z101, Z102, Z111, Z112 or Z113. The rf output assembly amplifies the input signal and provides the rf output of the MFER-1 to J124. Additionally, Z115 provides monitoring of current for its two stages of amplification and monitoring of the rf output signal level. These monitoring signals are routed from Z115 to the meter selector switch S104. Refer to paragraph 3.c.(8) for component level trouble shooting of the rf output assembly.

c. COMPONENT LEVEL TROUBLE SHOOTING. The various functional assemblies of the MFER-1 are shown in Figure 1. Those assemblies which are referenced with Z numbers are described individually in the paragraphs which follow. Each paragraph references a figure for the particular assembly being described. These figures (servicing block diagrams) show the primary signal flow and necessary operating potentials within each assembly and will aid the technician in localizing the faulty component(s).

(1) Power Supply Assembly. (Reference Figure 2. Servicing Block Diagram, Power Supply Assembly Z300 Series) Power input of 115 vac or 230 vac is applied to the power transformer T301 of Z300. From the secondary of T301, approximately 60 vac is routed to a bridge rectifier circuit on Z304. The rectified dc outputs of Z304 are applied to regulator circuitry on Z303. The heat sink assembly Z305 also contains a portion of the regulator circuitry. There are three separate dc outputs from the power supply assembly: +12 vdc, +24 vdc and +30 vdc. The +24 and +30 vdc potentials are also applied within the power supply assembly to Z301 for operation of the 1 mhz standard. The Z302 assembly is an ovenized oscillator which provides a nominal frequency of 3 mhz. The Z302 assembly receives +12 vdc for operation from the MODE switch when the F1

mode is selected (or in the FAX mode for certain system configurations). Additionally, Z302 receives the frequency shift keying voltage (or facsimile modulating voltage), and the 3 mhz oscillator frequency varies in accordance with this input.

For further isolation of the faulty component(s) refer to the following figures for the power supply assembly: Figure 27. Overall Schematic Diagram and Parts List, Power Supply Assembly Z300 Series, Figure 28. Schematic Diagrams, Power Supply A Z304 and Power Supply B Z303, and Figure 29. Component Locations and Parts Lists, Power Supply A Z304 and Power Supply B Z303.

(2) Carrier Generator Assembly Z104. (Reference Figure 3. Servicing Block Diagram, Carrier Generator Z104) The carrier generator assembly receives an input of 1 mhz. This input is applied to shaper/amplifier circuitry and then to a 4 to 1 divider network which provides a signal of 250 khz. The 250 khz is applied to two tuned amplifier stages. The tuned amplifier stages are enabled by a switched ground (keyline input to Z104). The 250 khz is further applied to both an emitter follower stage and to potentiometer R24. The emitter follower output is applied via carrier level adjust R27 to J104-12. This 250 khz output is utilized for carrier reinsertion in the A2H mode. The 250 khz signal, applied via output adjust R24 to J104-K, is utilized for mixing in the A2 and A2H modes. The 250 khz signal, applied via level adjust R23 to J104-11, is utilized in the A1 mode.

The 1 mhz input to Z104 is also applied to a harmonic selector circuit which is tuned to the fifth harmonic, providing a 5 mhz signal. The 5 mhz signal is applied via two tuned amplifier stages and a shaper/amplifier stage to a 3 to 1 divider network. The divider stage output of 1.666 mhz is applied via two tuned amplifier circuits to J104-A. The 1.666 mhz is utilized for mixing by the converter/ALDC assembly Z103. The 1.666 mhz circuitry is enabled by a switched voltage (+12 vdc) from the MODE switch in the A2, A2H and A1 modes.

A meter amplifier is also located on the carrier generator assembly, which is utilized in the audio monitoring circuitry.

For further isolation of the faulty component(s) refer to the following figures for the carrier generator assembly: Figure 13. Schematic Diagram, Carrier Generator Z104 and Figure 14. Component Location and Parts List, Carrier Generator Z104.

(3) Tone Generator/A2 Modulator Assembly Z108. (Reference Figure 4. Servicing Block Diagram, Tone Generator/A2 Modulator Z108) The tone generator portion of Z108 is an audio oscillator which generates an audio tone of approximately 1 khz for A2 and A2H modulation. The oscillator is enabled at all times by +12 vdc from the power switch S105. The tone level is adjusted by potentiometer R27. The tone output at J108-13 is routed to the A2H generator Z105 and also back into the Z108 assembly for use in the A2 modulation portion of Z108. The A2 modulator also receives a 250 khz input from the MODE switch in the A2 mode. The A2 modulator is enabled by +12 vdc from the MODE switch. Both inputs of 1 khz and 250 khz are amplified separately and applied to the A2 mixer. The mixer output of 250 khz ± 1 khz is applied via output adjust R20 and J108-E to the MODE switch.

For further isolation of the faulty component(s) refer to the following figures for the tone generator/A2 modulator assembly: Figure 15. Schematic Diagram, Tone Generator/A2 Modulator Z108 and Figure 16. Component Location and Parts List, Tone Generator/ A2 Modulator Z108.

(4) A2H Generator Z105. (Reference Figure 5. Servicing Block Diagram, A2H Generator Z105) The audio portion of Z105 is used only when external audio inputs are applied to the MFER-1. In normal operation the MFER-1 utilizes the audio tone from Z108 for A2 and A2H modulation; however, when an external mike audio input is applied to the MFER-1, it is amplified on Z105 and routed from J105-A to the MODE switch. When an external line audio input (600 ohm) is applied to the MFER-1, it is applied to an audio transformer on Z105, the secondary output of which is routed from J105-1 to the USB gain control and MODE switch.

A +30 vdc input is applied to Z105K1 at J105-10. The ground return for K1 is provided by relay driver circuitry, which is controlled by the keyline input at J105-9. Keyline closure causes K1 to energize. With K1 energized the following functions occur: (1) A ground is routed to a gate circuit which in turn enables USB amplifier circuitry. (2) A closure is provided between J105-H and J and routed to the transmitter in which the MFER-1 is configured (via TB103-5,6).

Audio input is applied to the A2H generator at J105-13. In normal operation of the MFER-1 the audio input is the 1 khz tone from Z108; however, if an external audio input is applied to the MFER-1, it will also be routed to J105-13 from the MODE switch. The audio input is amplified on Z105 and applied to a balanced modulator. The balanced modulator also receives a 250 khz signal from the MODE switch (in the A2H mode) via an amplifier circuit. The output of the balanced modulator ( 250 khz + audio) is applied to two tuned amplifier stages. A sample of the signal is sent to an AGC section on Z105, which controls the gain of the two tuned amplifier stages in accordance with the setting of R56, AGC adjust potentiometer. The signal is further amplified by Q12, which is enabled by a keyline closure. The signal is then applied to a filter, which passes only the USB portion of the signal, and then to emitter follower stages. The USB output signal at J105-11 is routed to the MODE switch, where a 250 khz signal from the carrier suppression network is reinserted for A2H modulation.

For further isolation of the faulty component(s) refer to the following figures for the A2H generator assembly: Figure 17. Schematic Diagram, A2H Generator Z105 and Figure 18. Component Location and Parts List, A2H Generator Z105.

(5) Frequency Shift Generator/Oscillator-Mixer Z107. (Reference Figure 6. Servicing Block Diagram, Frequency Shift Generator/Oscillator-Mixer Z107) The oscillator-mixer portion of Z107 is enabled only in the F1 mode by a +12 vdc input at J107-J. The oscillator provides a 4.416 mhz signal to a mixer circuit. The second input to the mixer is the 3.0 mhz VXCO signal at J107-M. The mixer output of 1.416 mhz is applied to a limiter/amplifier circuit and then via level adjust R16 to J107-H. The 1.416 mhz output is applied to the converter/ALDC assembly Z103.

The dc operating potentials for the frequency shift keying portion of Z107 are +24 vdc at J107-9 and +12 vdc at J107-J; both are applied to dc regulator circuitry. The 1 mhz input at J107-4 is applied to a keyer circuit which is, in effect, a modulator. The 1 mhz input is interrupted by a dc current input at J107-E,F, representing marks and spaces from an externally connected dry contact keyer or teletype input at TB105-15,16. (Refer also to Figure 10. Overall Schematic Diagram, MFER-1 Multi-Mode, Channelized Exciter.) When dry contact keying is used the FS loop switch S111 is set to 100 v or 50 v positions; when teletype keying is used S111 is set to 20 ma or 60 ma positions to match the dc battery loop. By keying the 1 mhz input, a frequency shift above and below center frequency is obtained, corresponding to marks and spaces of the teletype input. This signal is rectified, and the resultant varying dc signal is applied to a series of dc amplifiers, Q3 thru Q5, and an output emitter follower Q6. Amplifier Q4 is inserted in the circuit when sense switch S109 is in the positive (+) position; otherwise, in the negative (-) position, Q4 is bypassed. The variable dc output is developed across FSK balance potentiometer R22 and applied to FSK shift potentiometer R23; the dc output is coupled from J107-5 to the SHIFT switch S110. FSK center frequency adjust potentiometer R25 sets the average level about which the dc signal varies (J107-7) and thus the center frequency of the 3.0 mhz VXC0 oscillator in the power supply assembly. A regulated +12 vdc is also applied to the SHIFT switch S110 (J107-6). SHIFT switch S110 effectively sets the amplitude of the dc signal varying about the average dc level as set by R25.

The remaining circuitry on Z107 is applicable to facsimile operation and only utilized in special system configurations of the MFER-1.

For further isolation of the faulty component(s) refer to the following figures for the Z107 assembly: Figure 19. Schematic Diagram, Frequency Shift Generator/Oscillator-Mixer Z107 and Figure 20. Component Location and Parts List, Frequency Shift Generator/Oscillator-Mixer Z107.

(6) Converter/ALDC Assembly Z103. (Reference Figure 7. Servicing Block Diagram, Converter/ALDC Assembly Z103) The converter portion of Z103 receives a nominal 250 khz signal input at J103-L. With the A1 mode selected the signal is 250 khz; with the A2 mode selected the signal is 250 khz +1 khz, or with the A2H mode selected the signal is 250 khz +1 khz. This nominal 250 khz signal is applied to a difference mixer on Z103, which also receives a 1.666 mhz signal from the carrier generator Z104, via J103-15 and an amplifier circuit. The difference mixer provides a nominal output of 1.416 mhz to an amplifier stage in the A1, A2 and A2H modes. In the F1 mode the 1.416 mhz is provided by the frequency shift generator Z107, via J103-8, to the same 1.416 mhz amplifier stage. The gain of the amplifier stage is controlled by ALDC in certain system configurations. With an ALDC input connected at J123, the ALDC signal is routed via J103-E to an ALDC circuit, the control voltage output, of which, is applied to the 1.416 mhz amplifier. The 1.416 mhz signal output from the first amplifier stage is applied to a filter and two additional stages of amplification. The 1.416 mhz output signal at J103-A is applied to the RF OUTPUT control R102.

For further isolation of the faulty component(s) refer to the following figures for the converter/ALDC assembly: Figure 21, Schematic

Diagram, Converter/ALDC Z103 and Figure 22. Component Location and Parts List, Converter/ALDC Z103.

(7) RF Amplifiers Z101, Z102, Z111, Z112, Z113. (Reference Figure 8. Servicing Block Diagram, RF Amplifiers Z101, Z102, Z111, Z112, Z113) There are up to five separate rf amplifier assemblies in the MFER-1, each one representing a separate channel output. Only one rf amplifier is enabled at a time by a switched +24 vdc from the CHANNEL selector switch to pin P of the respective assembly (Z101, Z102, Z111, Z112 or Z113). Each rf assembly has an oscillator, the frequency, of which, is determined by the channel output frequency (f). The oscillator frequency is the channel output frequency plus 1.416 mhz ( $f + 1.416 \text{ mhz}$ ): i.e. - when the channel output frequency is 500 khz, the oscillator frequency on the rf amplifier assembly will be 500 khz plus 1.416 mhz or 1.916 mhz. The oscillator output is applied, via an amplifier stage, to a balance mixer circuit. Each rf amplifier assembly also receives a 1.416 mhz input from the RF OUTPUT control at pin N. The 1.416 mhz input is also applied, via an amplifier stage, to the balanced mixer circuit. The output of the balanced mixer is applied to four stages of amplification. The amplifier stages are tuned to the channel output frequency,  $(f + 1.416 \text{ mhz}) - (1.416 \text{ mhz}) = f$ . The level of rf output is controlled by level adjust R9 between the 1st and 2nd rf amplifier stages. The output of the rf amplifiers is fed via pin A to the rf output assembly Z115.

For further isolation of the faulty component(s) refer to the following figures for the rf amplifier assemblies: Figure 23. Schematic Diagram, RF Amplifiers Z101, Z102, Z111, Z112, Z113 and Figure 24. Component Location and Parts List, RF Amplifiers Z101, Z102, Z111, Z112, Z113.

(8) RF Output Assembly Z115. (Reference Figure 9. Servicing Block Diagram, RF Output Assembly Z115) The rf output assembly Z115 receives an rf input at J115-B from the enabled rf amplifier assembly (Z101, Z102, Z111, Z112, or Z113). There are two stages of rf amplification on Z115. The +24 vdc and +30 vdc supply line inputs at J115-F and J115-9, respectively, are also coupled to the METER switch S104, effectively placing MONITOR M101 in series with the supply lines and rf amplifiers. (Refer to Figure 10 for this interconnect.) With the METER switch S104 in the Q1 or Q2 positions, the collector current of the respective amplifier stages is monitored. The rf output signal is applied via J115-P to the rf output jack J124 and also applied to an rf metering circuit on the Z115 assembly. The dc output from the metering circuit is applied via J115-12 to the RF output position of the meter switch S104. In this position the MONITOR M101 displays the relative amplitude of the output signal.

For further isolation of the faulty component(s) refer to the following figures for the rf output assembly: Figure 25. Schematic Diagram, RF Output Assembly Z115 and Figure 26. Component Location and Parts List, RF Output Assembly Z115.

#### 4. ALIGNMENT

a. GENERAL. The following paragraphs present the alignment procedures required to maintain the MFER-1 Multi Mode, Channelized Exciter in satisfactory operating condition. When performing the alignment procedures, the

technician should refer to Figure 12. Overall Component Location, MFER-1 and to the individual component location figures for the printed circuit board assemblies.

CAUTION

When removing printed circuit board assemblies to mount on the extender board for alignment, it is good practice to set the ON/STANDBY switch to the STANDBY position before removing an assembly. Once the assembly has been mounted in the extender board and inserted in the proper chassis socket, the ON/STANDBY switch should be set to ON. When removing an assembly from the extender board and returning it to its chassis socket, the same procedure applies.

b. TEST EQUIPMENT REQUIRED. The following test equipment, or its equivalent, is required to perform the complete alignment of the MFER-1:

- (1) VOM, Simpson Model 260A.
- (2) RF VTVM, Hewlett-Packard Model 410B.
- (3) AC VTVM, Ballantine Model 314.
- (4) Millivolt Meter, Millivac Model MV-28B.
- (5) Audio Generator, Hewlett-Packard Model 200CD.
- (6) RF Signal Generator, Hewlett-Packard Model 606A.
- (7) Oscilloscope, Tektronix Model 535A with high gain preamplifier L-type plug in.
- (8) Spectrun Analyzer, Lavoie Laboratories, Model LA-40A.
- (9) Frequency Counter, Hewlett-Packard Model 5244L.

c. POWER SUPPLY ASSEMBLY. Perform the alignment of the power supply assembly as follows:

- (1) Remove the rf output assembly Z115 from the MFER-1.
- (2) With the ON/STANDBY switch in the STANDBY position, connect the line power cord from the ac power source to J116 on the MFER-1. The STANDBY indicator should illuminate.

(3) Set the ON/STANDBY switch to the ON position. The POWER indicator should illuminate and the STANDBY indicator should extinguish.

NOTE

Allow atleast 30 minutes for equipment to warm up.

(4) Mount the Z303 assembly on an extender board, and with the ON/STANDBY switch in the STANDBY position, set potentiometers R3 and R12 fully clockwise. Set the ON/STANDBY switch to the ON position.

(5) With a VOM, measure the dc voltage level at J304-6; it should be approximately +45 vdc.

(6) With a VOM, measure the dc voltage level at J304-A; it should be approximately +40 vdc.

(7) With a VOM, measure the dc voltage level at J304-E; it should be approximately +20 vdc.

(8) With a VOM, measure the dc voltage level at J303-A; it should be approximately +40 vdc.

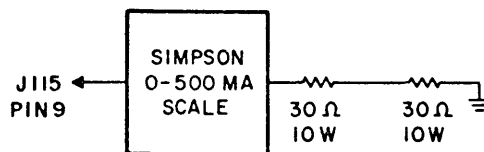
(9) With a VOM, measure the dc voltage level at J303-E; it should be approximately +20 vdc.

(10) Monitor the dc voltage level at J303-F with the VOM, and adjust R8 on Z303 for exactly +12 vdc (all cards inserted except Z115). Adjust R3 until the voltage level just commences to drop, and then back off R3 for a meter reading of exactly +12 vdc.

(11) Monitor the dc voltage level at J304-4 with the VOM, and adjust R12 until the voltage level just commences to drop, and then back off R12 for a meter reading of exactly +24 vdc.

(12) With a VOM, measure the dc voltage level at J301-E; it should be 30  $\pm$  1 vdc.

(13) Set the ON/STANDBY switch to the STANDBY position and the METER switch to the Q1 position. Connect the test arrangement shown in the following sketch:





(14) Observe the current reading on the VOM. Let the 0-5 dial divisions on the MONITOR meter of the MFER-1 represent 0-500 millamperes. Adjust R142 so that the MONITOR reading is the same as observed on the VOM.

(15) Disconnect test equipment, and return the Z303 assembly to the proper chassis socket.

d. CARRIER GENERATOR ASSEMBLY Z104. Perform the alignment of the carrier generator assembly as follows:

(1) Mount the Z104 assembly on the extender board.

(2) Connect an oscilloscope between J104-15 and ground; a 1 mhz signal at approximately 2.4 volts peak-to-peak should be displayed.

(3) Connect the oscilloscope to TP10, and adjust transformers T3 through T7 for maximum 5 mhz signal (level of approximately 0.7 volt peak-to-peak).

(4) Connect the oscilloscope to Z2 pin 9; a 1.666 mhz square-wave signal should be displayed (level of approximately 4 volts peak-to-peak).

(5) Connect the oscilloscope to the base of transistor Q11; a 1.666 mhz sinewave signal should be displayed (level of approximately 0.14 volt peak-to-peak).

(6) Connect the oscilloscope to TP13, and adjust transformers T8 through T10 for maximum 1.666 mhz signal (level of approximately 0.8 volt peak-to-peak).

(7) Set the EXCITER switch to the ON position.

(8) Connect the oscilloscope to Z1 pin 9; a 250 khz squarewave signal should be displayed (level of approximately 4 volts peak-to-peak).

(9) Connect the oscilloscope to the base of transistor Q3; a 250 khz sinewave signal should be displayed (level of approximately 0.4 volt peak-to-peak).

(10) Connect the oscilloscope to TP2, and adjust transformers T1 and T2 for maximum 250 khz signal (level of approximately 2.0 volts peak-to-peak).

(11) Set the MODE switch to the A1 position, and connect the millivolt meter to J103-L. Adjust potentiometer R23 on the Z104 assembly for 10 millivolts rms.

(12) With the millivolt meter still connected to J103-L, set the MODE switch to the A2H position and the CARR SUPPR switch to the -6 db position. Remove the Z108 assembly from the MFER-1 chassis. Adjust potentiometer R27 on the Z104 assembly for 5 millivolts rms.

(13) Return the Z108 assembly to the proper chassis socket.

(14) Connect the millivolt meter to J104-K and adjust R24 on the Z104 assembly for .61 volts rms.

(15) Disconnect test equipment, and return the Z104 assembly to the proper chassis socket.

e. CONVERTER/ALDC ASSEMBLY Z103. Perform the alignment of the converter/ALDC assembly as follows:

(1) Mount the Z103 assembly on the extender board.

(2) Set the EXCITER switch to the ON position and the MODE switch to the A1 position.

(3) Connect the oscilloscope to J103-15. The 1.666 mhz signal should be displayed (level of approximately 3.5 volts peak-to-peak).

(4) Connect the oscilloscope to the collector of transistor Q1 and adjust transformer T1 for maximum signal output (approximately 0.5 volt peak-to-peak).

(5) Set the following controls on the front panel of the MFER-1 to minimum levels: RF OUTPUT, USB and LSB LINE GAIN, MIKE GAIN and VOX GAIN.

(6) Connect the oscilloscope to the cathode of diode CR1 (junction of CR1 and R10), and adjust transformer T2 for maximum signal output.

(7) Adjust potentiometer R6 for minimum 1.666 mhz signal, and repeat steps (6) and (7) until maximum tuning is obtained.

(8) Connect the oscilloscope on the hot side of R23 and adjust T3 for maximum output.

(9) Connect the oscilloscope to J103-A and adjust transformers T2 through T4 for maximum signal output. The output should be a 1.416 mhz signal at an approximate level of 1.0 volt peak-to-peak.

(10) Disconnect test equipment, and return the Z103 assembly to the proper chassis socket.

f. TONE GENERATOR/A2 MODULATOR ASSEMBLY Z108. Perform the alignment of the tone generator/A2 modulator assembly as follows:

(1) Mount the Z108 assembly on the extender board.

(2) Set the EXCITER switch to the ON position and the MODE switch to the A2 position.

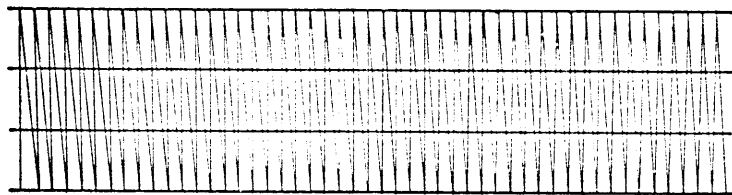
(3) Connect the oscilloscope to J108-13 and adjust potentiometer R27 for maximum signal output. (The frequency of the audio tone should be approximately 1 khz.)

(4) Connect the oscilloscope to J108-15; the audio tone input signal should be displayed.

(5) Connect the oscilloscope to J108-L; a 250 khz signal should be displayed,

(6) Connect the oscilloscope to J108-E and adjust T2 for maximum signal output. (It may be necessary to increase the signal level with R20 for a convenient display on the oscilloscope.)

(7) Connect the oscilloscope to J103-A and set the MODE switch to the A1 position. A 1.416 nmhz sinewave signal should be displayed at a level of approximately 1.0 volt peak-to-peak. Adjust the volts/cm switch and variable volts/cm control on the oscilloscope so that the displayed sinewave occupies a total of 3 cm divisions.

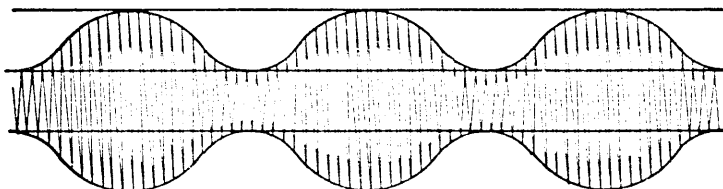


A1 Mode Peak-to-Peak Representation

NOTE

Do not change the volts/cm controls on the oscilloscope as set in step (7) for the adjustment outlined in step (8).

(8) With the oscilloscope still connected to J103-A and adjusted as per step (7), set the MODE switch to the A2 position. Alternately adjust R20 on Z108 for peak-to-peak amplitude and R24 on Z104 for percent of modulation until a 50% modulated signal at 3 cm divisions peak-to-peak on the oscilloscope is obtained.



A2 Mode, 50% Modulation, Peak-to-Peak Representation

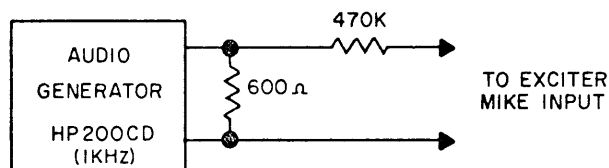
(9) Disconnect test equipment, and return the Z108 (and Z104) assemblies to the proper chassis sockets.

g. A2H GENERATOR Z105. Perform the alignment of the A2H generator as follows:

(1) Mount the Z105 assembly on the extender board.

(2) Set the EXCITER switch to the ON position and the MODE switch to the A2H position.

(3) Connect the audio generator to the MFER-1 MIKE input jack as shown in the following sketch.



(4) Adjust the audio generator to 1 khz at a level of 1.4 millivolts rms (measure level at J105-D with the millivolt meter).

(5) Connect the meter to J105-A, and adjust potentiometer R8 for a level of 50 millivolts rms.

(6) Connect the millivolt meter to J105-15 (the 250 khz input). The signal level should be approximately 0.6 volt rms.

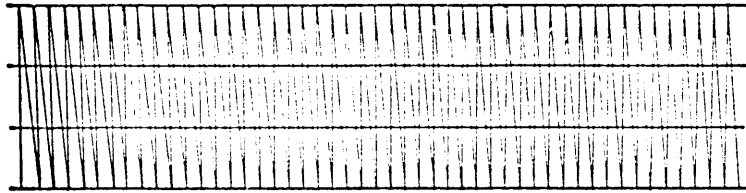
(7) Set the AGC potentiometer R56 fully clockwise.

(8) Connect the millivolt meter to the base of the transistor Q11, and adjust transformer T2 for maximum output.

(9) Connect the millivolt meter to the collector of Q12 (junction of R60 and R40), and adjust transformer T3 for maximum output.

(10) Connect the millivolt meter to the cathode of CR3 and adjust potentiometer R56 for a level of 0.2 volt rms; adjust transformer T4 for maximum indication.

(11) Connect the oscilloscope to J103-A and set the MODE switch to the A1 position and the CARR SUPPR switch to the -6 db position. A 1.416 mhz sinewave signal should be displayed at a level of approximately 1.0 volt peak-to-peak. Adjust the volts/cm switch and variable volts/cm control on the oscilloscope so that the displayed sinewave occupies a total of 3 cm divisions.

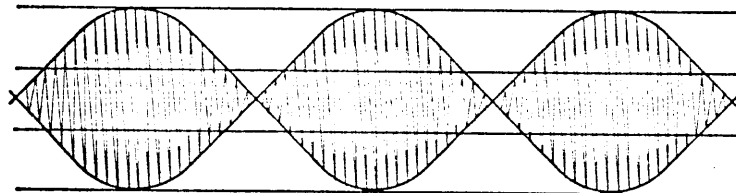


A1 Mode Peak-to-Peak Representation

NOTE

Do not change the volts/cm controls on the oscilloscope as set in step (11) for the adjustment outlined in step (12).

(12) With the oscilloscope still connected to J103-A and adjusted as per step (11), set the MODE switch to the A2H position. Alternately adjust R56 on Z105 for peak-to-peak amplitude and R27 on Z104 for sharp crossover until the following waveform is obtained at 3 cm divisions peak-to-peak on the oscilloscope.



A2H Mode Peak-to-Peak Representation

(13) Using the resistance function, connect the VOM across J105-H and J; a 0 ohm indication should be read on the VOM. Set the EXCITER switch to the PTT/VOX position; the VOM should read infinity.

(14) Disconnect test equipment, and return the Z105 (and Z104) assemblies to the proper chassis sockets.

h. FREQUENCY SHIFT GENERATOR/OSCILLATOR-MIXER Z107. Perform the alignment of the frequency shift generator/oscillator-mixer as follows:

(1) Connect the frequency counter to the vertical output terminals of the oscilloscope. Set the MODE switch to the F1 position and the EXCITER switch to the ON position. On the rear panel of the MFER-1, set potentiometer R101 to mid-range, SHIFT switch to +425 hz (maximum shift position), SENSE switch to the (+) position, and S111 to the CONT. position.

### NOTE

FSK adjustments must be made after the 3.0 mhz oscillator oven has warmed up for at least an hour.

- (2) Set R22 and R23 on Z107 fully counterclockwise.
  - (3) Connect the oscilloscope to J107-M, and adjust R25 for a reading of 3.000000 mhz on the frequency counter.
  - (4) Mount the Z107 assembly on the extender board.
  - (5) Connect the oscilloscope to J105-H, and adjust potentiometer R16 for maximum signal output level on the oscilloscope and C20 for a frequency reading of 1.416666 mhz on the counter.
  - (6) Return the Z107 assembly to the proper chassis socket.
  - (7) With the oscilloscope connected to J105, adjust R25 (if required) for a frequency reading of 1.416666 mhz on the counter.
  - (8) Adjust potentiometer R23 for a frequency of 1.416241 mhz on the counter. Set the SENSE switch to the (-) position and adjust potentiometer R22 for a frequency reading of 1.417091 mhz on the counter.
  - (9) Repeat step (8) until the frequencies are within 5 hz.
  - (10) Set the SHIFT switch to the +212 hz position and the SENSE switch to the (+) position. The frequency counter should read 1.416878 mhz +15 hz.
  - (11) Repeat step (10) for the +106 hz SENSE switch position and for the +53 hz position. The tolerance is +7 hz for the +53 hz position.
  - (12) Mount the Z107 assembly on the extender board.
  - (13) Connect the oscilloscope to J103-A and set the MODE switch to the A1 position. Observe the peak-to-peak amplitude on the oscilloscope. Set the MODE switch to the F1 position, and adjust R16 on Z107 for the same peak-to-peak amplitude displayed in the A1 mode.
  - (14) Disconnect test equipment, and return the Z107 assembly to the proper chassis socket.
- i. RF AMPLIFIERS Z101, Z102, Z111, Z112, Z113. Perform the alignment of the rf amplifier assemblies as follows:
- (1) Mount the rf amplifier assembly (Z101, Z102, Z111, Z112 or Z113) on the extender board. (Insure that Z115 is removed from MFER-1 chassis for this alignment.)

(2) Set the MODE switch to the A1 position, and the CHANNEL switch to the proper position for the rf amplifier being aligned.

NOTE

The oscillator frequency for a particular rf amplifier is determined by adding 1.416667 mhz to the channel output frequency of the rf amplifier.

$$\begin{array}{r} .500000 \text{ mhz} \\ + 1.416667 \\ \hline 1.916667 \text{ mhz} \end{array} \quad \begin{array}{l} \text{output frequency} \\ \\ \text{oscillator frequency} \end{array}$$

(3) Determine the oscillator frequency for the rf amplifier being aligned, and adjust the signal generator to that frequency (use a counter for this adjustment.) Set the signal generator output to minimum.

(4) Set the RF OUTPUT control on the MFER-1 to minimum (fully counterclockwise).

(5) Connect the signal generator to the junction of R40, R41, and R39.

(6) Connect the oscilloscope to the junction of R2 and R3, and check the level of the oscillator output. It should be 0.5 volt peak-to-peak.

(7) Connect the oscilloscope to the hot side of C2. Set the signal generator output for an oscilloscope reading of 0.1 volt peak-to-peak and adjust C2 for maximum signal output.

(8) Connect the oscilloscope to the hot side of C7, and adjust C2 and C7 for maximum signal output. Maintain the signal generator output level so that the maximum signal displayed on the oscilloscope is 0.1 volt peak-to-peak.

(9) Connect the oscilloscope to the hot side of C20, and adjust C14 and C20 for maximum signal output. Continue to maintain the signal generator output so that the maximum signal displayed on the oscilloscope is 0.1 volt peak-to-peak.

(10) Connect the oscilloscope to pin A of the amplifier being aligned, and adjust C20 for maximum signal output.

(11) Disconnect the signal generator. Set the EXCITER switch to the ON position and the RF OUTPUT control fully clockwise (maximum output).

(12) Connect the oscilloscope to the hot side of C7, and adjust C2 and C7 for maximum signal output.

(13) Connect the oscilloscope to the hot side of C14, and adjust C7 and C14 for maximum signal output.

(14) Connect the oscilloscope to the hot side of C20, and adjust C14 and C20 for maximum signal output.

(15) Connect the oscilloscope to pin A of the rf amplifier being aligned, and adjust C20 for maximum signal output. Adjust potentiometer R9 for approximately 0.1 volt peak-to-peak.

#### NOTE

This completes the alignment of the rf amplifier. Final adjustment of potentiometer R9 is performed in the final alignment.

(16) Disconnect test equipment, and return the rf amplifier assembly to the proper chassis socket.

j. RF OUTPUT ASSEMBLY Z115. Perform the alignment of the rf output assembly as follows:

(1) Before inserting the Z115 assembly into the MFER-1 chassis, adjust potentiometers R3 and R8 for maximum resistance. Adjust RF OUTPUT control on the front panel of the MFER-1 fully counterclockwise. Set the MODE switch to the A1 position, the CARR SUPPR switch to -6 db, the CHANNEL switch to the channel 1 position, and the EXCITER switch to the ON position.

(2) Mount the Z115 assembly on the extender board.

(3) Recheck the power supply voltages and readjust as outlined in the power supply alignment procedures in paragraph 4.c.

(4) Set the METER switch to the Q1 position, and adjust R8 on Z115 until the MONITOR on the front panel reads in the green region marked Q1.

(5) Set the METER switch to the Q2 position, and adjust R3 on Z115 until the MONITOR on the front panel reads in the green region marked Q2.

(6) Connect a 50 ohm load to the RF OUT jack J124 on the rear panel of the MFER-1 and connect the RF VTVM across the load.

(7) Adjust the RF OUTPUT control fully clockwise, and adjust T1 and L11 for maximum output level on the VTVM.

(8) Readjust RF OUTPUT control fully counterclockwise.

(9) Disconnect test equipment, and return the Z115 assembly to the proper chassis socket.



k. FINAL ALIGNMENT. Perform the overall final alignment of the MFER-1 as follows:

(1) Set the MODE switch to the A1 position, the CARR SUPPR switch to -6 db, the CHANNEL switch to the channel 1 position, the EXCITER switch to the ON position, and the RF OUTPUT control fully clockwise.

(2) Connect a 50 ohm load to the RF OUT jack J124 on the rear panel of the MFER-1 and connect the RF VTVM and an oscilloscope across the load.

(3) Adjust R9 on the proper rf amplifier assembly for the selected channel (Z101, Z102, Z111, Z112, Z113) for a level of 3.5 volts rms on the RF VTVM. Repeat this adjustment for all channels.

(4) Connect the spectrum analyzer controls so that the signal displayed is at the 0 db reference. (A sinewave should be displayed on the oscilloscope.)

#### NOTE

The peak-to-peak relationship displayed on the oscilloscope should be the same for all modes in the final alignment.

(5) Set the MODE switch to the F1 position, and adjust R16 on Z107 for 3.5 volts rms on the RF VTVM. (A sinewave should be displayed on the oscilloscope and a signal at 0 db reference should be displayed on the spectrum analyzer.)

(6) Set the MODE switch to the A2H position. Alternately adjust R56 on Z105 for 3.5 volts rms on the RF VTVM and R27 on Z104 so that the two signals displayed on the spectrum analyzer are equal in amplitude. The level of the two signals on the spectrum analyzer should be approximately -6 db from the 0 db reference, with 3.5 volts rms output. (A two tone envelope with sharp crossover should be displayed on the oscilloscope.)

(7) Set the MODE switch to the A2 position. (This mode will now be adjusted for approximately 80% modulation.) Alternately adjust R20 on Z108 for 3.5 volts rms on the RF VTVM and R24 on Z104 for percent of modulation. The carrier level on the spectrum analyzer should be approximately -5.4 db from the 0 db reference and the tone level should be approximately -7.8 db from the carrier level, with 3.5 volts rms output. (An A2 modulation envelope of 80% modulation should be displayed on the oscilloscope.)

(8) Disconnect test equipment, and return all assemblies to the proper chassis sockets. Replace top and bottom covers on the MFER-1, and reconnect unit into system.

## 5. SUPPORT DOCUMENTATION.

The support documentation for servicing the MFER-1, Multi-Mode, Channelized Exciter consists of 29 figures, located in the rear of this Service Manual. Figures 1 thru 9 are servicing block diagrams: figure 1 is an overall block diagram of the MFER-1; figures 2 thru 9 are servicing block diagrams of the individual printed circuit board assemblies. Figure 10 is a schematic wiring diagram of the overall unit, figure 11 is the parts list for the overall unit, and figure 12 is a component location diagram for, assemblies and components located on the overall exciter chassis. Figures 13 thru 29 are schematic and component location diagrams and parts lists for each individual printed circuit board assembly within the MFER-1.

Table 2. lists the manufacturer's engineering drawing numbers for applicable figures. Each number includes a revision letter under which this equipment was manufactured.

TABLE 2. TMC ENGINEERING DRAWINGS

Figure Number	TMC Drawing Number
10	CK1919 Ø
13	CK1918 Ø
14	A4908 Ø
15	CK1913 Ø
16	A4901 Ø
17	CK1917 Ø
18	A4907 Ø
19	CK1920 Ø
20	A4905 Ø
21	CK1495 C
22	A4717 B
23	CK1925 Ø
24	A4894 A
25	CK1399 B
26	A4620 B
27	CK1330 E
28	CK1328 A
	CK1291 B
29	A4512 A
	A4513 B

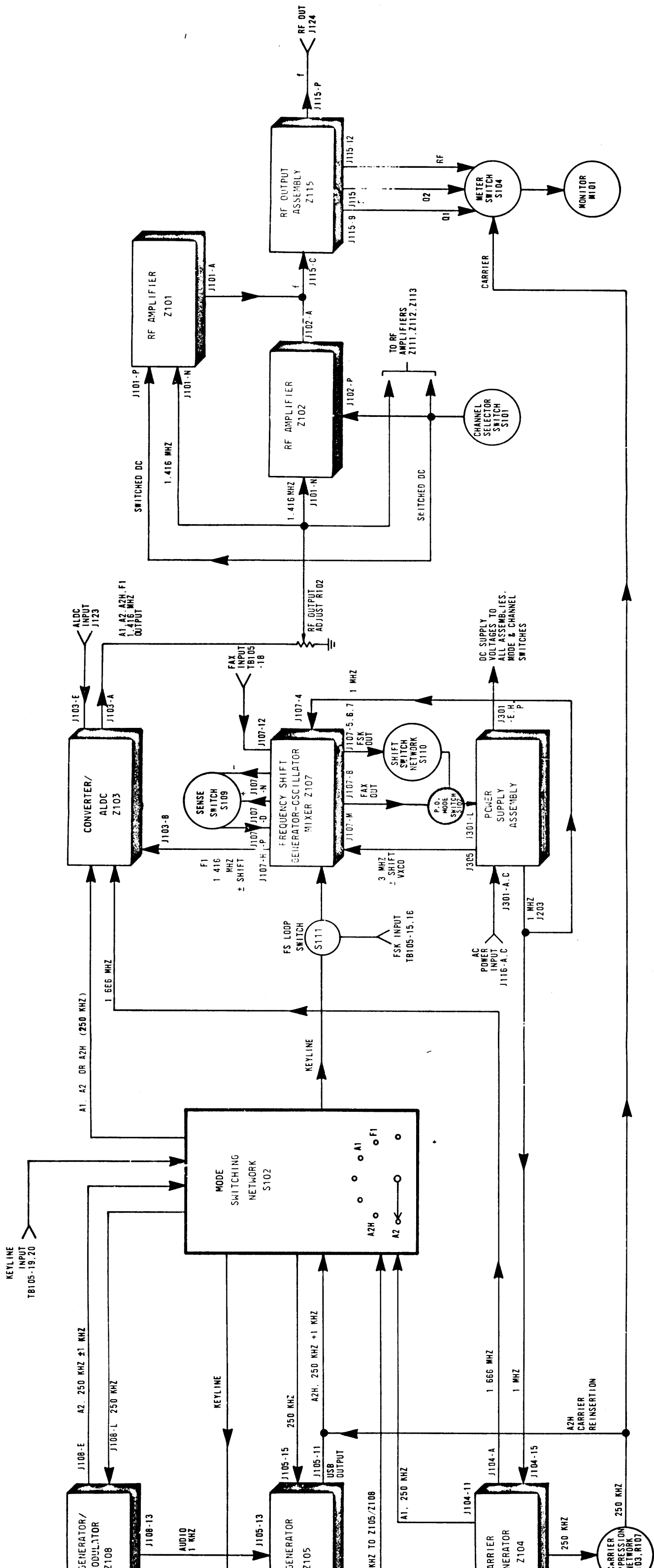
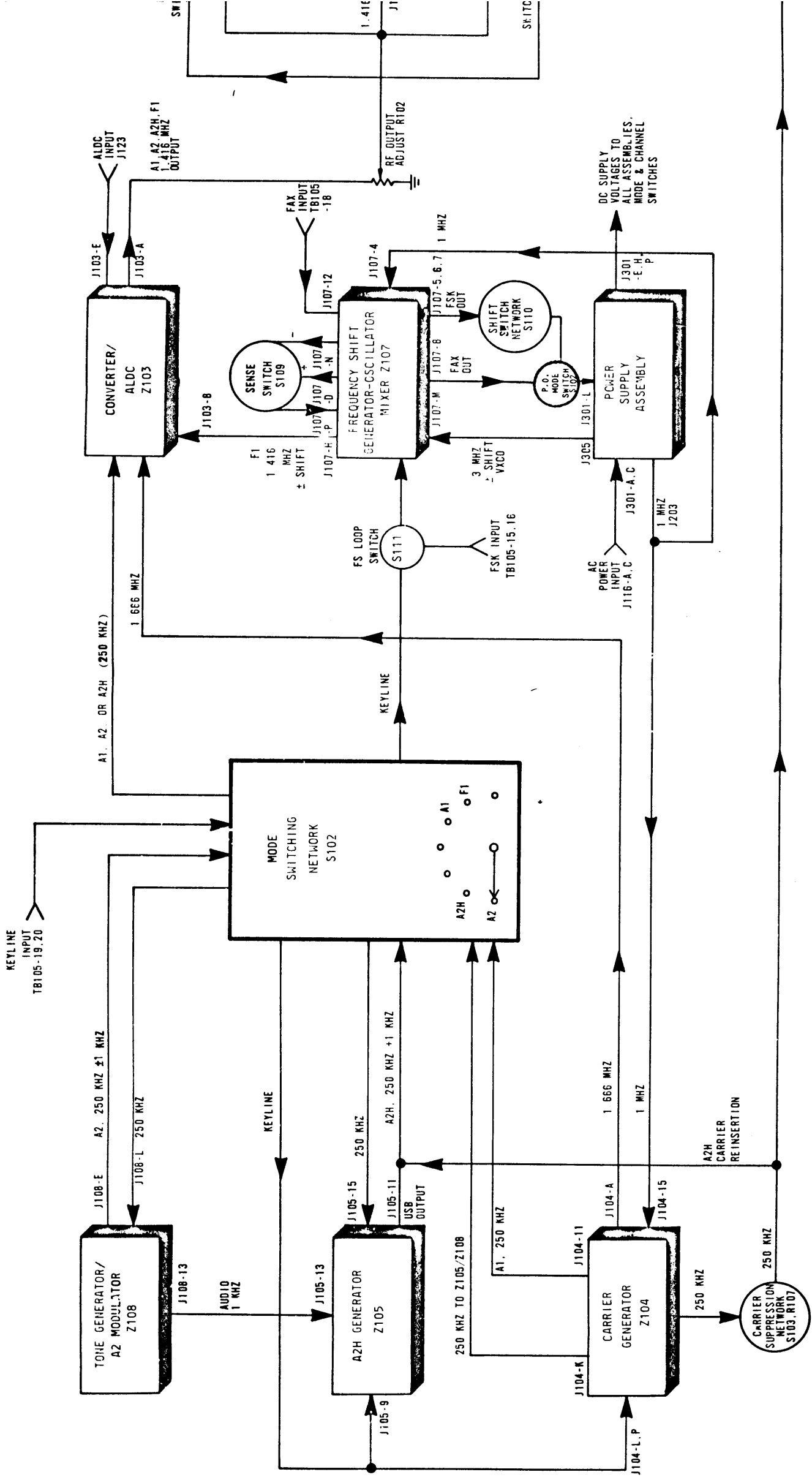


FIGURE 1. OVERALL BLOCK DIAGRAM.  
MFER-1 MULTI-MODE, CHANNELIZED EXCITER



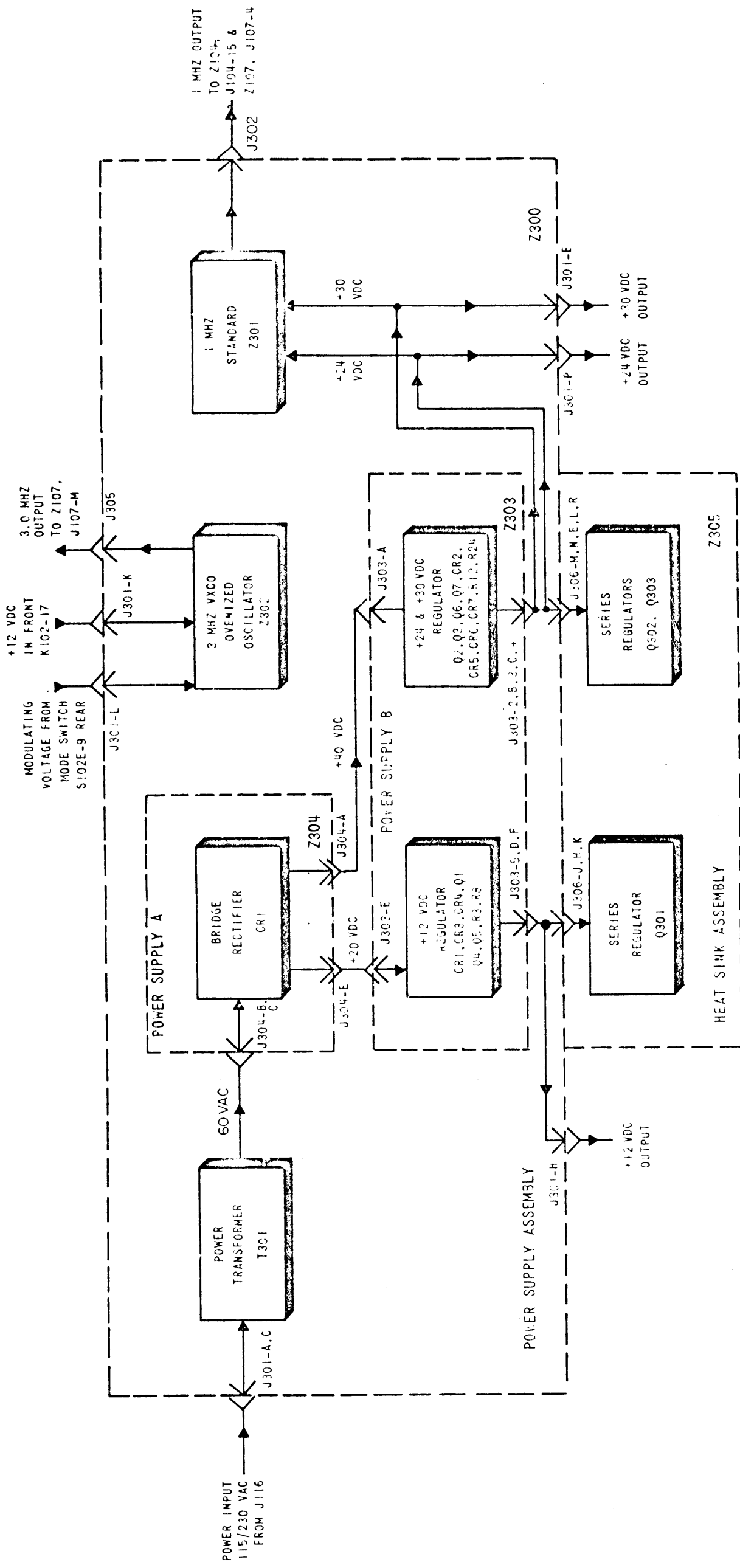


FIGURE 2. SERVICING BLOCK DIAGRAM,  
POWER SUPPLY ASSEMBLY Z300 SERIES

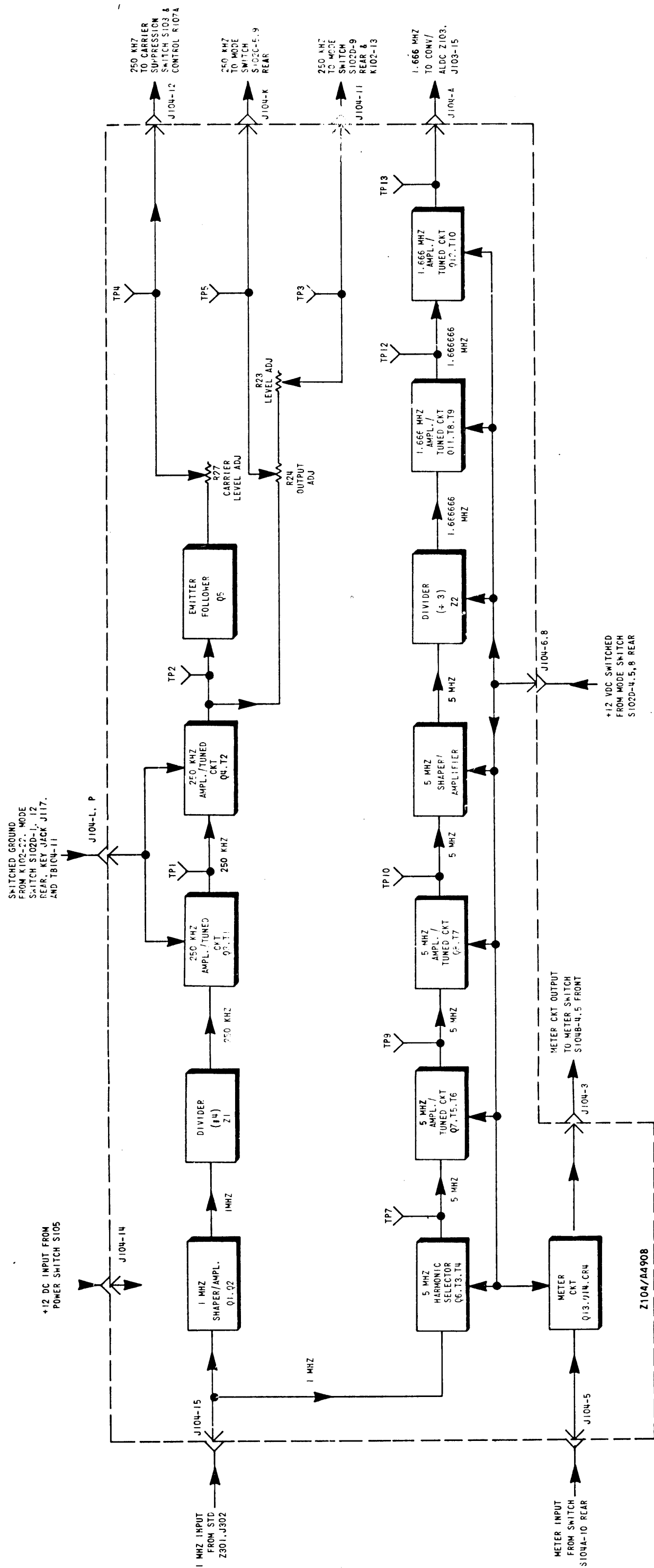
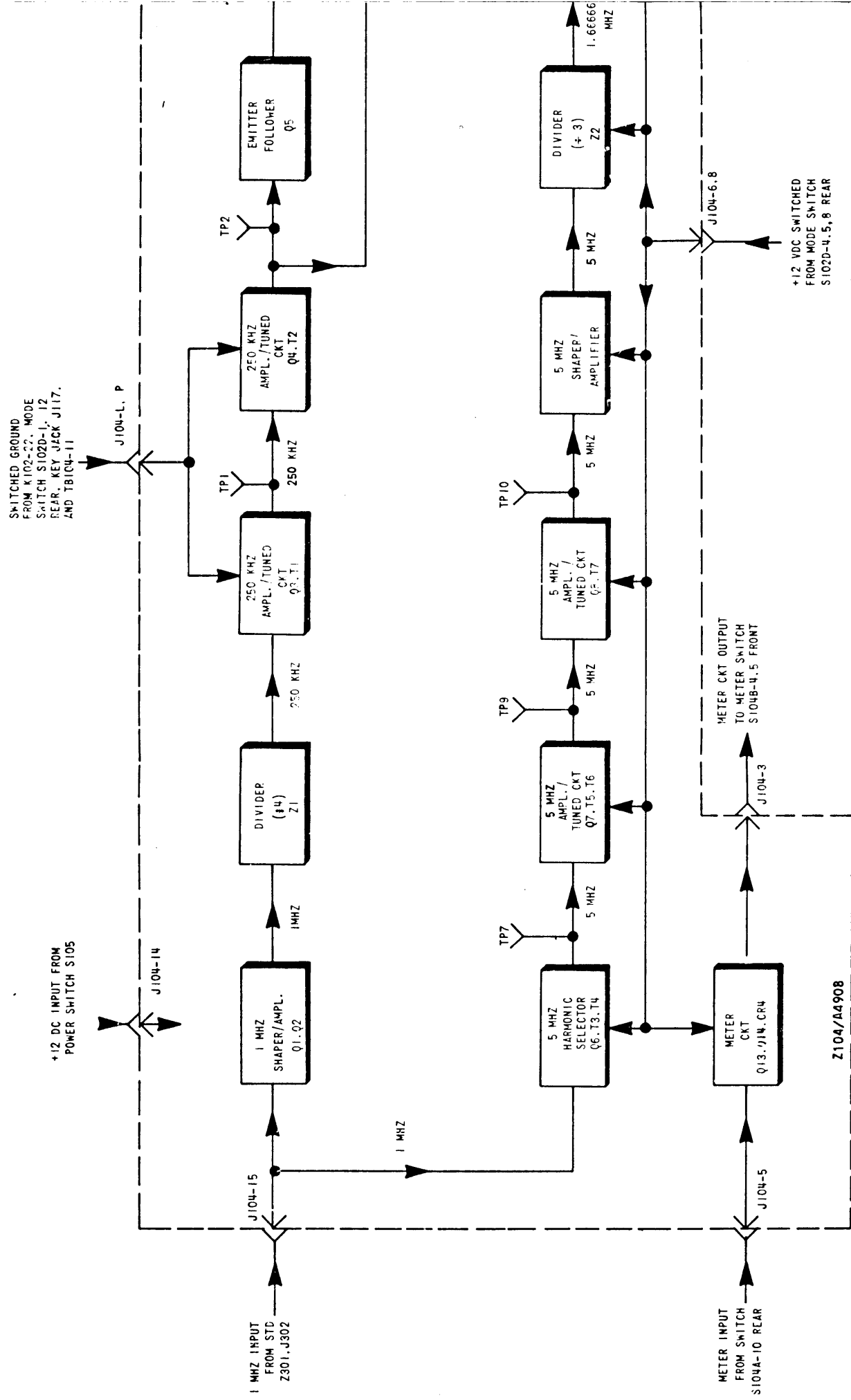


FIGURE 3. SERVICING BLOCK DIAGRAM. CARRIER GENERATOR Z104



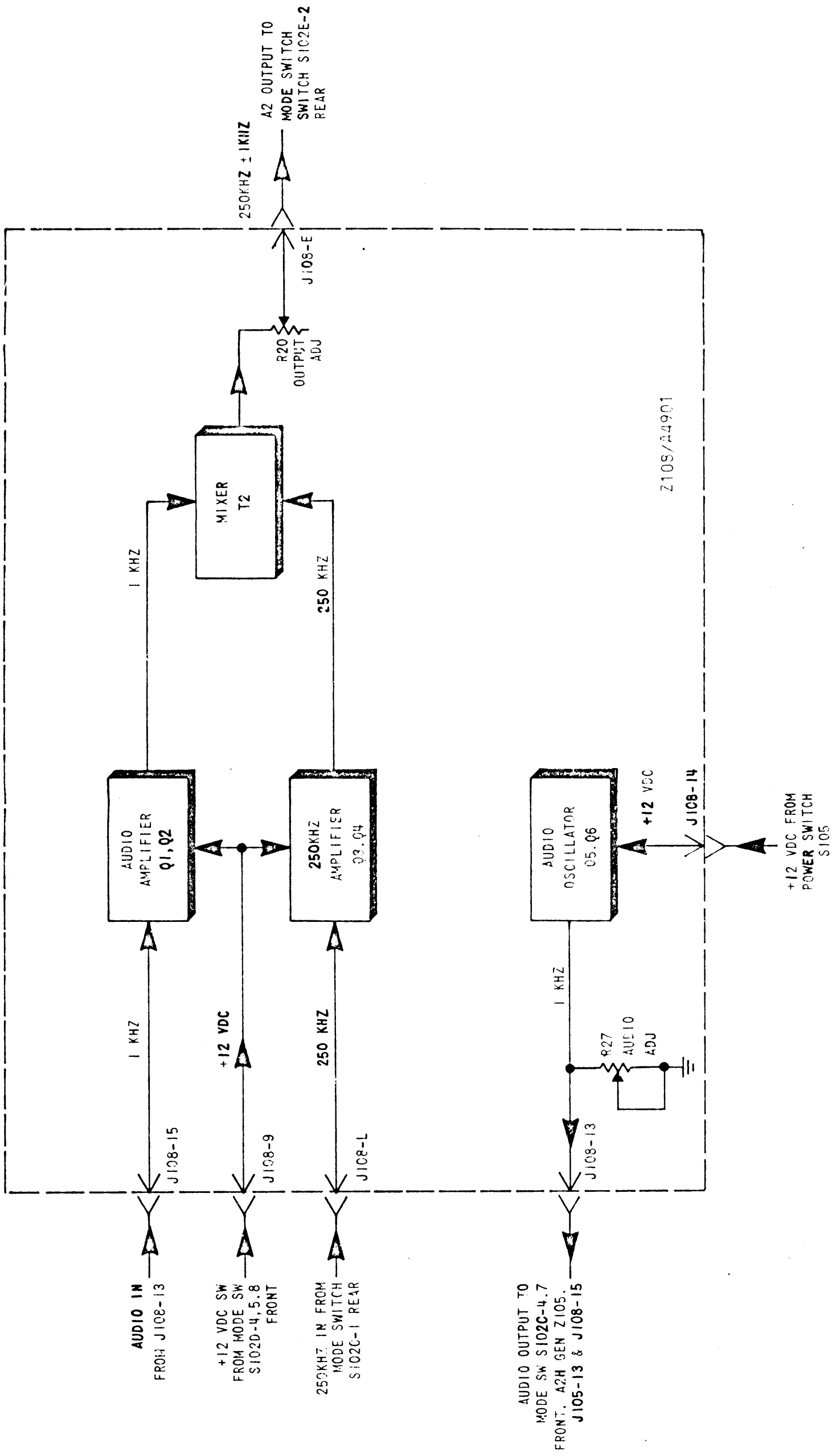


FIGURE 4. SERVICING BLOCK DIAGRAM, TONE GENERATOR/A2 MODULATOR Z105



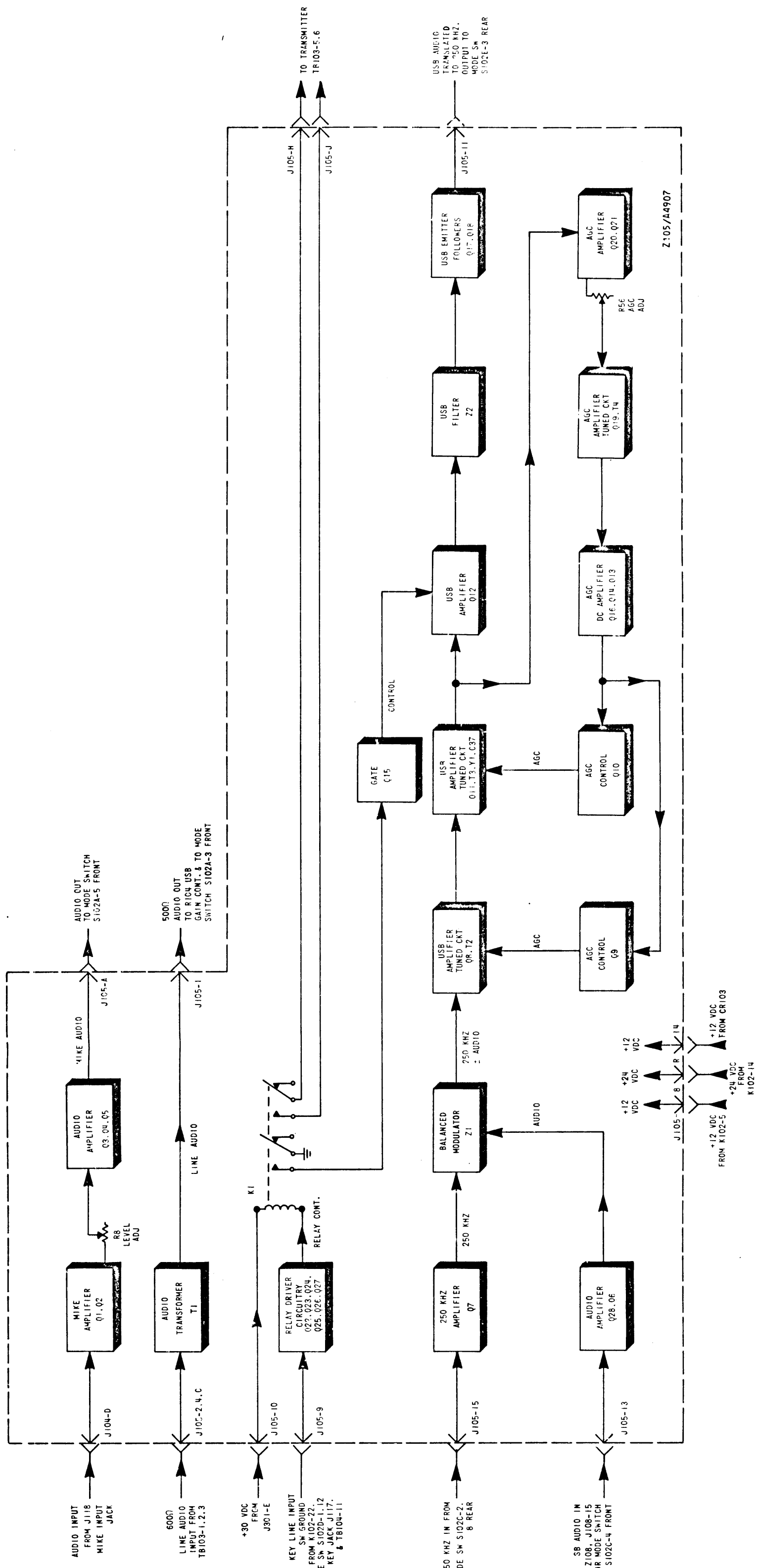
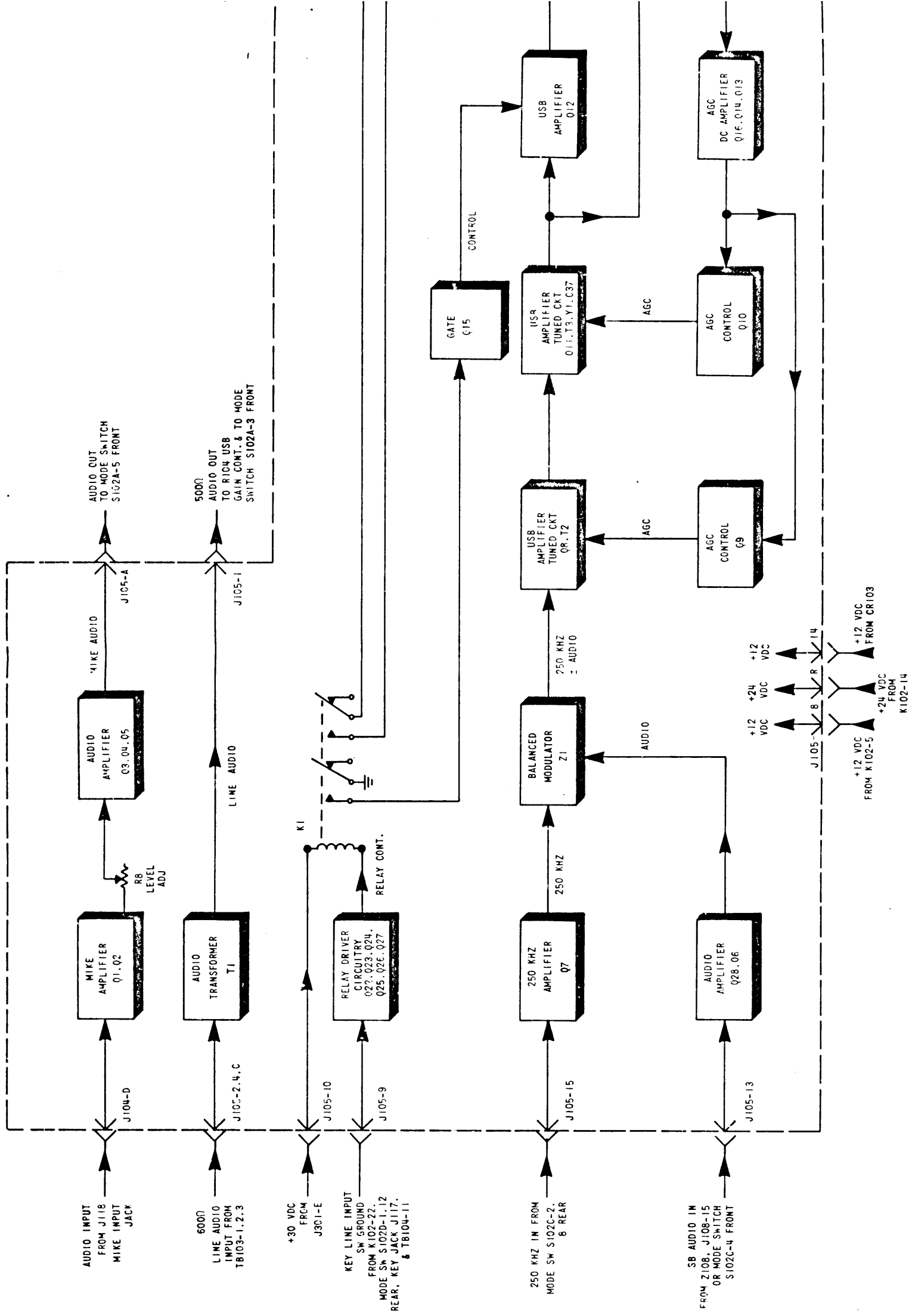


FIGURE 5. SERVICING BLOCK DIAGRAM. A2H GENERATOR Z105



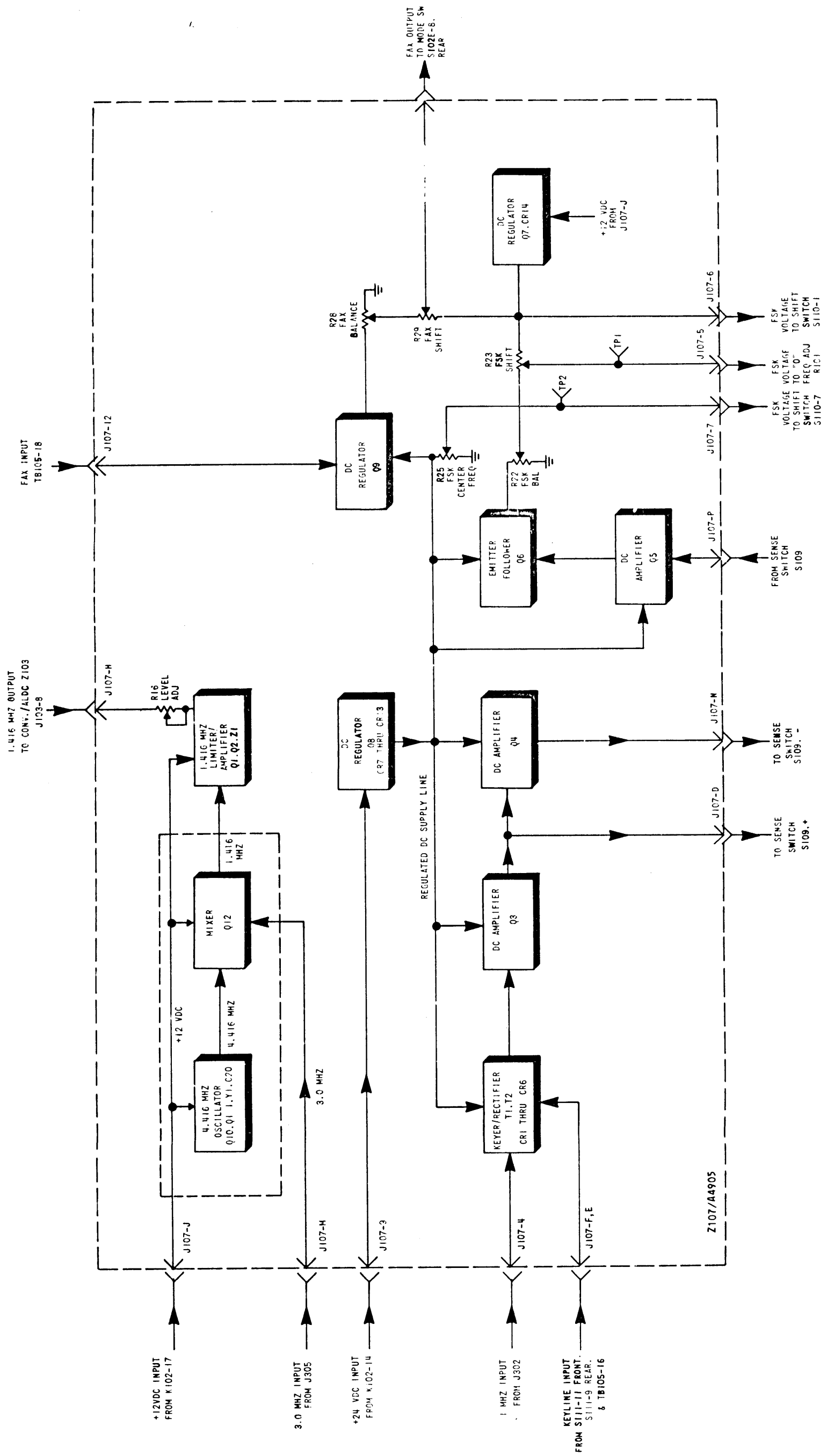
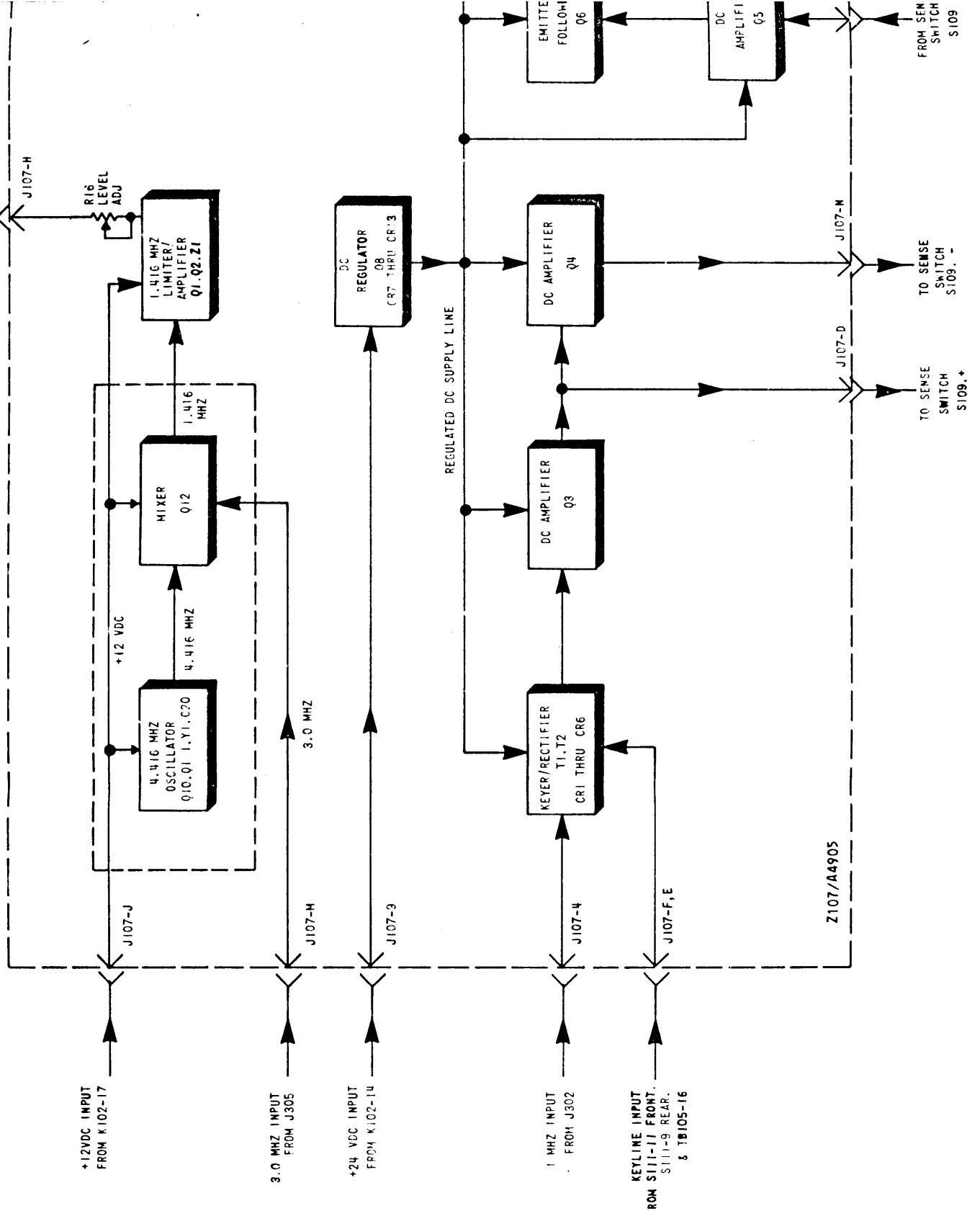


FIGURE 6. SERVICING BLOCK DIAGRAM, FREQUENCY SHIFTER GENERATOR/OSCILLATOR-MIXER Z107

1.416 MHZ OUTPUT  
TO COMV./ALDC Z103  
J103-B



Z107/A4905



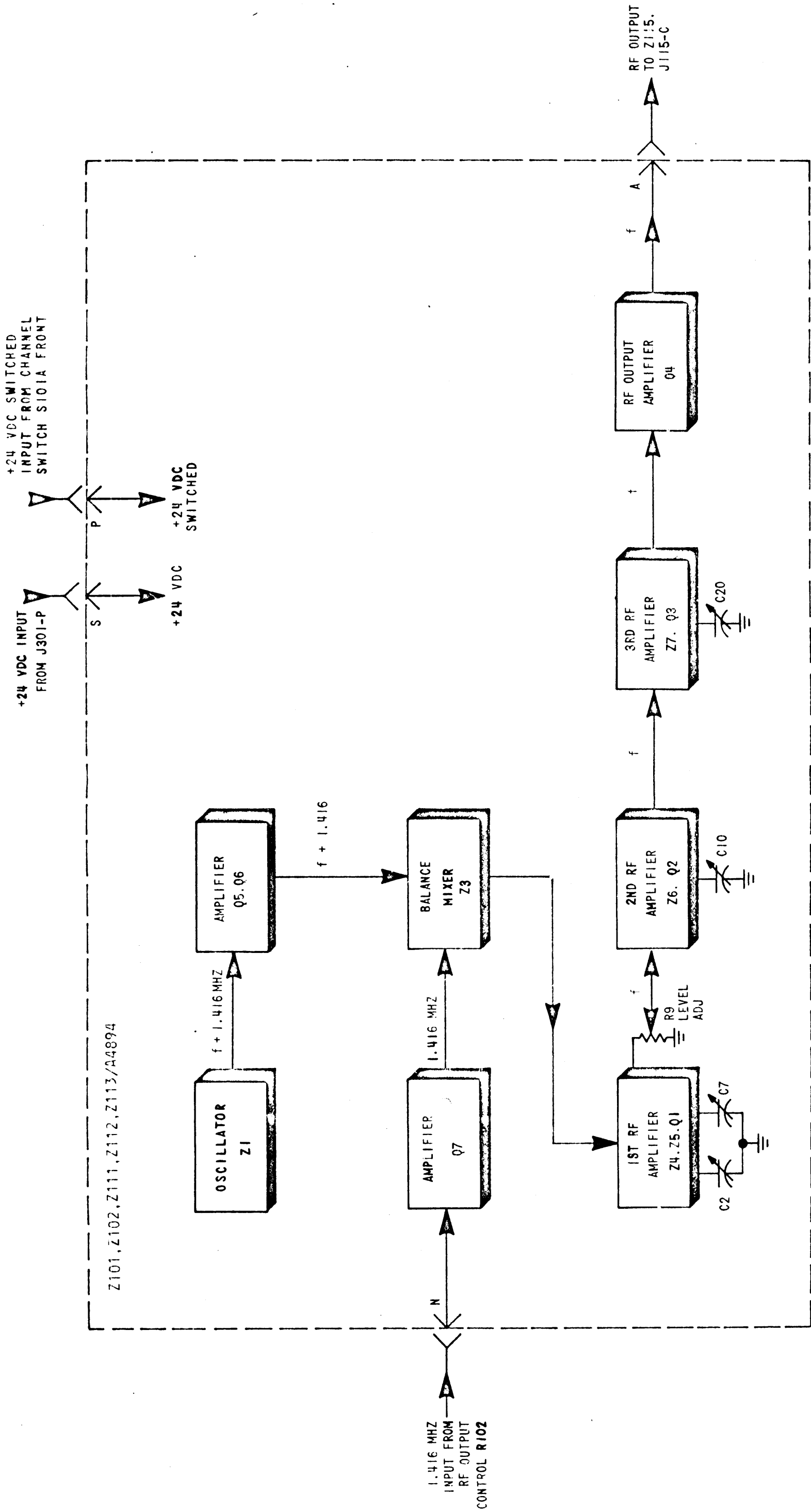


FIGURE 8. SERVICING BLOCK DIAGRAM, RF AMPLIFIERS Z101, Z102, Z111, Z112, Z113

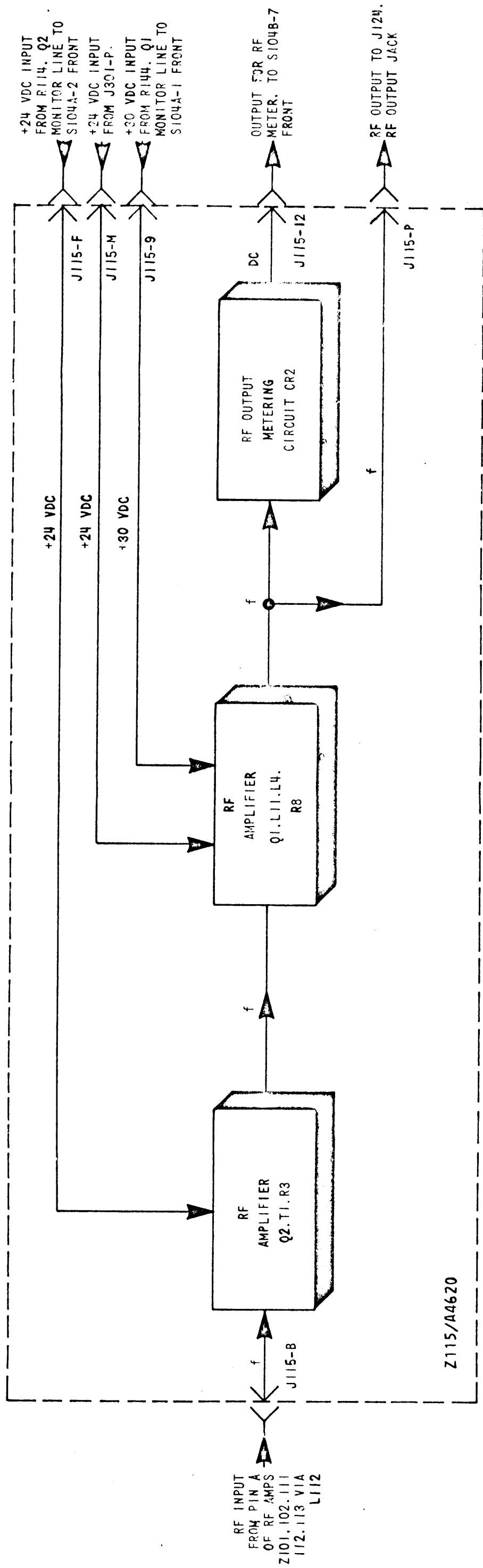


FIGURE 9. SERVICING BLOCK DIAGRAM, RF OUTPUT ASSEMBLY Z115

NOTE

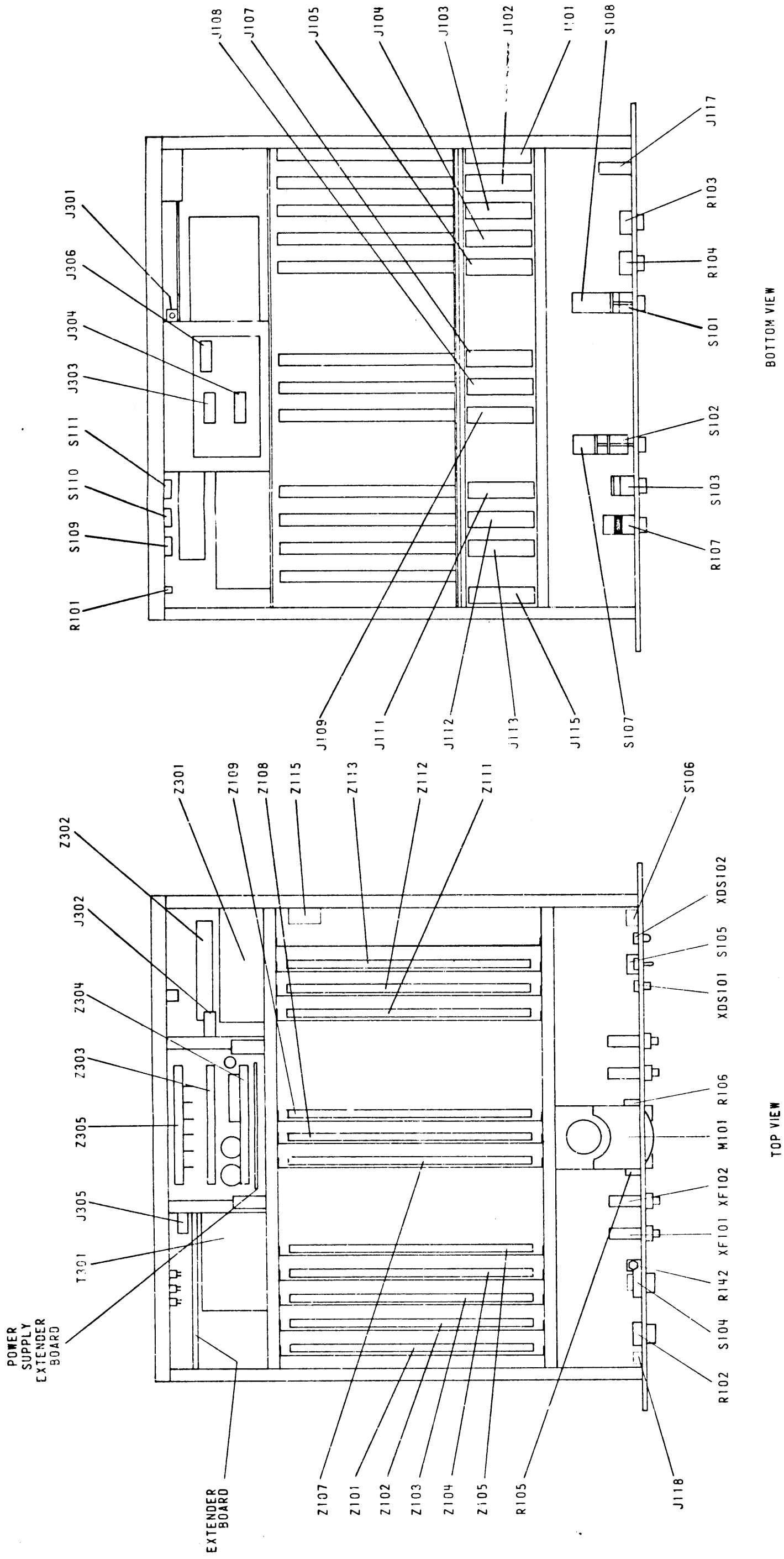
Figure 10 (sheets 1 and 2, of 2) is supplied separately in an envelope, attached to the back cover of this Service Manual.

Figure 10. Overall Schematic Diagram,  
MFER-1 Multi-Mode,  
Channelized Exciter







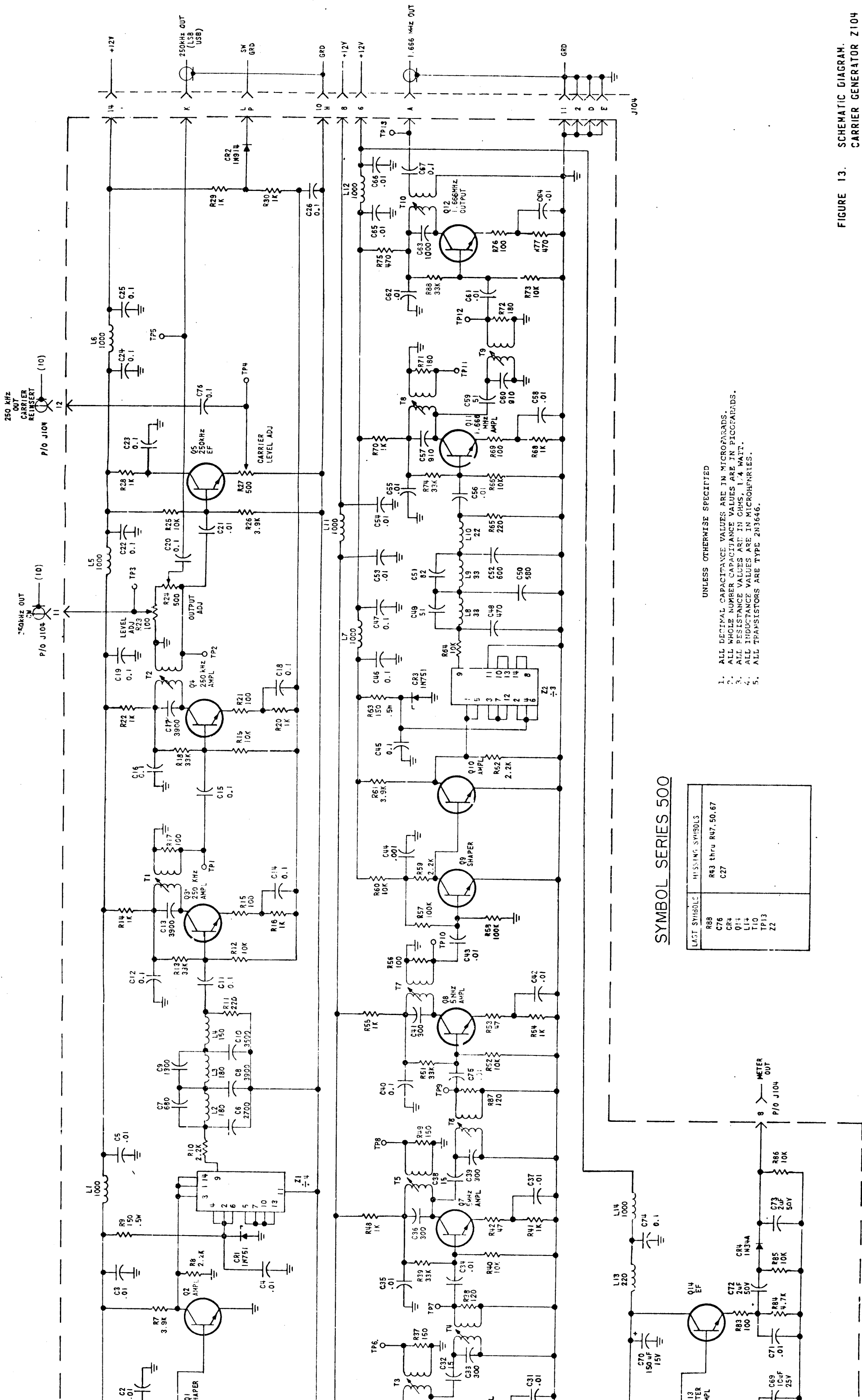


BOTTOM VIEW

TOP VIEW

FIGURE 12 OVERALL COMPONENT LOCATION. MFER-1 MULTI-MODE. CHANNELIZED EXCITER





- UNLESS OTHERWISE SPECIFIED
1. ALL DECIMAL CAPACITANCE VALUES ARE IN MICROFARADS.
  2. ALL WHOLE NUMBER CAPACITANCE VALUES ARE IN PICOFARADS.
  3. ALL RESISTANCE VALUES ARE IN OHMS, 1/4 WATT.
  4. ALL INDUCTANCE VALUES ARE IN MICROHENRIES.
  5. ALL TRANSISTORS ARE TYPE 2N3646.

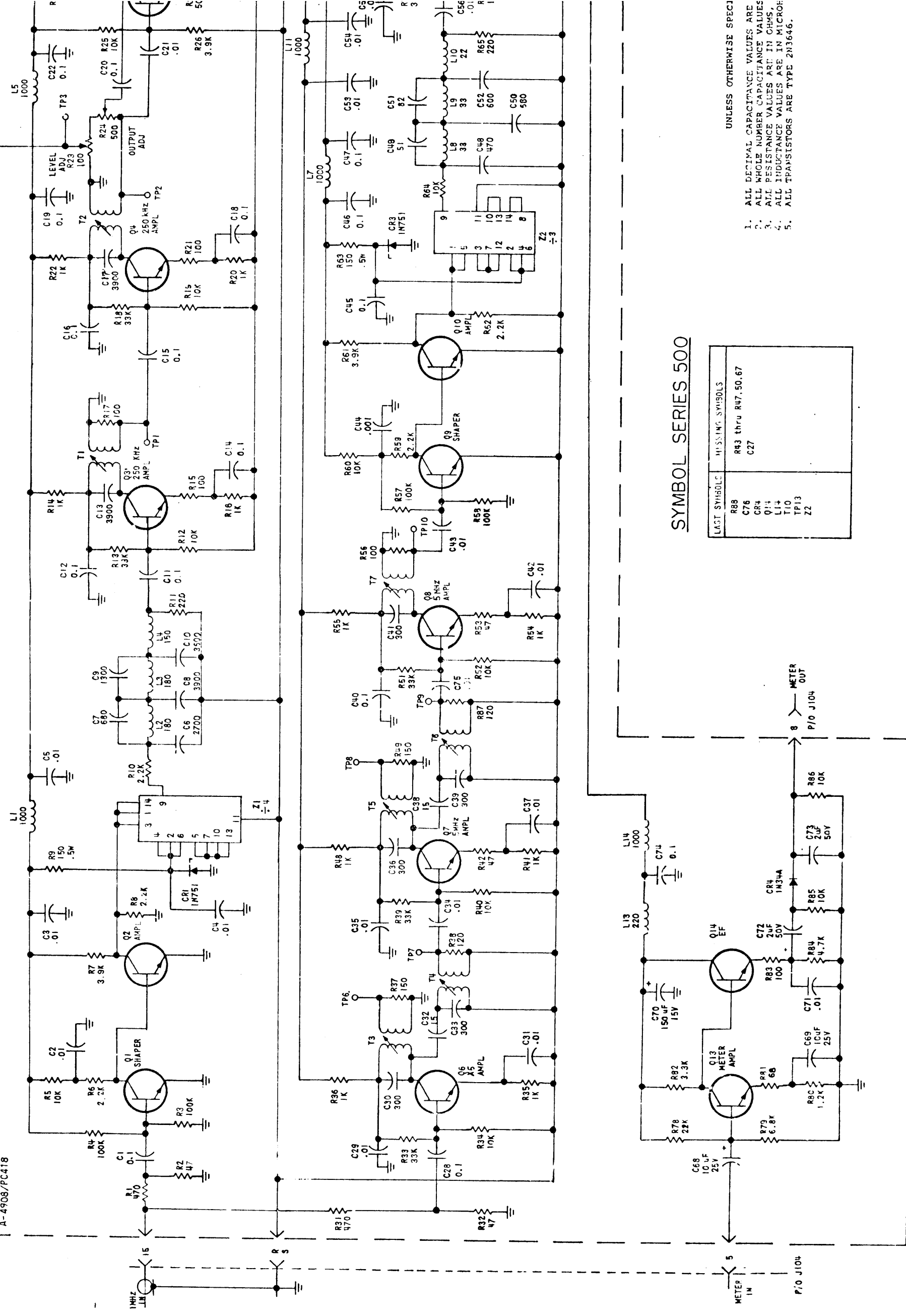
**SYMBOL SERIES 500**

LAST SYMBOLS	MISSING SYMBOLS
R88	R43 thru R47, 50, 67
C76	C27
CR4	
Q14	
L14	
T10	
TP13	
Z2	

FIGURE 13. SCHEMATIC DIAGRAM. CARRIER GENERATOR Z104

50KHZ OUT  
P/O J104

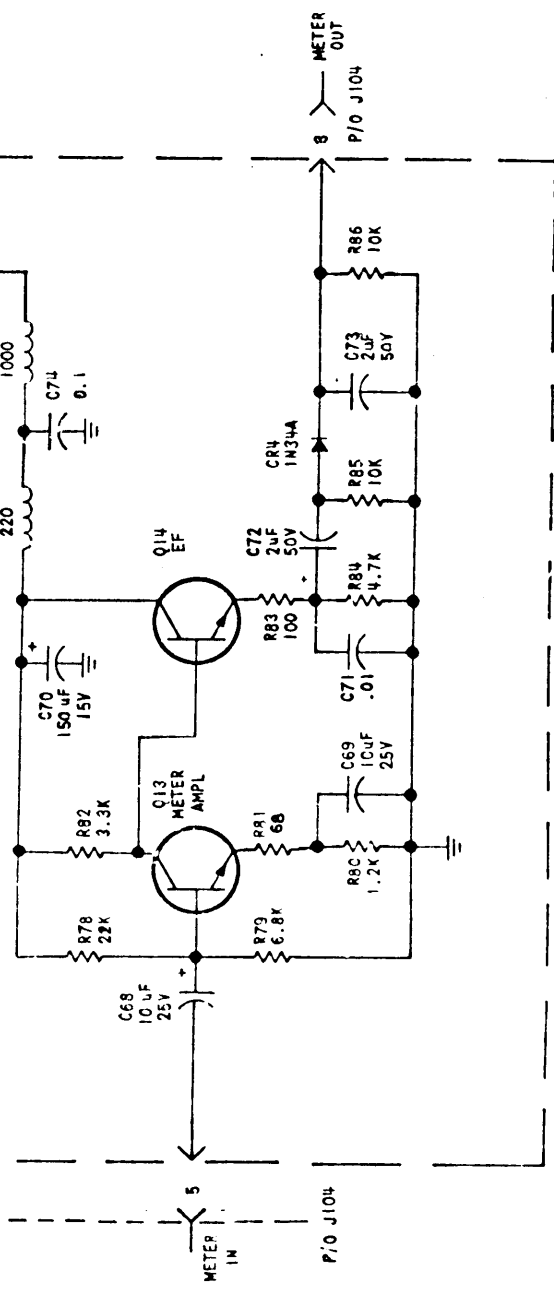
Z104  
A-4908/PC418

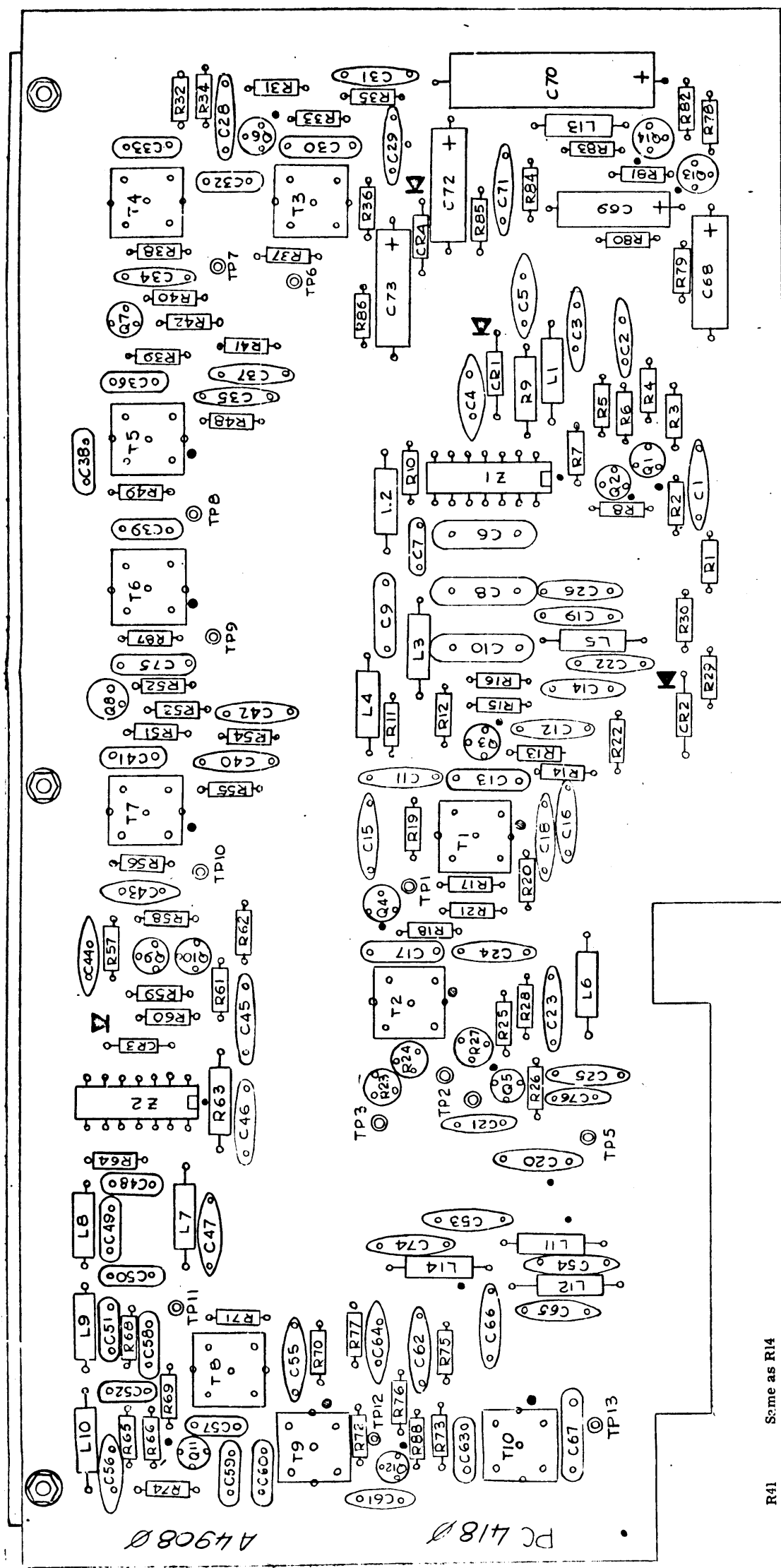


SYMBOL SERIES 500

LAST SYMBOLS	MISSING SYMBOLS
R88	R43 thru R47, 50, 67
C76	C27
CR4	
Q14	
L14	
T10	
TP13	
Z2	

- UNLESS OTHERWISE SPECIFIED:
1. ALL DECIMAL CAPACITANCE VALUES ARE IN MICROFARADS.
  2. ALL WHOLE NUMBER CAPACITANCE VALUES ARE IN PICOFARADS.
  3. ALL RESISTANCE VALUES ARE IN OHMS.
  4. ALL INDUCTANCE VALUES ARE IN MICROHENRYS.
  5. ALL TRANSISTORS ARE TYPE 2N3646.





CE105-10-25	Capacitor, Elect	C68
CE105-150-15	Same as C68	C69
CE105-2-50	Capacitor, Elect	C70
	Same as C2	C71
	Capacitor, Elect	C72
	Same as C72	C73
	Same as C1	C74
	Same as C2	C75
	Same as C1	C76
IN751	Semiconductor, Dev, Diode	CR1
IN914	Semiconductor, Dev, Diode	CR2
IN34A	Same as CR1	CR3
CL275-102	Semiconductor, Dev, Diode	CR4
CL275 181	Coil	L1
CL275-151	Coil	L2
	Same as L2	L3
	Coil	L4
	Same as L1	L5
	Same as L1	L6
	Same as L1	L7
CL275-330	Coil	L8
CL275-220	Same as L8	L9
	Coil	L10
	Same as L1	L11
	Same as L1	L12
CL275-221	Coil	L13
2N3646	Same as L1	L14
	Transistor	Q1
		thru
		Q14
RC07GF47J	Resistor, Fixed, Composition	R1
RC07GF470J	Resistor, Fixed, Composition	R2
RC07GF104J	Resistor, Fixed, Composition	R3
	Same as R3	R4
RC07GF103J	Resistor, Fixed, Composition	R5
RC07GF222J	Resistor, Fixed, Composition	R6
RC07GF392J	Resistor, Fixed, Composition	R7
	Same as R6	R8
RC20GF151J	Resistor, Fixed, Composition	R9
	Same as R6	R10
	Resistor, Fixed, Composition	R11
	Same as R5	R12
RC07GF333J	Resistor, Fixed, Composition	R13
RC07GF102J	Resistor, Fixed, Composition	R14
RC07GF101J	Resistor, Fixed, Composition	R15
	Same as R14	R16
	Same as R15	R17
	Same as R13	R18
	Same as R5	R19
	Same as R4	R20
	Same as R15	R21
	Same as R14	R22
	Resistor, Variable, Composition	R23
RV124-1-101	Resistor, Variable, Composition	R24
RV124-1-501	Same as R5	R25
	Same as R7	R26
	Same as R24	R27
	Same as R14	R28
	Same as R14	R29
	Same as R14	R30
	Same as R1	R31
	Same as R2	R32
	Same as R13	R33
	Same as R5	R34
	Same as R14	R35
	Same as R14	R36
RC07GF151J	Resistor, Fixed, Composition	R37
RC07GF121J	Resistor, Fixed, Composition	R38
	Same as R13	R39
	Same as R5	R40

R78	Resistor, Fixed, Composition	RC07GF233J
R79	Resistor, Fixed, Composition	RC07GF682J
R80	Resistor, Fixed, Composition	RC07GF122J
R81	Resistor, Fixed, Composition	RC07GF680J
R82	Resistor, Fixed, Composition	RC07GF332J
R83	Same as R15	
R84	Resistor, Fixed, Composition	RC07GF472J
R85	Same as R5	
R86	Same as R5	
R87	Same as R38	
R88	Same as R13	
T1	Transformer, RF, Adj	TT285-12
T2	Transformer, RF, Adj	TT285-11
T3	Transformer, RF, Tune	TT286-6
thru		
T7	Transformer, RF, Tune	TT286-4
T8	Same as T8	
T9	Transformer, RF, Tune	TT286-5
T10	Dual Flip-Flop	NW159
Z1	Same as Z1	
Z2		

R41	Same as R14	
R42	Same as R2	
R43	Not Used	
thru		
R47		
R48	Same as R14	
R49	Same as R37	
R50	Not Used	
R51	Same as R13	
R52	Same as R5	
R53	Same as R2	
R54	Same as R14	
R55	Same as R14	
R56	Same as R15	
R57	Same as R3	
R58	Same as R3	
R60	Same as R5	
R61	Same as R7	
R62	Same as R6	
R63	Same as R9	
R64	Same as R5	
R65	Same as R11	
R66	Same as R5	
R67	Not Used	
R68	Same as R14	
R69	Same as R15	
R70	Same as R14	
R71	Resistor, Fixed, Composition	RC07GF181J
R72	Same as R71	
R73	Same as R5	
R74	Same as R13	
R75	Same as R1	
R76	Same as R15	
R77	Same as R1	

FIGURE 14. COMPONENT LOCATION AND PARTS LIST.

Parts List for A-4908

CEI05-10-25

CEI05-150-15

CEI05-2-50

IN751

IN914

IN34A

CL275-102

CL275 181

CL275-151

CL275-330

CL275-220

CL275-221

2N3646

RC07GF471J

RC07GF470J

RC07GF104J

RC07GF103J

RC07GF222J

RC07GF392J

RC20GF151J

RC07GF221J

RC07GF333J

RC07GF102J

RC07GF101J

RV124-1-101

RV124-1-501

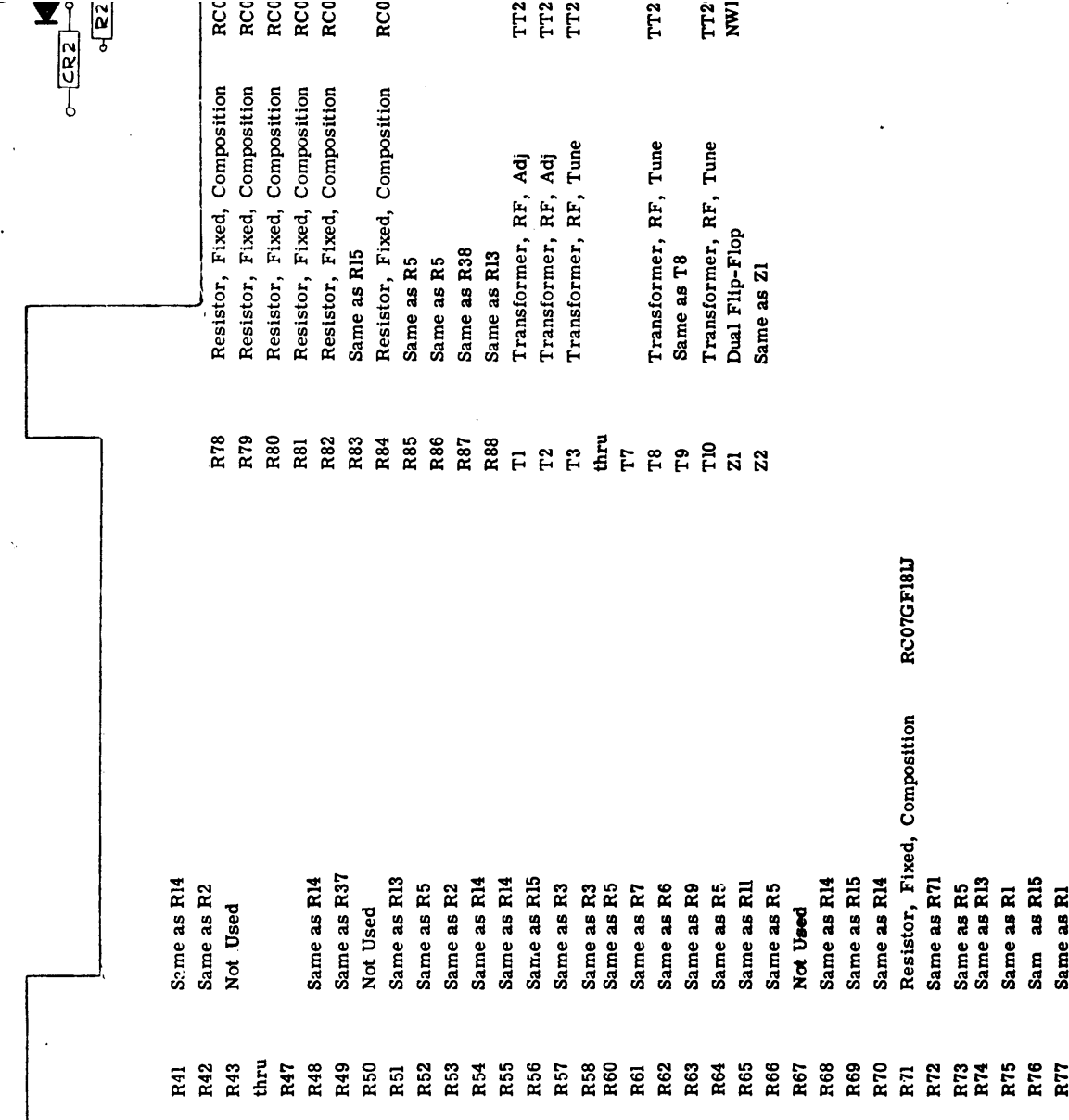
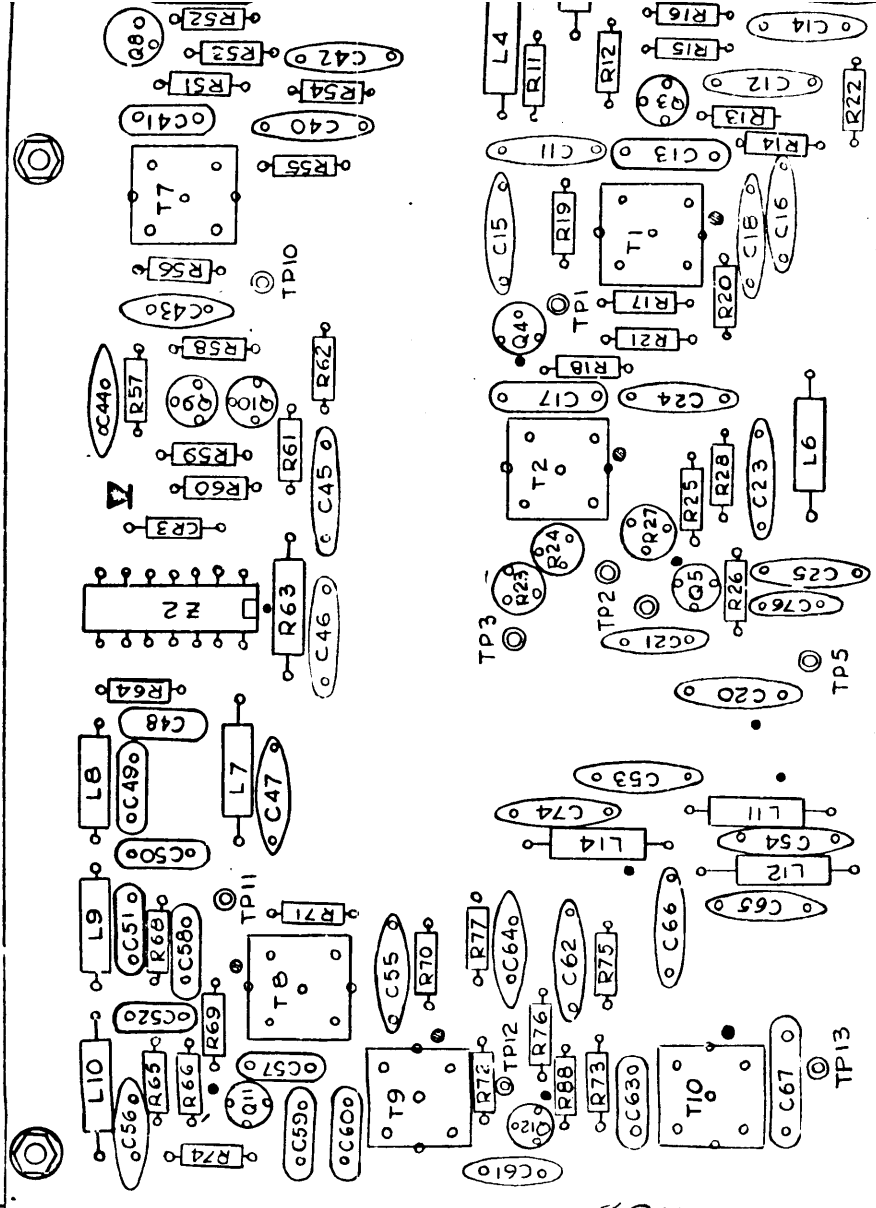
RC07GF151J

RC07GF121J

RC07GF181J

SYMBOL	DESCRIPTION	TMC P/N	Part Number	Quantity	Notes
C68	Capacitor, E1 ct		CEI05-10-25		
C69	Same as C68				
C70	Capacitor, Elect		CEI05-150-15		
C71	Same as C2				
C72	Capacitor, Elect		CEI05-2-50		
C73	Same as C72	CC100-44			
C74	Same as C1	CC100-16			
C75	Same as C2				
C76	Same as C1				
CR1	Semiconductor, Dev, Diode		IN751		
CR2	Semiconductor, Dev, Diode	CM112F272F5S	IN914		
CR3	Same as CR1	CM111F681J3S			
CR4	Semiconductor, Dev, Diode	CM112F392G3S	IN34A		
L1	Coil	CM112F132F5S	CL275-102		
L2	Coil	CM112F362G5S	CL275 181		
L3	Same as L2				
L4	Coil		CL275-151		
L5	Same as L1				
L6	Same as L1				
L7	Same as L1				
L8	Coil		CL275-330		
L9	Same as L8				
L10	Coil		CL275-220		
L11	Same as L1				
L12	Same as L1				
L13	Coil		CL275-221		
L14	Same as L1				
Q1	Transistor		2N3646		
Q14	Not Used				
R1	Resistor, Fixed, Composition		RC07GF471J		
R2	Resistor, Fixed, Composition		RC07GF470J		
R3	Resistor, Fixed, Composition		RC07GF104J		
R4	Same as R3	CM111F301J5S			
R5	Resistor, Fixed, Composition	CM111C150J5S	RC07GF103J		
R6	Resistor, Fixed, Composition		RC07GF222J		
R7	Resistor, Fixed, Composition		RC07GF392J		
R8	Same as R6				
R9	Resistor, Fixed, Composition		RC20GF151J		
R10	Same as R6				
R11	Resistor, Fixed, Composition		RC07GF221J		
R12	Same as R5				
R13	Resistor, Fixed, Composition		RC07GF333J		
R14	Resistor, Fixed, Composition		RC07GF102J		
R15	Resistor, Fixed, Composition		RC07GF101J		
R16	Same as R14				
R17	Same as R15				
R18	Same as R13	CC100-29			
R19	Same as R5				
R20	Same as R4				
R21	Same as R15	CM111F471F5S			
R22	Same as R14	CM111E510G5S			
R23	Resistor, Variable, Composition		RV124-1-101		
R24	Resistor, Variable, Composition	CM111E820F5S	RV124-1-501		
R25	Same as R5	CM111F601J3S			
R26	Same as R7				
R27	Same as R24				
R28	Same as R14				
R29	Same as R14				
R30	Same as R14				
R31	Same as R1	CM111F91J1S			
R32	Same as R2				
R33	Same as R13				
R34	Same as R5				
R35	Same as R14				
R36	Same as R14	CM111F102F1S			
R37	Resistor, Fixed, Composition		RC07GF151J		
R38	Resistor, Fixed, Composition		RC07GF121J		
R39	Same as R13				
R40	Same as R5				
R41	Same as R14				
R42	Same as R2				
R43	Not Used				
R44	Same as R14				
R45	Same as R14				
R46	Same as R2				
R47	Same as R5				
R48	Same as R14				
R49	Same as R37				
R50	Not Used				
R51	Same as R13				
R52	Same as R5				
R53	Same as R2				
R54	Same as R14				
R55	Same as R14				
R56	Same as R15				
R57	Same as R3				
R58	Same as R3				
R59	Same as R5				
R60	Same as R5				
R61	Same as R7				
R62	Same as R6				
R63	Same as R9				
R64	Same as R5				
R65	Same as R11				
R66	Same as R5				
R67	Not Used				
R68	Same as R14				
R69	Same as R15				
R70	Same as R14				
R71	Resistor, Fixed, Composition		RC07GF181J		
R72	Same as R71				
R73	Same as R5				
R74	Same as R13				
R75	Same as R1				
R76	Same as R15				
R77	Same as R1				
R78	Resistor, Fixed, Composition				
R79	Resistor, Fixed, Composition				
R80	Resistor, Fixed, Composition				
R81	Resistor, Fixed, Composition				
R82	Resistor, Fixed, Composition				
R83	Same as R15				
R84	Resistor, Fixed, Composition				
R85	Same as R5				
R86	Same as R5				
R87	Same as R38				
R88	Same as R13				
T1	Transformer, RF, Adj		TT2		
T2	Transformer, RF, Adj		TT2		
T3	Transformer, RF, Tune		TT2		
thru					
T7	Transformer, RF, Tune		TT2		
T8	Same as T8				
T9	Same as T8				
T10	Transformer, RF, Tune		TT2		
Z1	Dual Flip-Flop		NW1		
Z2	Same as Z1				

449080 PC 418





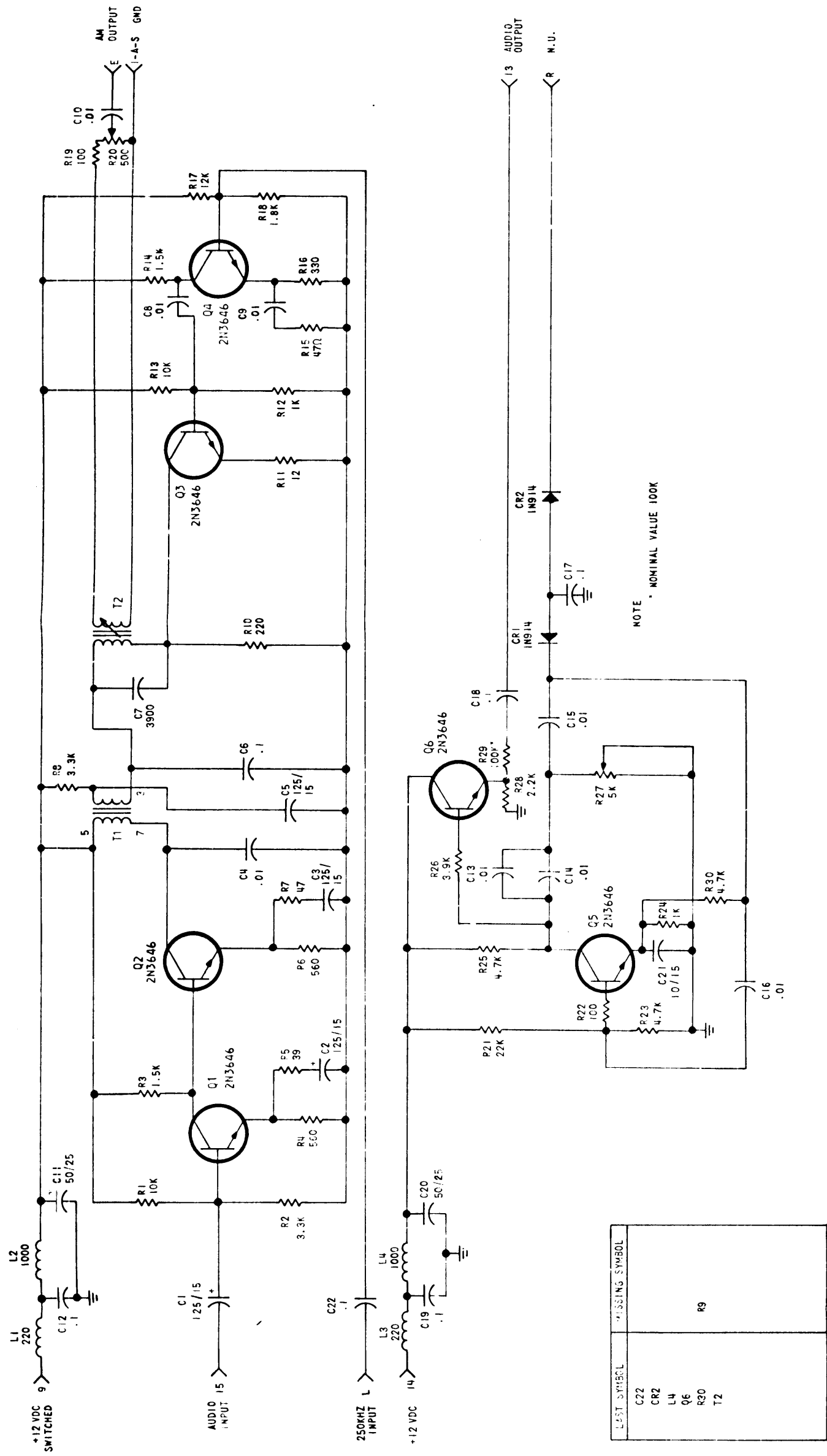


FIGURE 15. SCHEMATIC DIAGRAM. TONE GENERATOR/A2 MODULATOR Z108

Parts List for A-4901

SYMBOL	DESCRIPTION	TMC P/N
C1	Capacitor, Fixed, Elec	CE105-125-15
C2	Same as C1	
C3	Same as C1	
C4	Capacitor, Fixed, Ceramic	CC100-43
C5	Same as C1	
C6	Capacitor, Fixed, Ceramic	CC100-44
C7	Capacitor, Mica, Dip	CM112F392G
C8	Same as C4	
C9	Same as C4	
C10	Same as C4	
C11	Capacitor, Fixed, Elec	CE105-50-25
C12	Same as C6	
C13	Capacitor, Fixed, Paper	CN100-1
thru		
C16	Same as C6	
C17	Same as C6	
C18	Same as C6	
C19	Same as C6	
C20	Same as C11	
C21	Capacitor, Fixed, Elec	CE105-10-15
C22	Same as C6	
CR1	Semiconductor, Dev, Diode	IN914
CR2	Same as CR1	
L1	Coil, RF	CL275-221
L2	Coil, RF	CL275-102
L3	Same as L1	
L4	Same as L2	
Q1	Transistor	2N3646
thru		
Q6		
R1	Resistor, Fixed, Composition	RC07GF103J
R2	Resistor, Fixed, Composition	RC07GF332J
R3	Resistor, Fixed, Composition	RC07GF152J
R4	Resistor, Fixed, Composition	RC07GF561J
R5	Resistor, Fixed, Composition	RC07GF390J
R6	Same as R4	
R7	Resistor, Fixed, Composition	RC07GF470J
R8	Same as R2	
R9	Not Used	
R10	Resistor, Fixed, Composition	RC07GF271J
R11	Resistor, Fixed, Composition	RC07GF120J
R12	Resistor, Fixed, Composition	RC07GF102J
R13	Same as R1	
R14	Same as R3	
R15	Same as R7	
R16	Resistor, Fixed, Composition	RC07GF331J
R17	Resistor, Fixed, Composition	RC07GF122J
R18	Resistor, Fixed, Composition	RC07GF182J
R19	Resistor, Fixed, Composition	RC07GF101J
R20	Resistor, Variable, Composition	RV124-501
R21	Resistor, Fixed, Composition	RC07GF223J
R22	Same as R19	
R23	Resistor, Fixed, Composition	RC07GF472J
R24	Same as R12	
R25	Same as R23	
R26	Resistor, Fixed, Composition	RC07GF392J
R27	Resistor, Variable, Composition	RV111V502A
R28	Resistor, Fixed, Composition	RC07GF222J
R29	Resistor, Fixed, Composition	RC07GF104J
R30	Same as R23	
T1	Transformer, Audio	TF420
T2	Transformer, Tune	TT285-15

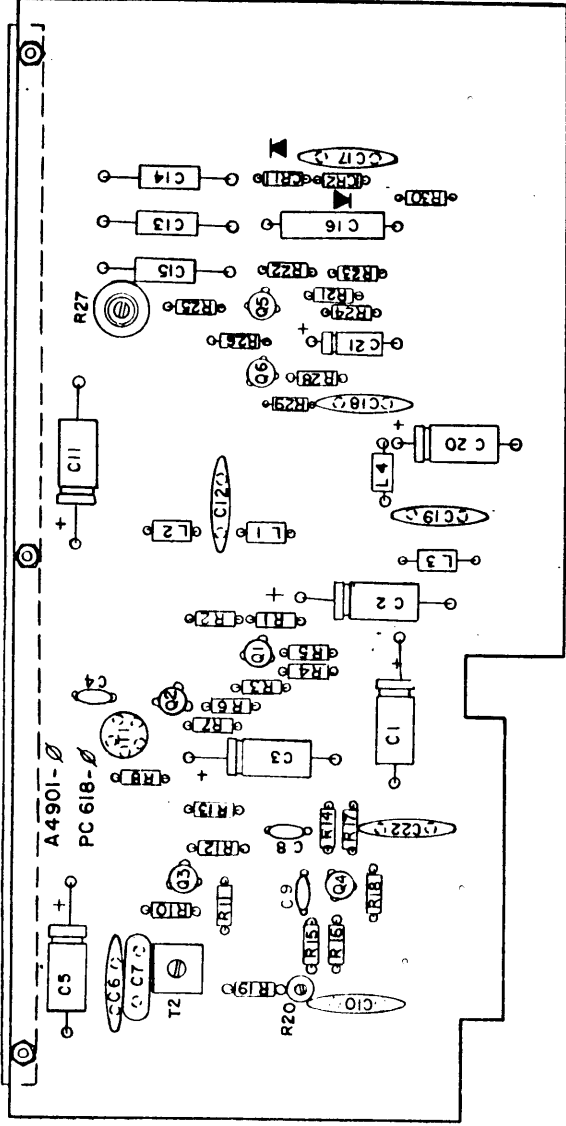


FIGURE 16. COMPONENT LOCATION AND PARTS LIST.  
TONE GENERATOR/A2 MODULATOR Z108

**SYMBOL SERIES (SEE TABLE)**

LAST SYMBOLS	MISSING SYMBOLS
C81	C16, 19, 20, 41, 62, 63, 72,
CR7	C75, 76, 77, 78, 79, 80
K1	L4, 6, 11
L17	R52, 62, 63, 64, 65, 88, 89
Q28	
R95	
T4	
Y1	
Z2	

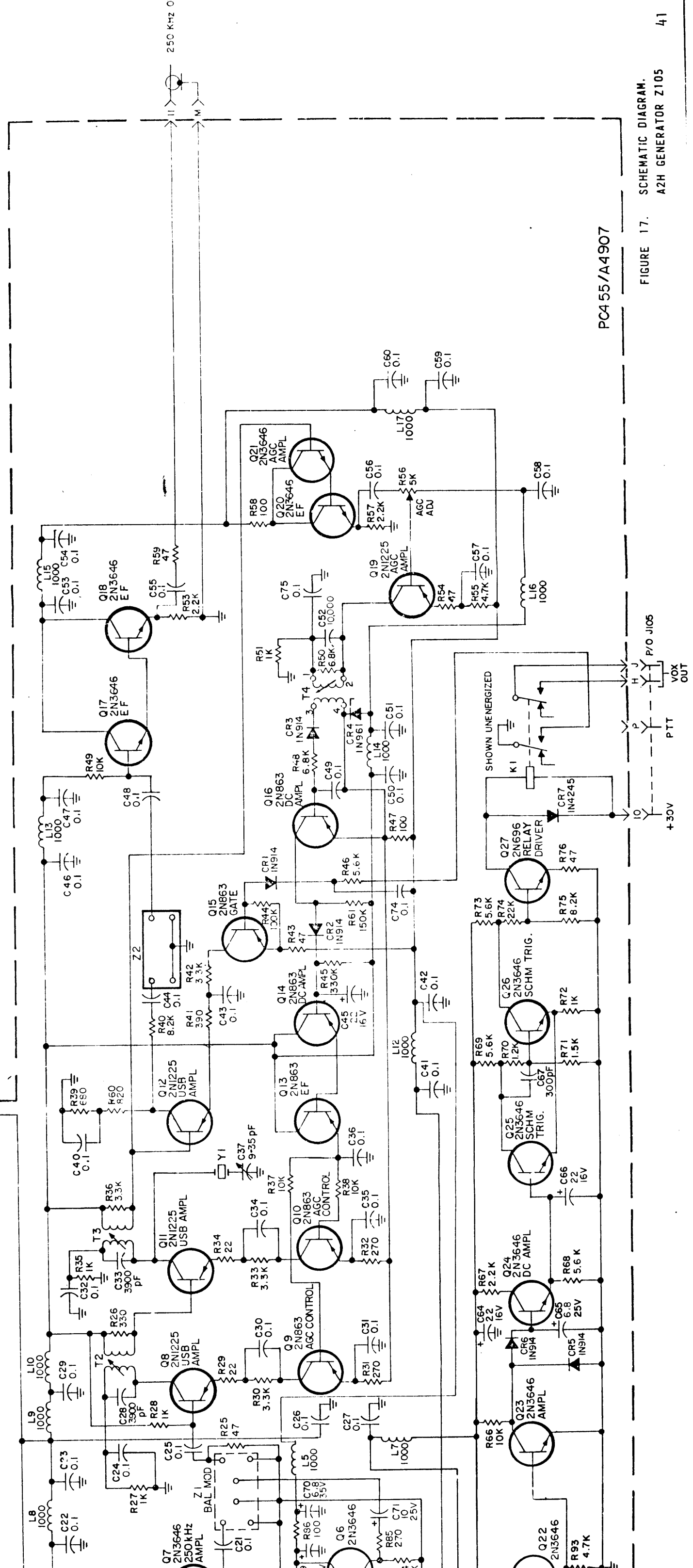
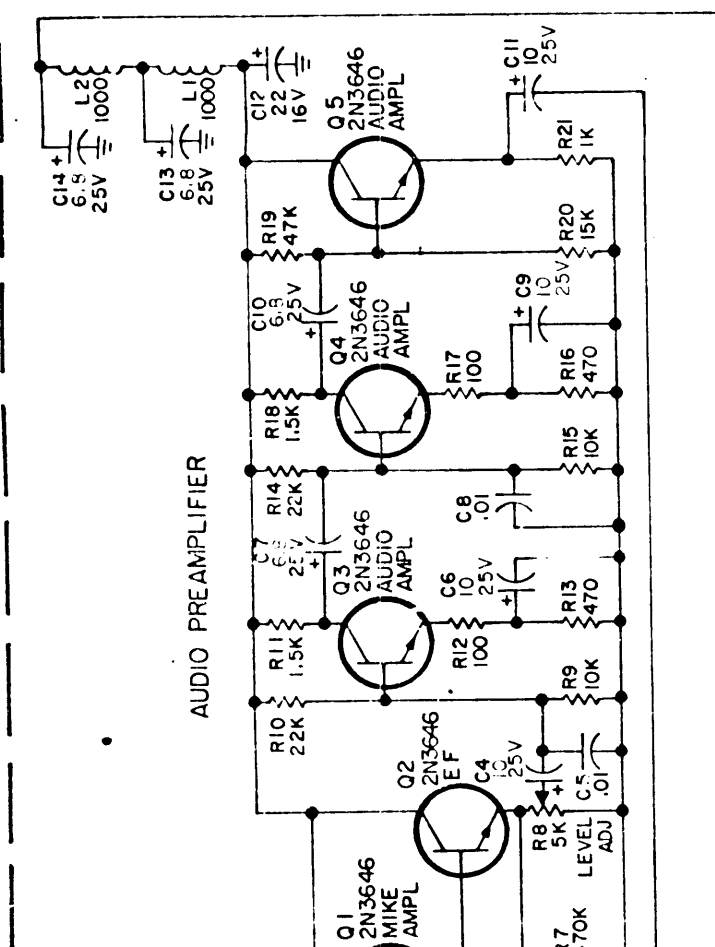
UNLESS OTHERWISE SPECIFIED

1- ALL RESISTANCE VALUES ARE IN OHMS, 1/4 WATT.

2- ALL CAPACITANCE VALUES ARE IN MICROFARADS.

3- ALL INDUCTANCE VALUES ARE IN MICROHENRIES.

**AUDIO PREAMPLIFIER**

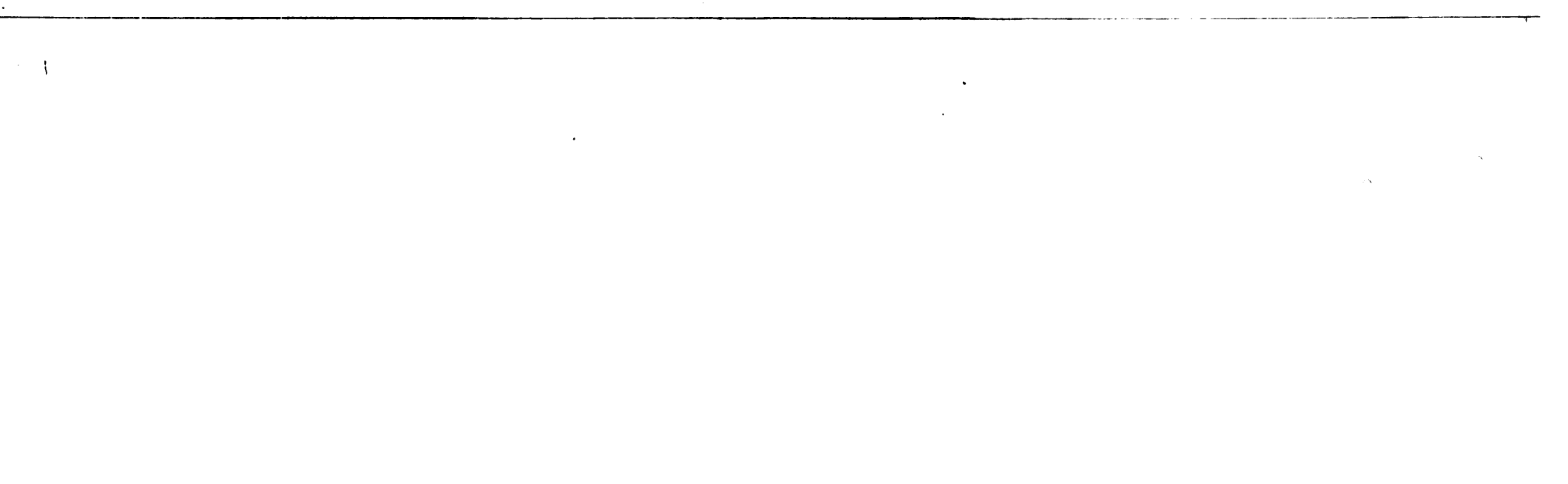
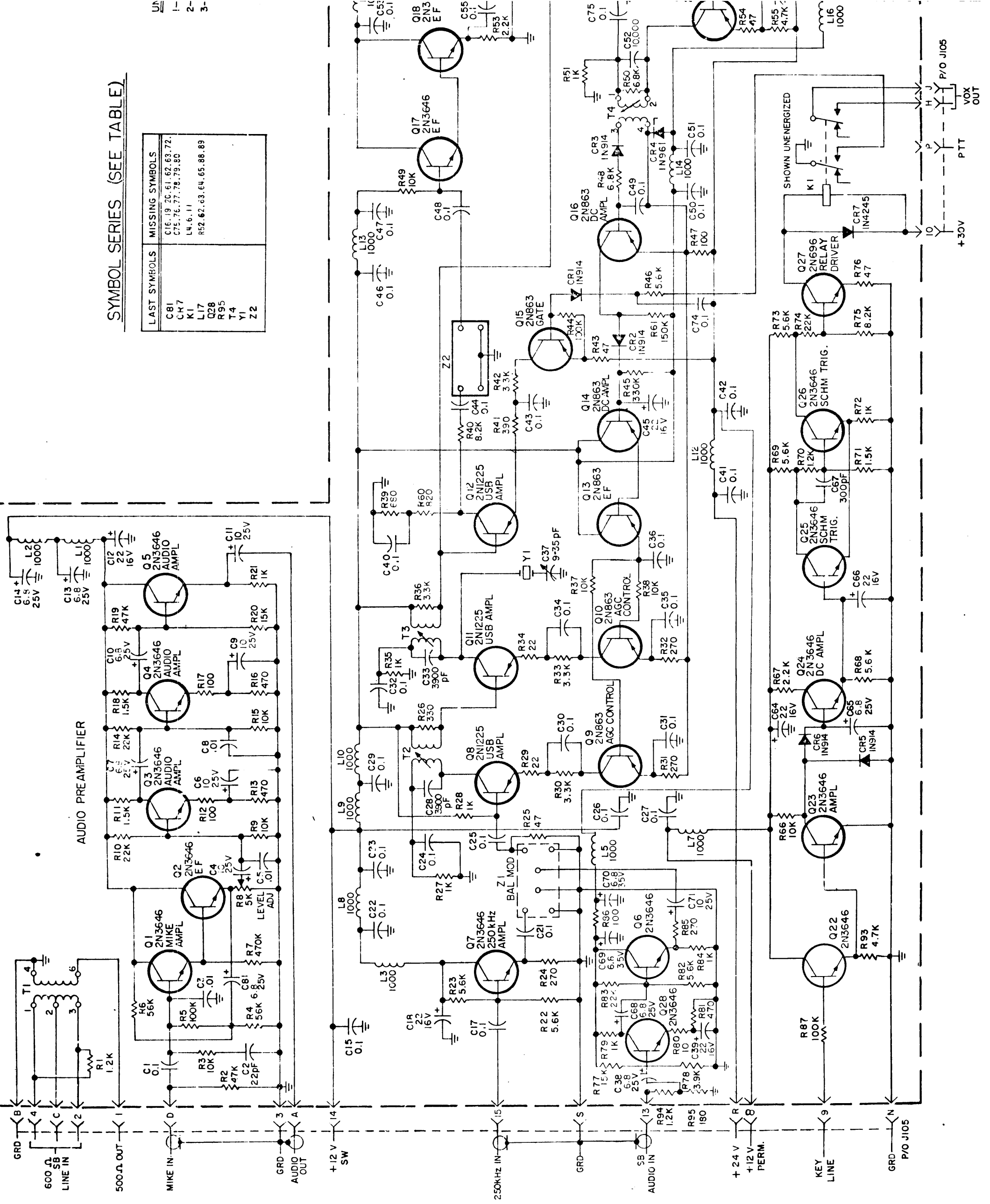


PC455/A4907

FIGURE 17. SCHEMATIC DIAGRAM. A2H GENERATOR Z105

**SYMBOL SERIES (SEE TABLE)**

LAST SYMBOLS	MISSING SYMBOLS
C81	C16, 19, 20, 61, 62, 63, 72,
CR7	C75, 76, 77, 78, 79, 80
K1	L4, 6, 11
L17	R52, 62, 63, 64, 65, 88, 89
Q28	
R95	
T4	
Y1	
Z2	

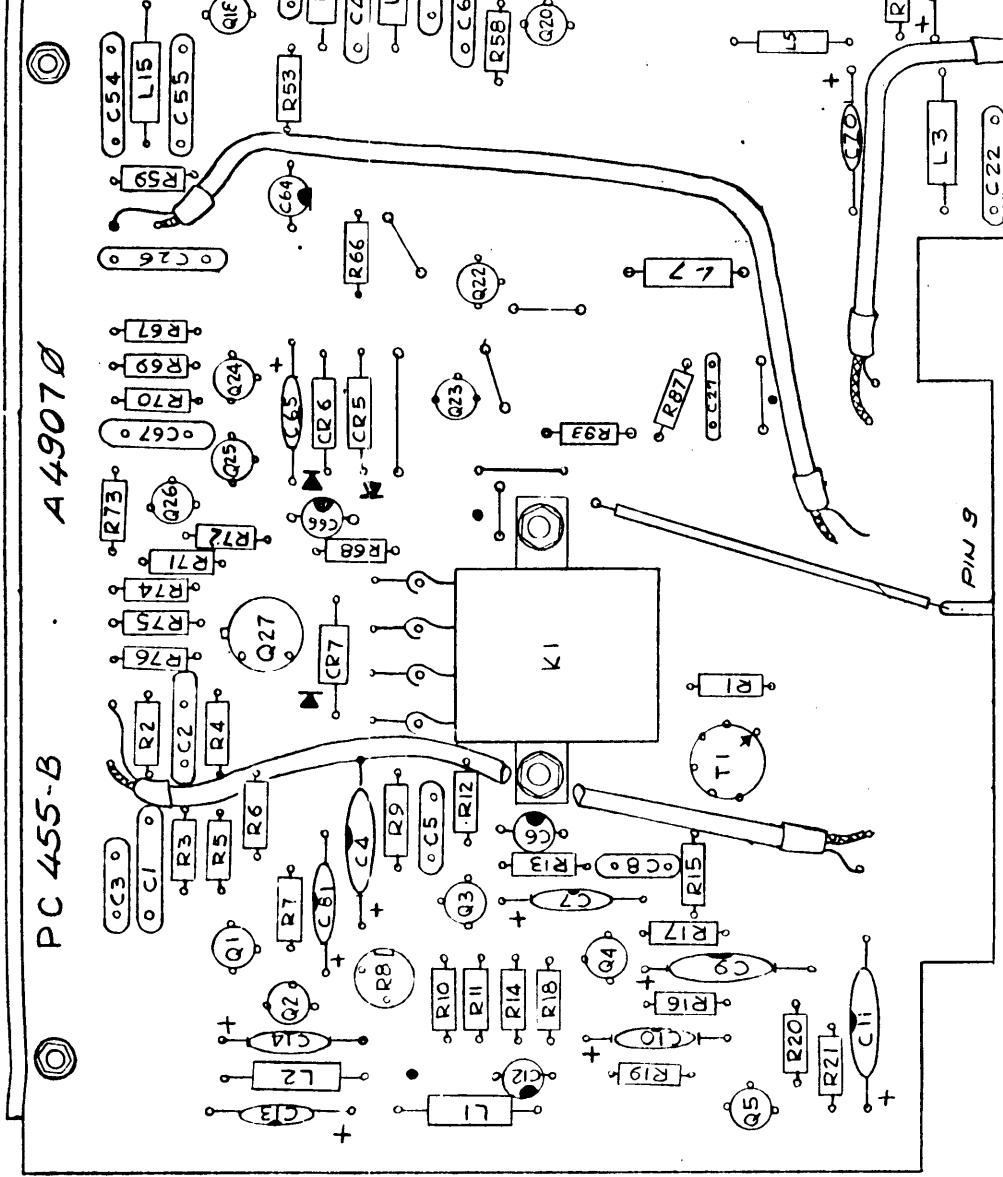




Parts List for A-4907

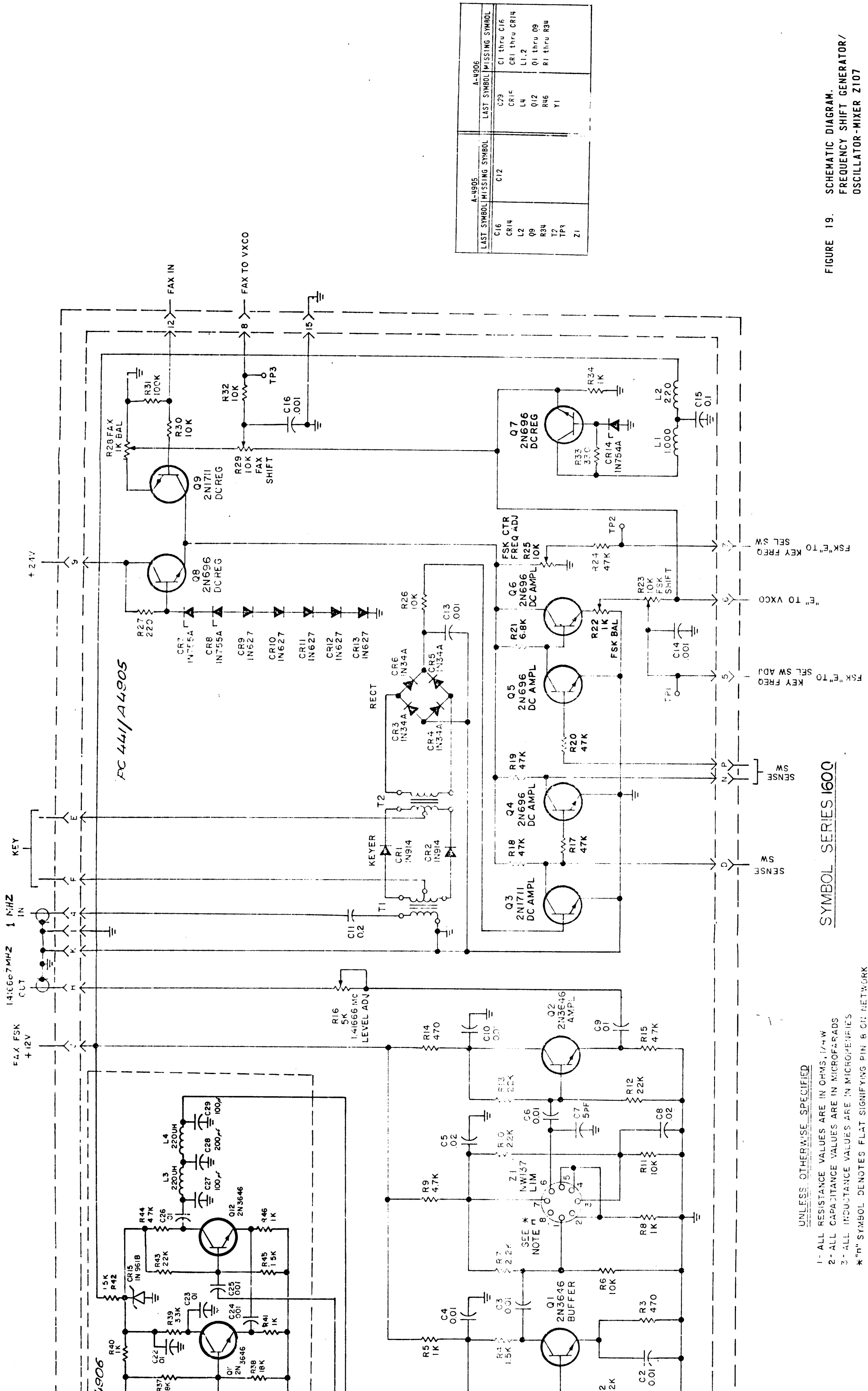
DESCRIPTION

SYMBOL	DESCRIPTION	TMC P/N	Notes
C1	Capacitor, Fixed, Ceramic		
C2	Capacitor, Fixed, Mica		
C3	Capacitor, Fixed, Ceramic	CC100-44	
C4	Capacitor, Fixed, Elec	CM11C220J5S	
C5	Same as C3	CC100-42	
C6	Same as C4	CE122-10-25	
C7	Capacitor, Fixed, Elec		
C8	Same as C3	CE122-6R8-25	
C9	Same as C4		
C10	Same as C7		
C11	Same as C4		
C12	Capacitor, Fixed, Elec	CE122-22-16	
C13	Same as C7		
C14	Same as C7		
C15	Same as C1		
C16	Not Used		
C17	Same as C1		
C18	Same as C12		
C19	Not Used		
C20	Not Used		
C21	Same as C1		
thru			
C27			
C28	Capacitor, Fixed, Mica	CM112F392G3S	
C29	Same as C1		
thru			
C32			
C33	Same as C28		
C34	Same as C1		
C35	Same as C1		
C36	Same as C1		
C37	Capacitor, Variable	CV112-8	
C38	Same as C7		
C39	Same as C12		
C40	Same as C1		
C41	Capacitor, Fixed, Ceramic	CC100-28	
C42	Same as C41		
C43	Same as C1		
C44	Same as C1		
C45	Same as C12		
C46	Same as C1		
C47	Same as C1		
C48	Same as C1		
C49	Same as C41		
C50	Same as C1		
C51	Same as C1		
C52	Capacitor, Fixed, Mica	CM112F103J1S	
C53	Same as C41		
C54	Same as C41		
C55	Same as C1		
C56	Same as C1		
C57	Same as C41		
C60	Same as C41		
C61	Not Used		
thru			
C63			
C64	Same as C12		
C65	Same as C7		
C66	Same as C12		
C67	Capacitor, Fixed, Mica	CM111F301K5S	
C68	Same as C7		
C69	Capacitor, Fixed, Elec	CE122-6R8-35	
C70	Same as C69		
C71	Same as C4		
C72	Not Used		



Symbol	Description	Notes
C73	Not Used	
C74	Same as C41	
C75	Same as C41	
C76	Not Used	
C77	Not Used	
C78	Not Used	
C79	Not Used	
C80	Not Used	
C81	Same as C7	
CR1	Semiconductor, Dev, Diode	IN914
CR2	Same as CR1	
CR3	Same as CR1	
CR4	Semiconductor, Dev, Diode	IN961
CR5	Same as CR1	
CR6	Same as CR1	
CR7	Semiconductor, Dev, Diode	IN4245
K1	Relay	RL143-4
L1	Coil	CL275-102
L2	Same as L1	
L3	Same as L1	
L4	Not Used	
L5	Same as L1	
L6	Not Used	
L7	Same as L1	
thru		
L10		
L11		
L12		
thru		
L17		
Q1	Transistor	2N3646
thru		
Q7		
Q8		
Q9	Transistor	2N1225
Q10	Transistor	2N863
Q11	Same as Q9	
Q12	Same as Q8	
Q13	Same as Q8	
thru		
Q16		
Q17	Same as Q1	
Q18	Same as Q1	
Q19	Same as Q8	
Q20	Same as Q1	
thru		
Q26		
Q27	Transistor	2N696
Q28	Same as Q1	
R1	Resistor, Fixed, Composition	RC07GF122J
R2	Resistor, Fixed, Composition	RC07GF473J
R3	Resistor, Fixed, Composition	RC07GF193J
R4	Resistor, Fixed, Composition	RC07GF563J
R5	Resistor, Fixed, Composition	RC07GF104J
R6	Same as R4	
R7	Resistor, Fixed, Composition	RC07GF474J
R8	Resistor, Variable	RV124-1-502
R9	Same as R3	
R10	Resistor, Fixed, Composition	RC07GF223J
R11	Resistor, Fixed, Composition	RC07GF152J
R12	Resistor, Fixed, Composition	RC07GF101J
R13	Resistor, Fixed, Composition	RC07GF471J
R14	Same as R10	
R15	Same as R3	
R16	Same as R13	
R17	Same as R13	
R18	Same as R12	
R19	Same as R11	
thru		
R21	Resistor, Fixed, Composition	RC07GF153J
R22	Resistor, Fixed, Composition	RC07GF102J
R23	Resistor, Fixed, Composition	RC07GF562J
R24	Same as R22	
R25	Resistor, Fixed, Composition	RC07GF271J
R26	Resistor, Fixed, Composition	RC07GF470J
R27	Resistor, Fixed, Composition	RC07GF331J
R28	Same as R21	
R29	Same as R21	
R30	Resistor, Fixed, Composition	RC07GF220J
R31	Resistor, Fixed, Composition	RC07GF332J
R32	Same as R24	
R33	Same as R24	
R34	Same as R30	
R35	Same as R29	
R36	Same as R21	
R37	Same as R30	
R38	Same as R3	
R39	Resistor, Fixed, Composition	RC07GF681J
R40	Resistor, Fixed, Composition	RC07GF822J
R41	Resistor, Fixed, Composition	RC07GF391J
R42	Same as R30	
R43	Same as R25	
R44	Same as R5	
R45	Resistor, Fixed, Composition	RC07GF334J
R46	Same as R22	
R47	Same as R12	
R48	Resistor, Fixed, Composition	RC07GF682J
R49	Same as R3	
R50	Same as R48	
R51	Same as R21	
R52	Not Used	
R53	Resistor, Fixed, Composition	RC07GF153J
R54	Same as R25	
R55	Resistor, Fixed, Composition	RC07GF271J
R56	Same as R8	
R57	Same as R53	
R58	Same as R12	
R59	Same as R25	
R60	Resistor, Fixed, Composition	RC07GF681J
R61	Resistor, Fixed, Composition	RC07GF822J
R62	Not Used	
thru		
R65		
R66	Same as R3	
R67	Same as R53	
R68	Same as R22	
R69	Same as R22	
R70	Same as R1	
R71	Same as R11	
R72	Same as R21	
R73	Same as R22	
R74	Same as R10	
R75	Same as R40	
R76	Same as R25	
R77	Same as R20	
R78	Resistor, Fixed, Composition	RC07GF681J
R79	Same as R21	
R80	Resistor, Fixed, Composition	RC07GF682J
R81	Same as R13	
R82	Same as R22	
R83	Same as R10	
R84	Same as R21	
R85	Same as R24	

PC 455-B A 4907



A-4905		A-4906	
LAST SYMBOL	MISSING SYMBOL	LAST SYMBOL	MISSING SYMBOL
C16	C12	C29	C1 thru C16
CR14		CR15	CR1 thru CR14
L2		L4	L1, 2
Q9		Q12	Q1 thru Q9
R34		R46	R1 thru R34
T2		Y1	
TP3			
Z1			

FIGURE 19. SCHEMATIC DIAGRAM. FREQUENCY SHIFT GENERATOR/OSCILLATOR-MIXER Z107

SYMBOL SERIES 1600

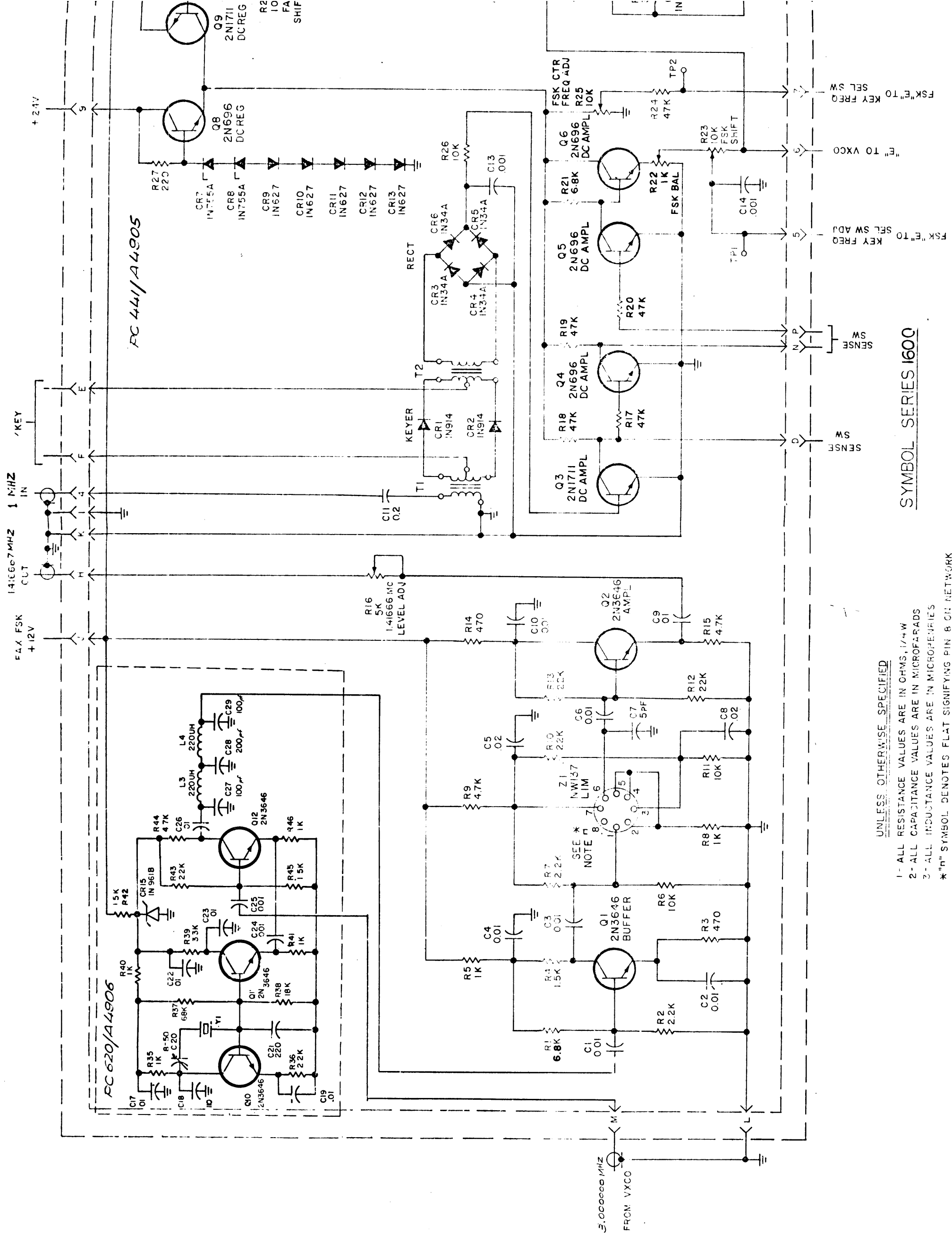
UNLESS OTHERWISE SPECIFIED

1 - ALL RESISTANCE VALUES ARE IN OHMS, 1/4 W

2 - ALL CAPACITANCE VALUES ARE IN MICROFARADS

3 - ALL INDUCTANCE VALUES ARE IN MICROHENRIES

\*"n" SYMBOL DENOTES FLAT SIGNIFYING PIN 8 OR NETWORK

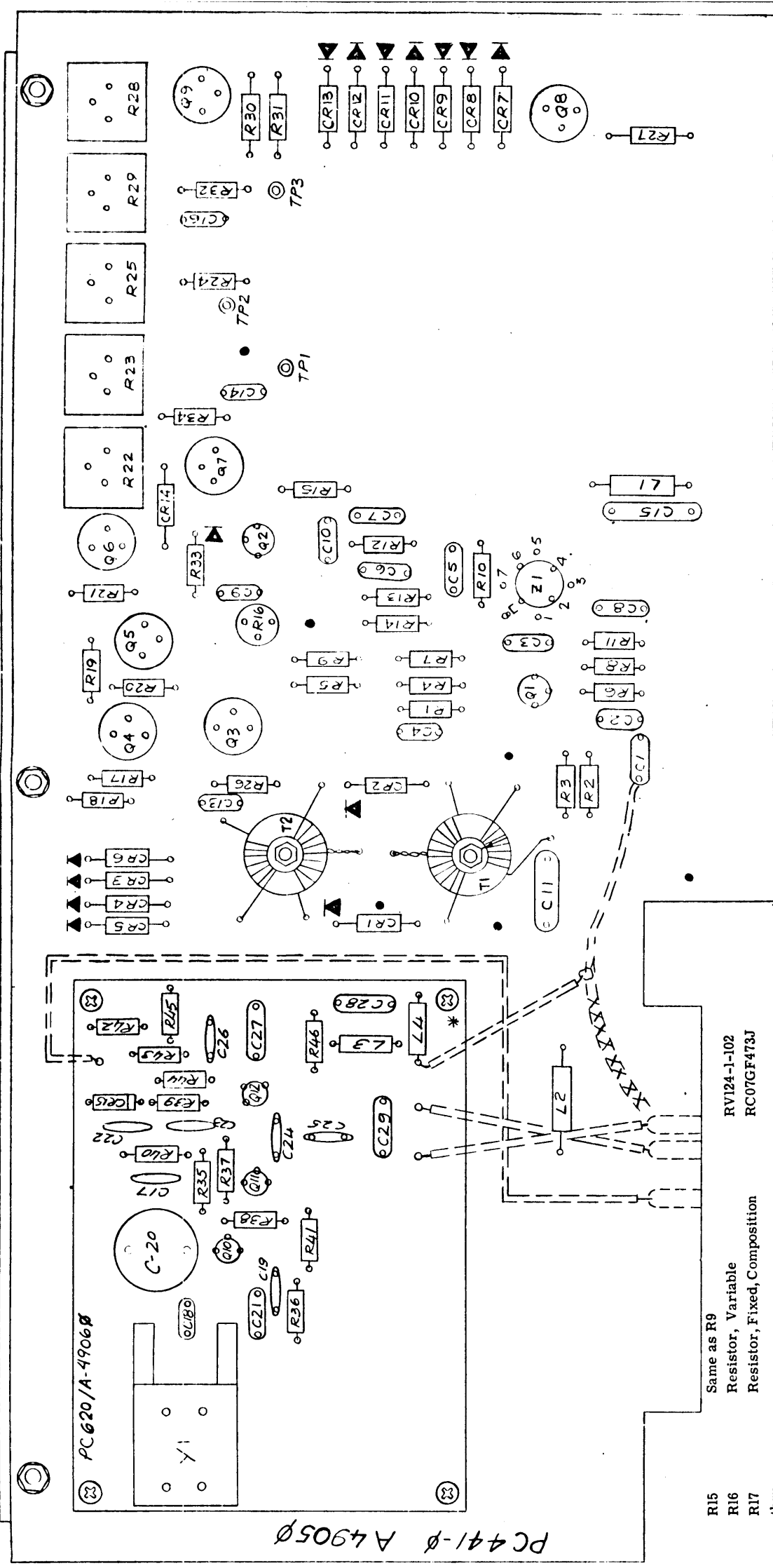


UNLESS OTHERWISE SPECIFIED

- 1- ALL RESISTANCE VALUES ARE IN OHMS, 1/4 W
- 2- ALL CAPACITANCE VALUES ARE IN MICROFARADS
- 3- ALL INDUCTANCE VALUES ARE IN MICROHENRIES
- \* "n" SYMBOL DENOTES FLAT SIGNIFYING PIN 8 ON NETWORK

**SYMBOL SERIES 1600**





Parts List for A-4905

SYM30L	TMC P/N	DESCRIPTION	TMC P/N
C1 thru C4	CC100-41	Capacitor, Fixed, Ceramic	CC100-41
C5	CC100-40	Capacitor, Fixed, Ceramic	CC100-40
C6	CM11F10G5S	Same as C1	CM11C050K5
C7	CV109-9	Capacitor, Fixed, Mica	
C8	CM11F22G5S	Same as C5	
C9		Same as C1	
C10		Same as C1	
C11	CC100-33	Capacitor, Fixed, Ceramic	CC100-33
C12		Not Used	
C13	CC100-29	Capacitor, Fixed, Ceramic	CC100-29
C14		Same as C13	
C15	CM11F10G5S	Capacitor, Fixed, Ceramic	CC100-44
C16	CM11F20G5S	Same as C13	
CR1	IN914	Semiconductor, Dev., Diode	IN914
CR2	IN34A	Same as CR1	IN34A
CR3		Semiconductor, Dev., Diode	
CR6	IN961B		IN755A
CR7		Semiconductor, Dev., Diode	IN755A
CR8		Same as CR7	IN627
CR9	CL275-221	Semiconductor, Dev., Diode	IN627
CR13			IN754A
CR14		Semiconductor, Dev., Diode	CL275-102
L1	2N3646	Coil	CL275-221
L2		Coil	2N3646
Q1		Transistor	2N1711
Q2		Same as Q1	2N696
Q3		Transistor	
Q4		Transistor	
Q8	RC07GF102J	Same as Q3	RC07GF682J
Q9	RC07GF222J	Resistor, Fixed, Composition	RC07GF222J
R1	RC07GF683J	Resistor, Fixed, Composition	RC07GF471J
R2	RC07GF183J	Resistor, Fixed, Composition	RC07GF152J
R3	RC07GF332J	Resistor, Fixed, Composition	RC07GF102J
R4		Resistor, Fixed, Composition	RC07GF103J
R5		Resistor, Fixed, Composition	
R6	RC07GF152J	Resistor, Fixed, Composition	
R7	RC07GF223J	Same as R2	
R8	RC07GF472J	Same as R5	
R9		Same as R5	RC07GF472J
R10		Resistor, Fixed, Composition	RC07GF331J
R11		Resistor, Fixed, Composition	RC07GF223J
R12		Same as R6	
R13	CR18/AU-4 416667 MHZ	Same as R10	TZ216
R14		Same as R10	TZ218
		Same as R3	NW137
			RV124-1-102
			RC07GF473J
			RV119-2-103D
			RC07GF221J
			RC07GF104J
			RC07GF331J
			TZ216
			TZ218
			NW137

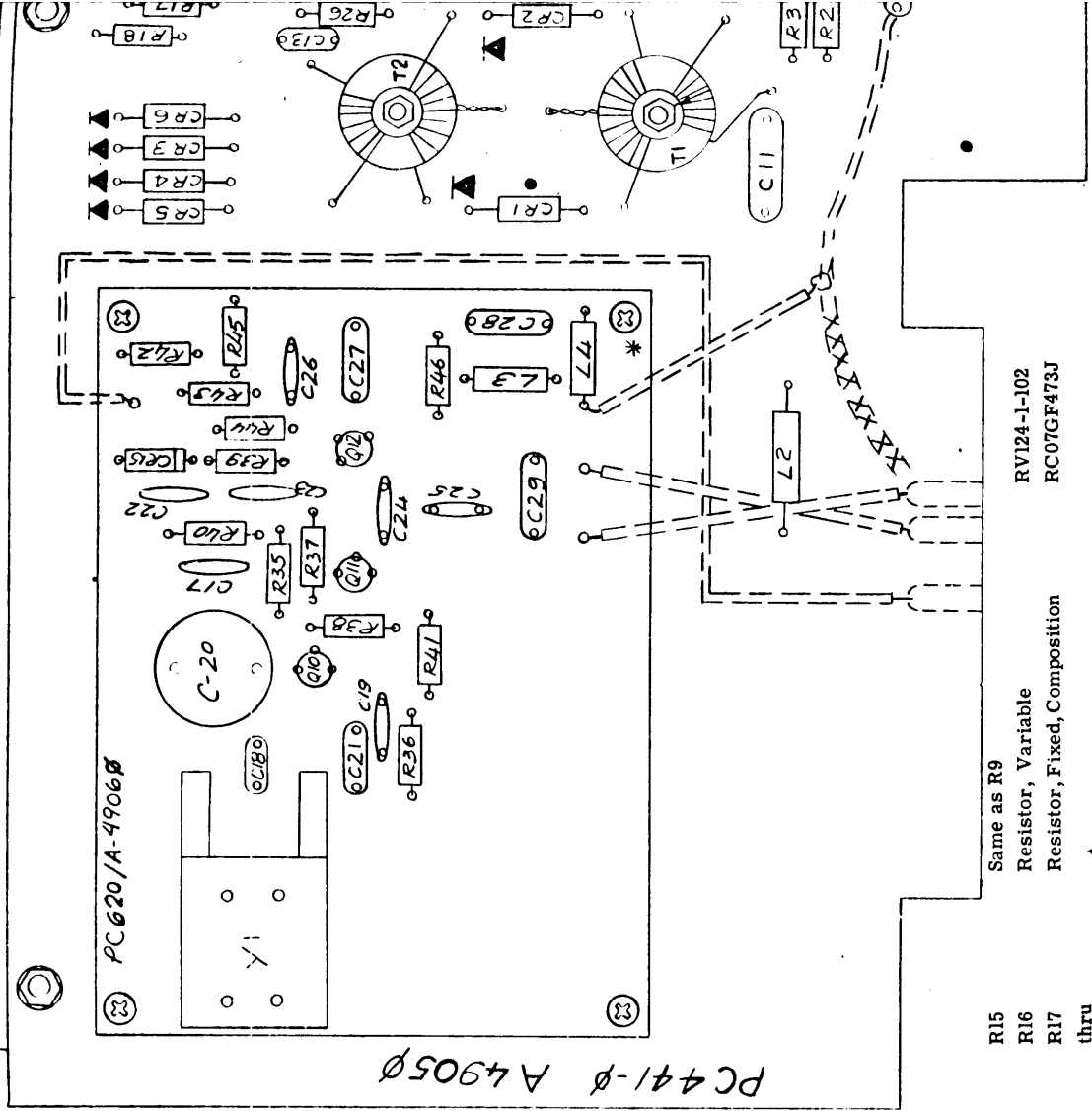
FIGURE 20. COMPONENT LOCATION AND PARTS LIST. FREQUENCY SHIFT GENERATOR/ OSCILLATOR-MIXER Z107

Parts List for A-4906

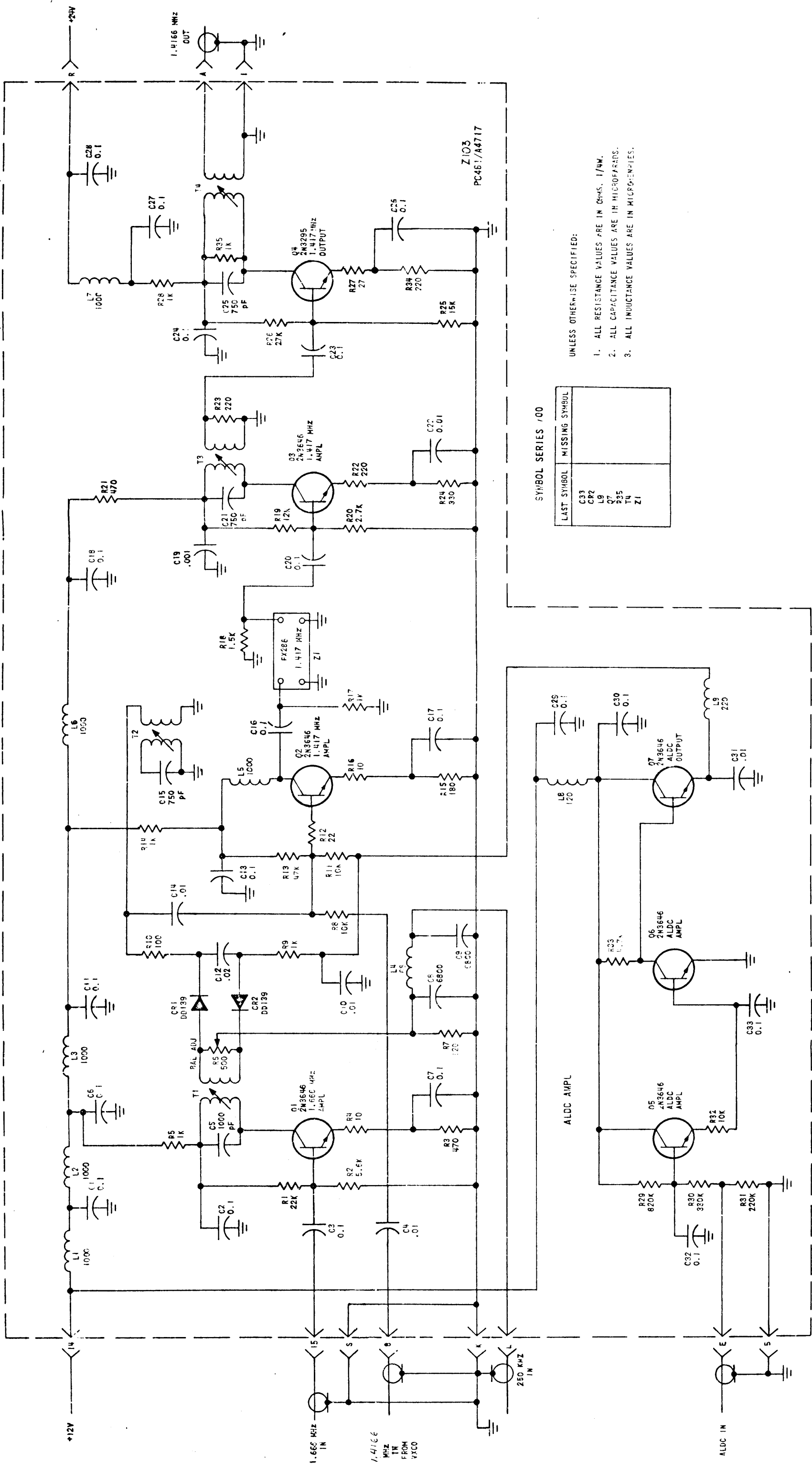
SYMBOL	DESCRIPTION	TMC P/N	SYMBOL	DESCRIPTION	TMC P/N
C1	Not Used		C1	Capacitor, Fixed, Ceramic	CC100-41
thru			thru		
C16			C4	Capacitor, Fixed, Ceramic	CC100-40
C17	Capacitor, Fixed, Ceramic	CC100-41	C5	Same as C1	
C18	Capacitor, Fixed, Mica	CM11F110G5S	C6	Capacitor, Fixed, Mica	CM11C050K5
C19	Same as C17		C7	Same as C5	
C20	Capacitor, Variable, Ceramic	CV109-9	C8	Same as C1	
C21	Capacitor, Fixed, Mica	CM11F221G5S	C9	Same as C1	
C22	Same as C17		C10	Same as C1	
C23	Same as C17		C11	Capacitor, Fixed, Ceramic	CC100-33
C24	Capacitor, Fixed, Ceramic	CC100-29	C12	Not Used	
C25	Same as C24		C13	Capacitor, Fixed, Ceramic	CC100-29
C26	Same as C17		C14	Same as C13	
C27	Capacitor, Fixed, Mica	CM11F101G5S	C15	Capacitor, Fixed, Ceramic	CC100-44
C28	Capacitor, Fixed, Mica	CM11F201G5S	C16	Same as C13	
C29	Same as C27		CR1	Semiconductor, Dev., Diode	IN914
CR1	Not Used		CR2	Same as CR1	
thru			CR3	Semiconductor, Dev., Diode	IN34A
CR14			thru		
CR15	Semiconductor, Dev., Diode	IN961B	CR6		
L1	Not Used		CR7	Semiconductor, Dev., Diode	IN755A
L2	Not Used		CR8	Same as CR7	
L3	Coil, RF	CL275-221	CR9	Semiconductor, Dev., Diode	IN627
L4	Same as L3		thru		
Q1	Not Used		CR13		
thru			CR14	Semiconductor, Dev., Diode	IN754A
Q9			L1	Coil	CL275-102
Q10	Semiconductor, Dev., Diode	2N3646	L2	Coil	CL275-221
thru			Q1	Transistor	2N3646
Q12			Q2	Same as Q1	
R1	Not Used		Q3	Transistor	2N1711
thru			Q4	Transistor	2N696
R34			thru		
R35	Resistor, Fixed, Composition	RC07GF102J	Q8		
R36	Resistor, Fixed, Composition	RC07GF222J	Q9	Same as Q3	
R37	Resistor, Fixed, Composition	RC07GF683J	R1	Resistor, Fixed, Composition	RC07GF682J
R38	Resistor, Fixed, Composition	RC07GF183J	R2	Resistor, Fixed, Composition	RC07GF222J
R39	Resistor, Fixed, Composition	RC07GF332J	R3	Resistor, Fixed, Composition	RC07GF471J
R40	Same as R35		R4	Resistor, Fixed, Composition	RC07GF152J
R41	Same as R35		R5	Resistor, Fixed, Composition	RC07GF102J
R42	Resistor, Fixed, Composition	RC07GF152J	R6	Resistor, Fixed, Composition	RC07GF103J
R43	Resistor, Fixed, Composition	RC07GF223J	R7	Same as R2	
R44	Resistor, Fixed, Composition	RC07GF472J	R8	Same as R5	
R45	Same as R42		R9	Resistor, Fixed, Composition	RC07GF472J
R46	Same as R35		R10	Resistor, Fixed, Composition	RC07GF223J
Y1	Crystal, Unit, Quartz	CR18/AU-4 418667 MHZ	R11	Same as R6	

Parts List for A-4905

SYMBOL	DESCRIPTION	TMC P/N	SYMBOL	DESCRIPTION	TMC P/N
C1	Capacitor, Fixed, Ceramic	CC100-41	C1	Capacitor, Fixed, Ceramic	CC100-41
thru			thru		
C4	Capacitor, Fixed, Ceramic	CC100-40	C4	Capacitor, Fixed, Ceramic	CC100-40
C5	Same as C1		C5	Same as C1	
C6	Capacitor, Fixed, Mica	CM11C050K5	C6	Capacitor, Fixed, Mica	CM11C050K5
C7	Same as C5		C7	Same as C5	
C8	Same as C1		C8	Same as C1	
C9	Same as C1		C9	Same as C1	
C10	Same as C1		C10	Same as C1	
C11	Capacitor, Fixed, Ceramic	CC100-33	C11	Capacitor, Fixed, Ceramic	CC100-33
C12	Not Used		C12	Not Used	
C13	Capacitor, Fixed, Ceramic	CC100-29	C13	Capacitor, Fixed, Ceramic	CC100-29
C14	Same as C13		C14	Same as C13	
C15	Capacitor, Fixed, Ceramic	CC100-44	C15	Capacitor, Fixed, Ceramic	CC100-44
C16	Same as C13		C16	Same as C13	
CR1	Semiconductor, Dev., Diode	IN914	CR1	Semiconductor, Dev., Diode	IN914
CR2	Same as CR1		CR2	Same as CR1	
CR3	Semiconductor, Dev., Diode	IN34A	CR3	Semiconductor, Dev., Diode	IN34A
thru			thru		
CR6			CR6		
CR7	Semiconductor, Dev., Diode	IN755A	CR7	Semiconductor, Dev., Diode	IN755A
CR8	Same as CR7		CR8	Same as CR7	
CR9	Semiconductor, Dev., Diode	IN627	CR9	Semiconductor, Dev., Diode	IN627
thru			thru		
CR13			CR13		
CR14	Semiconductor, Dev., Diode	IN754A	CR14	Semiconductor, Dev., Diode	IN754A
L1	Coil	CL275-102	L1	Coil	CL275-102
L2	Coil	CL275-221	L2	Coil	CL275-221
Q1	Transistor	2N3646	Q1	Transistor	2N3646
Q2	Same as Q1		Q2	Same as Q1	
Q3	Transistor	2N1711	Q3	Transistor	2N1711
Q4	Transistor	2N696	Q4	Transistor	2N696
thru			thru		
Q8			Q8		
Q9	Same as Q3		Q9	Same as Q3	
R1	Resistor, Fixed, Composition	RC07GF682J	R1	Resistor, Fixed, Composition	RC07GF682J
R2	Resistor, Fixed, Composition	RC07GF222J	R2	Resistor, Fixed, Composition	RC07GF222J
R3	Resistor, Fixed, Composition	RC07GF183J	R3	Resistor, Fixed, Composition	RC07GF183J
R4	Resistor, Fixed, Composition	RC07GF332J	R4	Resistor, Fixed, Composition	RC07GF332J
R5	Same as R35		R5	Same as R35	
R6	Same as R35		R6	Same as R35	
R7	Resistor, Fixed, Composition	RC07GF152J	R7	Resistor, Fixed, Composition	RC07GF152J
R8	Resistor, Fixed, Composition	RC07GF223J	R8	Resistor, Fixed, Composition	RC07GF223J
R9	Resistor, Fixed, Composition	RC07GF472J	R9	Resistor, Fixed, Composition	RC07GF472J
R10	Same as R42		R10	Same as R42	
R11	Same as R35		R11	Same as R35	
R12	Crystal, Unit, Quartz	CR18/AU-4 418667 MHZ	R12	Crystal, Unit, Quartz	CR18/AU-4 418667 MHZ
R13			R13		
R14			R14		



SYMBOL	DESCRIPTION	TMC P/N
R15	Same as R9	
R16	Resistor, Variable	RV124-1-102
R17	Resistor, Fixed, Composition	RC07GF473J
thru		
R20		
R21	Same as R1	
R22	Same as R1	
R23	Resistor, Variable	RV119-2-103D
R24	Same as R17	
R25	Same as R23	
R26	Same as R6	
R27	Resistor, Fixed, Composition	RC07GF221J
R28	Same as R1	
R29	Same as R23	
R30	Same as R6	
R31	Resistor, Fixed, Composition	RC07GF104J
R32	Same as R6	
R33	Resistor, Fixed, Composition	RC07GF331J
R34	Same as R5	
T1	Transformer, Rf	TZ216
T2	Transformer, Toroidal	TZ218
Z1	Network, Gate, Elect	NW137



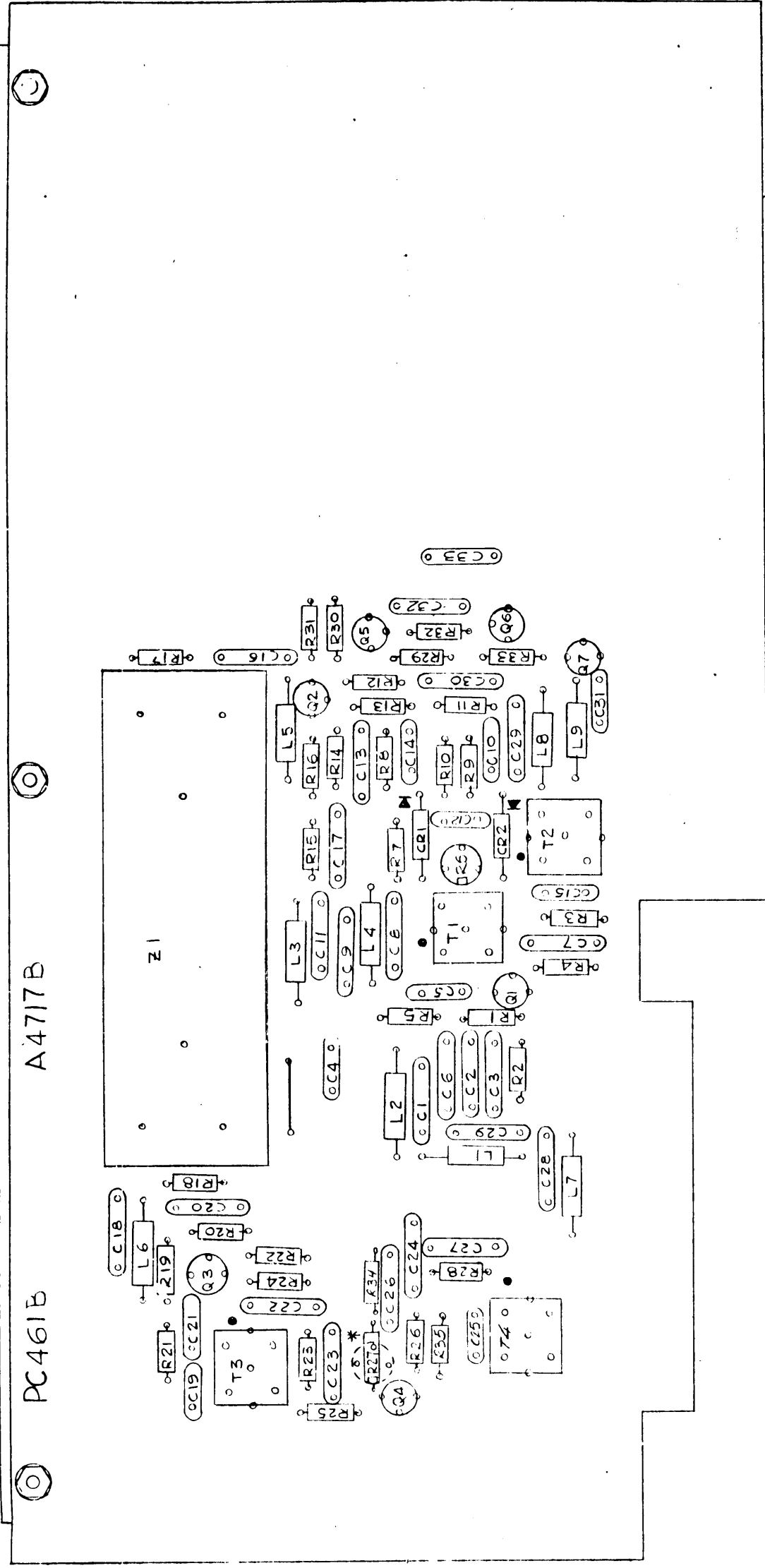
SYMBOL SERIES /00

LAST SYMBOL	MISSING SYMBOL
C33	
CR2	
L9	
Q7	
R35	
T4	
Z1	

- UNLESS OTHERWISE SPECIFIED:
1. ALL RESISTANCE VALUES ARE IN OHMS, I/100.
  2. ALL CAPACITANCE VALUES ARE IN MICROFARADS.
  3. ALL INDUCTANCE VALUES ARE IN MICROHENRIES.

FIGURE 21. SCHEMATIC DIAGRAM.  
CONVERTER/ALDC Z103





TMC P/N	Location	Description	Part Number
CC100-44	R3	Resistor, Fixed, Composition	RC07GF471J
CC100-42	R4	Resistor, Fixed, Composition	RC07GF100J
CM11F102F1	R5	Resistor, Fixed, Composition	RC07GF102J
CM11F682G3S	R6	Resistor, Variable	RV124-1-501
CC100-40	R7	Resistor, Fixed, Composition	RC07GF121J
CM11F75LJ3	R8	Resistor, Fixed, Composition	RC07GF103J
CC100-29	R9	Same as R5	RC07GF101J
CC100-28	R10	Resistor, Fixed, Composition	RC07GF220J
	R11	Same as R8	RC07GF473J
	R12	Resistor, Fixed, Composition	RC07GF181J
	R13	Resistor, Fixed, Composition	RC07GF152J
	R14	Resistor, Fixed, Composition	RC07GF123J
	R15	Resistor, Fixed, Composition	RC07GF272J
	R16	Same as R5	RC07GF221J
	R17	Same as R5	RC07GF331J
	R18	Resistor, Fixed, Composition	RC07GF153J
	R19	Resistor, Fixed, Composition	RC07GF273J
	R20	Resistor, Fixed, Composition	RC07GF270J
	R21	Same as R3	RC07GF824J
	R22	Resistor, Fixed, Composition	RC07GF334J
	R23	Same as R22	RC07GF224J
	R24	Resistor, Fixed, Composition	RC07GF472J
	R25	Resistor, Fixed, Composition	RC07GF151J
	R26	Resistor, Fixed, Composition	RC07GF151J
	R27	Resistor, Fixed, Composition	RC07GF151J
	R28	Same as R5	RC07GF151J
	R29	Resistor, Fixed, Composition	RC07GF151J
	R30	Resistor, Fixed, Composition	RC07GF151J
	R31	Resistor, Fixed, Composition	RC07GF151J
	R32	Same as R8	RC07GF151J
	R33	Resistor, Fixed, Composition	RC07GF151J
	R34	Same as R22	RC07GF151J
DD139	T1	Transformer, Variable	TT296-1
CL275-102	T2	Transformer, Variable	TT296-2
CL275-680	T3	Transformer, Variable	TT296-3
CL275-171	T4	Same as T3	TT296-3
CL275-221	Z1	Filter, Bandpass	FX286
2N3646			
2N3295			

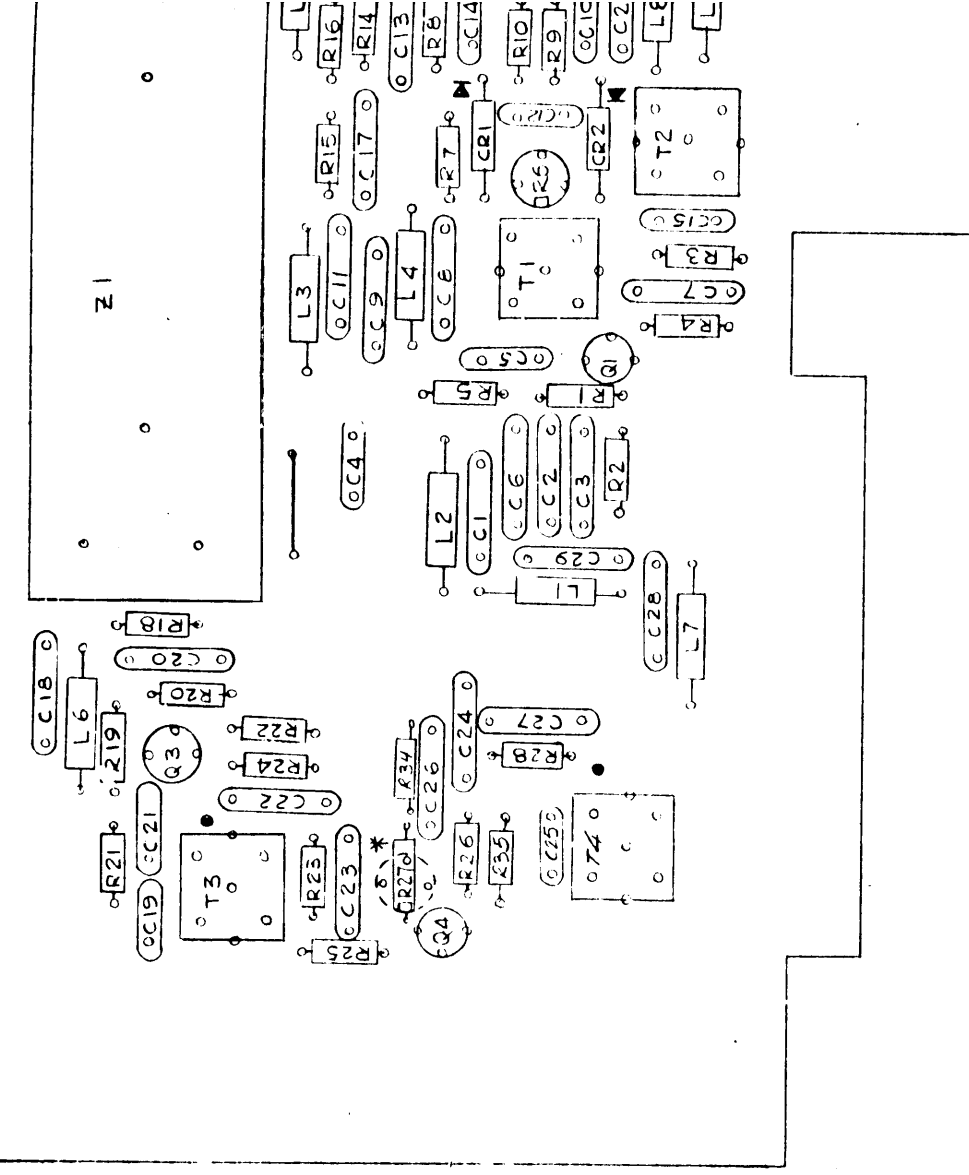
RC07GF223J  
RC07GF562J

FIGURE 22. COMPONENT LOCATION AND PARTS LIST.  
CONVERTER/ALDC Z103

PC461B

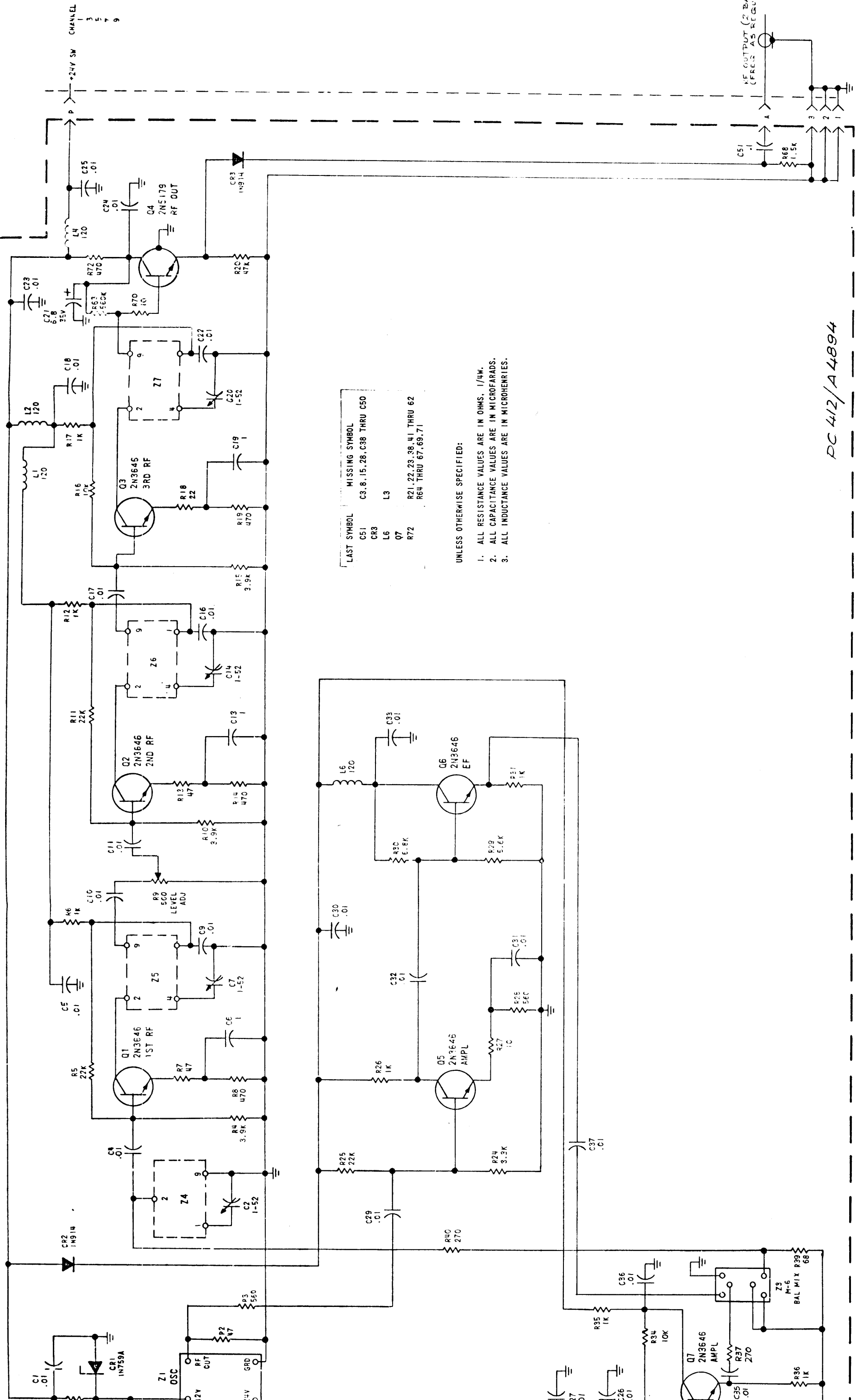
A4717B

Z1



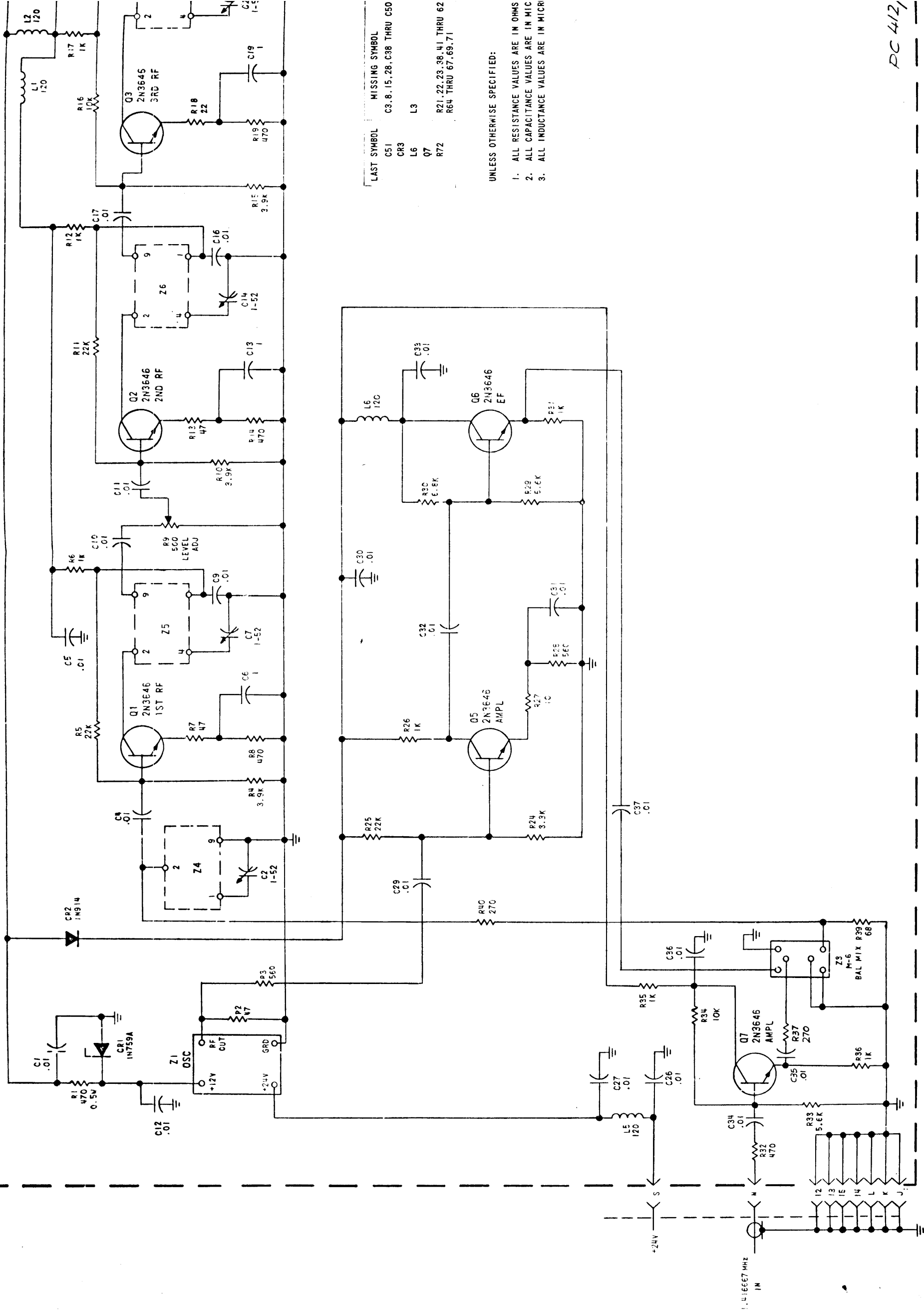
Parts List for A-4717

SYMBOL	DESCRIPTION	TMC P/N	R3	RC07GF471J
C1	Capacitor, Fixed, Ceramic	CC100-44	R4	RC07GF100J
C2	Same as C1		R5	RC07GF102J
C3	Same as C1		R6	RV124-1-501
C4	Capacitor, Fixed, Ceramic	CC100-42	R7	RC07GF121J
C5	Capacitor, Fixed, Mica	CM11F102F1	R8	RC07GF103J
C6	Same as C1		R9	Same as R5
C7	Same as C1		R10	RC07GF101J
C8	Capacitor, Fixed, Mica	CM11F682G3S	R11	Same as R8
C9	Same as C8		R12	RC07GF220J
C10	Same as C4		R13	RC07GF473J
C11	Same as C1		R14	Same as R5
C12	Capacitor, Fixed, Ceramic	CC100-40	R15	RC07GF181J
C13	Same as C1		R16	Same as R4
C14	Same as C4		R17	Same as R5
C15	Capacitor, Fixed, Mica	CM11F751J3	R18	RC07GF152J
C16	Same as C1		R19	RC07GF123J
thru			R20	RC07GF272J
C18			R21	Same as R3
C19	Capacitor, Fixed, Ceramic	CC100-29	R22	RC07GF221J
C20	Same as C1		R23	Same as R22
C21	Same as C15		R24	RC07GF331J
C22	Same as C4		R25	RC07GF153J
C23	Same as C1		R26	RC07GF273J
C24	Capacitor, Fixed, Ceramic	CC100-28	R27	RC07GF270J
C25	Same as C15		R28	Same as R5
C26	Same as C1		R29	RC07GF824J
C27	Same as C24		R30	RC07GF334J
C28	Same as C24		R31	RC07GF224J
C29	Same as C1		R32	Same as R8
C30	Same as C1		R33	RC07GF472J
C31	Same as C4		R34	Same as R22
C32	Same as C24		T1	TT296-1
C33	Same as C24		T2	TT296-2
CR1	Semiconductor, Device, Diode	DD139	T3	TT296-3
CR2	Same as CR1		T4	Same as T3
L1	Coil	CL275-102	Z1	FX286
thru				
L3	Coil	CL275-680		
L4	Same as L1			
L5	Same as L1			
thru				
L7	Coil	CL275-171		
L8	Coil	CL275-221		
L9	Coil	2N3646		
Q1	Transistor			
thru				
Q3	Transistor	2N3295		
Q4	Same as Q1			
Q5	Same as Q1			
thru				
Q7	Resistor, Fixed, Composition	RC07GF223J		
R1	Resistor, Fixed, Composition	RC07GF562J		
R2				



PC 412/A 4894

FIGURE 23. SCHEMATIC DIAGRAM.  
RF AMPLIFIERS Z101, Z102, Z111, Z112, Z113



LAST SYMBOL	MISSING SYMBOL
C51	C3, 8, 15, 28, C38 THRU C50
CR3	
L6	L3
Q7	
R72	R21, 22, 23, 38, 41 THRU 62 R64 THRU 67, 69, 71

UNLESS OTHERWISE SPECIFIED:  
 1. ALL RESISTANCE VALUES ARE IN OHMS  
 2. ALL CAPACITANCE VALUES ARE IN MIC  
 3. ALL INDUCTANCE VALUES ARE IN MICR

PC 4/12



TMC P/N

ON

Ceramic  
Plate, Glass

CC100-43  
CV116-2

Ceramic

CC100-28

Elect

CE122-6R8-35

Dev, Diode  
Dev, Diode

IN759A  
IN914

CL275-121

2N3646

2N5179

Composition  
Composition  
Composition  
Composition  
Composition  
Composition

RC20GF47LJ  
RC07GF470J  
RC07GF56LJ  
RC07GF392J  
RC07GF223J  
RC07GF102J

Composition  
Plate, Comp

RC07GF47LJ  
RV124-2-501

R10	Same as R4	
R11	Same as R5	
R12	Same as R6	
R13	Same as R2	
R14	Same as R8	
R15	Same as R4	
R16	Resistor, Fixed, Composition	RC07GF103J
R17	Same as R6	
R18	Resistor, Fixed, Composition	RC07GF220J
R19	Same as R8	
R20	Resistor, Fixed, Composition	RC07GF473J
R21	Not Used	
thru		
R23		
R24	Resistor, Fixed, Composition	RC07GF332J
R25	Same as R5	
R26	Same as R6	
R27	Resistor, Fixed, Composition	RC07GF100J
R28	Same as R3	
R29	Resistor, Fixed, Composition	RC07GF562J
R30	Resistor, Fixed, Composition	RC07GF682J
R31	Same as R6	
R32	Same as R8	
R33	Same as R29	
R34	Same as R16	
R35	Same as R6	
R36	Same as R6	
R37	Resistor, Fixed, Composition	RC07GF271J
R38	Not Used	
R39	Resistor, Fixed, Composition	RC07GF680J
R40	Same as R37	
R41	Not Used	
thru		
R62		
R63	Resistor, Fixed, Composition	RC07GF564J
R64	Not Used	
thru		
R67		
R68	Resistor, Fixed, Composition	RC07GF152J
R69	Not Used	
R70	Same as R27	
R71	Not Used	
R72	Same as R8	
* Z1	Oscillator	AO125
Z2	Not Used	
Z3	Network, Mixer, Unbalanced	NW163
* Z4	Transformer	TZ223
* Z5	Transformer	TZ225
* Z6	Same as Z5	
* Z7	Transformer	TZ226

\* Note: Frequency must be specified when ordering

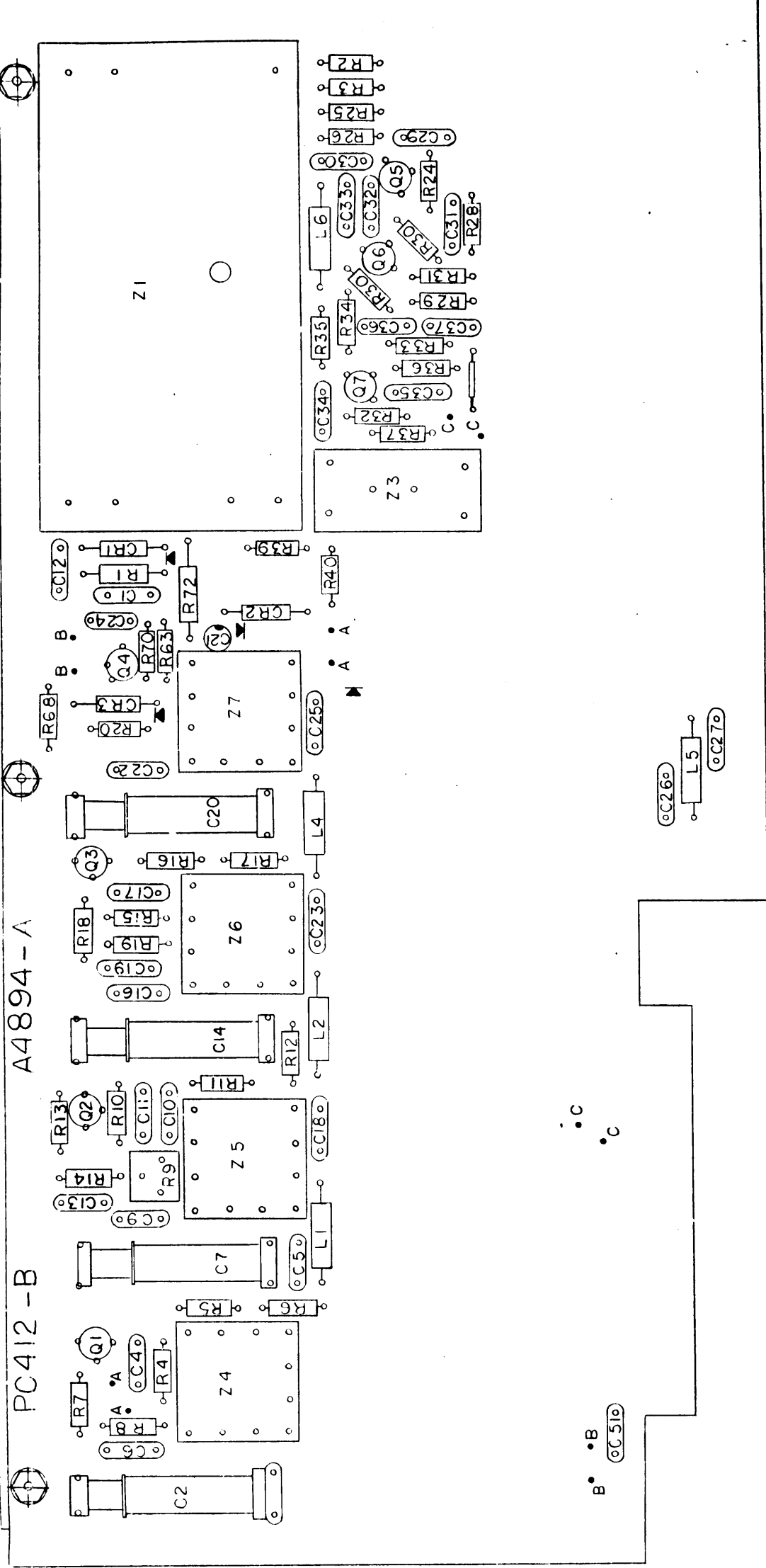
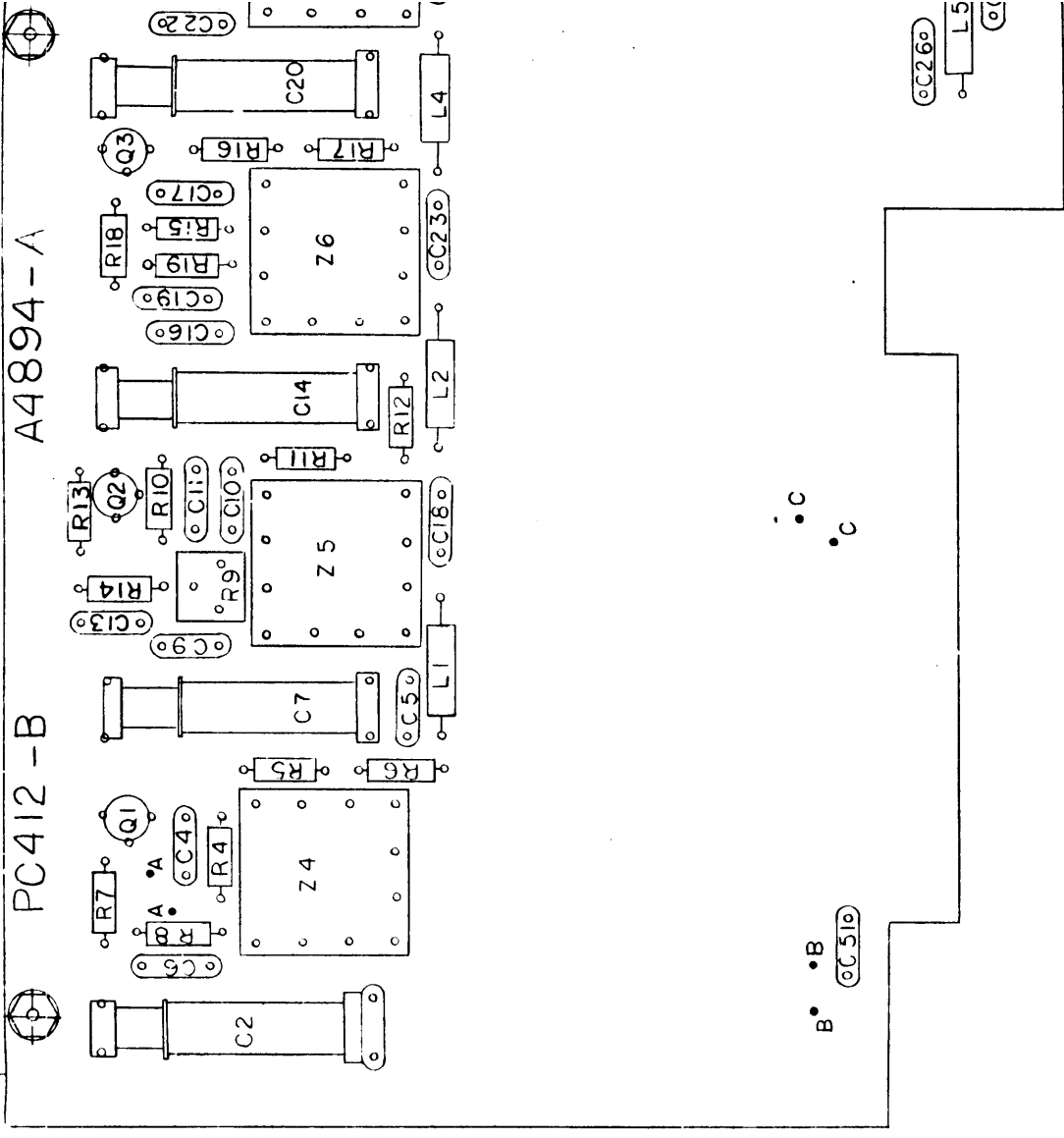


FIGURE 24. COMPONENT LOCATION AND PARTS LIST.  
RF AMPLIFIERS Z101, Z102, Z111, Z112, Z113

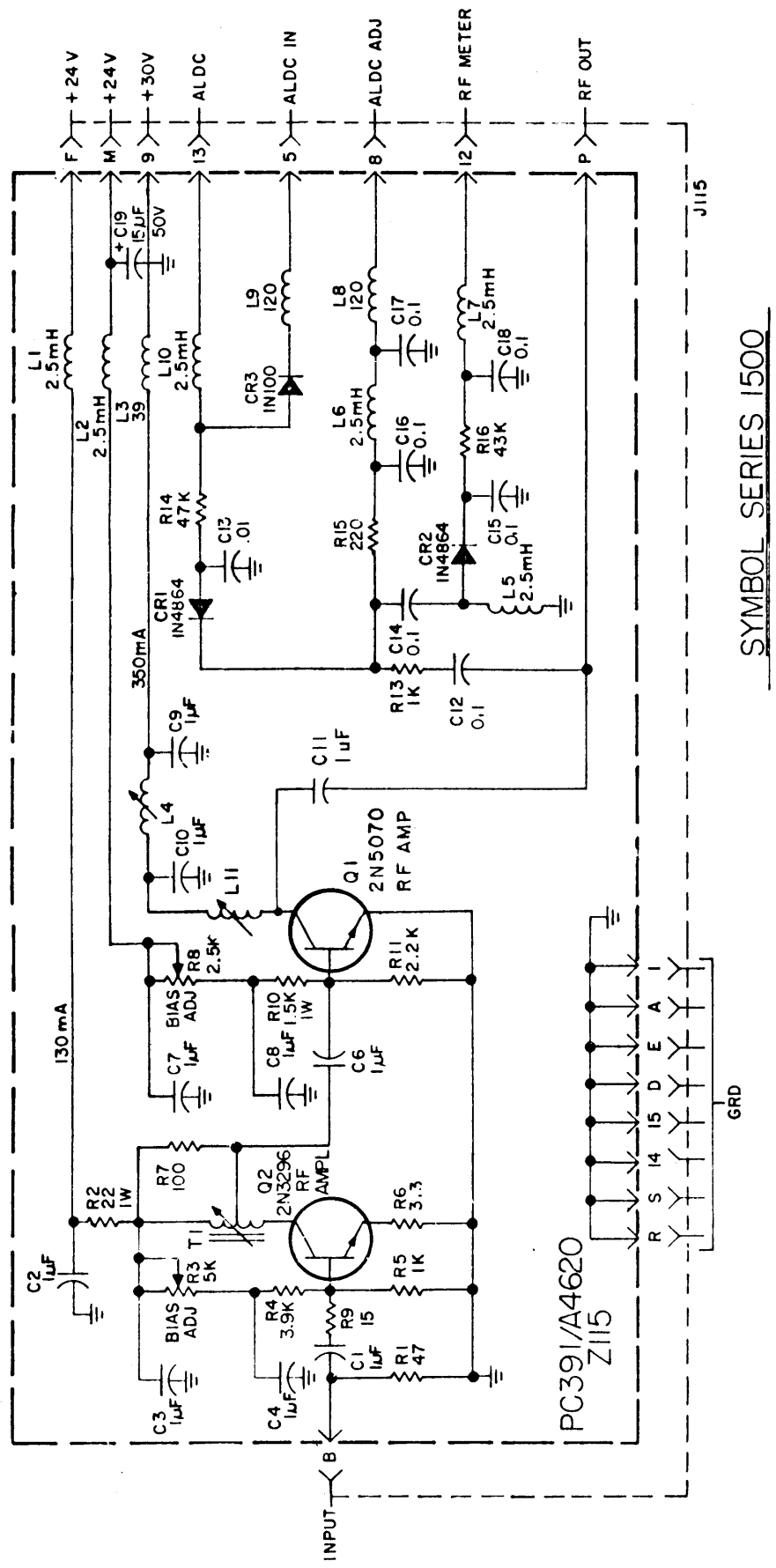
Parts List for A-4894

SYMBOL	DESCRIPTION	TMC P/N
C1	Capacitor, Fixed, Ceramic	CC100-43
C2	Capacitor, Variable, Glass	CV116-2
C3	Not Used	
C4	Same as C1	
C5	Same as C1	
C6	Capacitor, Fixed, Ceramic	CC100-28
C7	Same as C2	
C8	Not Used	
C9	Same as C1	
thru		
C12	Same as C6	
C13	Same as C2	
C14	Not Used	
C15	Same as C1	
C16	Same as C1	
C17	Same as C1	
C18	Same as C1	
C19	Same as C6	
C20	Same as C2	
C21	Capacitor, Fixed, Elec	CE122-6R8-35
C22	Same as C1	
thru		
C27	Not Used	
C28	Not Used	
C29	Same as C1	
thru		
C37	Not Used	
C38	Not Used	
thru		
C50	Same as C6	
C51	Semiconductor, Dev, Diode	IN759A
CR1	Semiconductor, Dev, Diode	IN914
CR2	Same as CR2	
CR3	Same as CR2	
L1	Coil	CL275-121
L2	Same as L1	
L3	Not Used	
L4	Same as L1	
thru		
L6	Not Used	
Q1	Transistor	2N3646
Q2	Same as Q1	
Q3	Same as Q1	
Q4	Transistor	2N5179
Q5	Same as Q1	
thru		
Q7	Not Used	
R1	Resistor, Fixed, Composition	RC20GF471J
R2	Resistor, Fixed, Composition	RC07GF470J
R3	Resistor, Fixed, Composition	RC07GF561J
R4	Resistor, Fixed, Composition	RC07GF392J
R5	Resistor, Fixed, Composition	RC07GF223J
R6	Resistor, Fixed, Composition	RC07GF102J
R7	Same as R2	
R8	Resistor, Fixed, Composition	RC07GF471J
R9	Resistor, Variable, Comp	RV124-2-501



\* Note: Frequency must be specified when ordering

LAST SYMBOLS	MISSING SYMBOLS
C19	C5
CR3	
L11	
Q2	R12
R16	
T1	



UNLESS OTHERWISE SPECIFIED:

- 1- ALL RESISTANCE VALUES ARE IN OHMS, 1/2 W.
- 2- ALL DECIMAL NUMBER CAPACITANCE VALUES ARE IN MICROFARADS.
- ALL WHOLE NUMBER VALUES ARE IN PICOFARADS.
- 3- ALL INDUCTANCE VALUES ARE IN MICROHENRIES.

FIGURE 25. SCHEMATIC DIAGRAM.  
RF OUTPUT ASSEMBLY Z115

Parts List for A-4620

SYMBOL	DESCRIPTION	TMC P/N
C1 thru C4	Capacitor, Fixed, Milz	CN114-1RO-5J
C5	Not Used	
C6 thru C11	Same as C1	
C12	Capacitor, Fixed, Ceramic	CC100-28
C13	Capacitor, Fixed, Ceramic	CC100-16
C14 thru C18	Same as C12	
C19	Capacitor, Fixed, Electrolytic	CE105-15-50
CR1	Semiconductor, Device, Diode	IN4864
CR2	Same as CR1	
CR3	Semiconductor, Device, Diode	IN100
L1	Coil, Rf, Fixed	CL140-1
L2	Same as L1	
L3	Coil, Rf, Fixed	CL270-39
L4	Choke, Rf, Adjust	CL240
L5 thru L7	Same as L1	
L8	Coil, Rf, Fixed	CL240-120
L9	Same as L8	
L10	Same as L1	
L11	Same as L4	
Q1	Transistor	2N5070
Q2	Transistor	2N3296
R1	Resistor, Fixed, Composition	RC20GF470J
R2	Resistor, Fixed, Composition	RC32GF220J
R3	Resistor, Variable	RV124-1-502
R4	Resistor, Fixed, Composition	RC20GF392J
R5	Resistor, Fixed, Composition	RC20GF102J
R6	Resistor, Fixed, Composition	RC20GF3R3J
R7	Resistor, Fixed, Composition	RC20GF101J
R8	Resistor, Variable	RV124-1-252
R9	Resistor, Fixed, Composition	RC20GF150J
R10	Resistor, Fixed, Composition	RC32GF152J
R11	Resistor, Fixed, Composition	RC20GF222J
R12	Not Used	
R13	Same as R5	
R14	Resistor, Fixed, Composition	RC20GF473J
R15	Resistor, Fixed, Composition	RC20GF221J
R16	Resistor, Fixed, Composition	RC20GF433J
T1	Transformer, Rf, Adjust	TT288

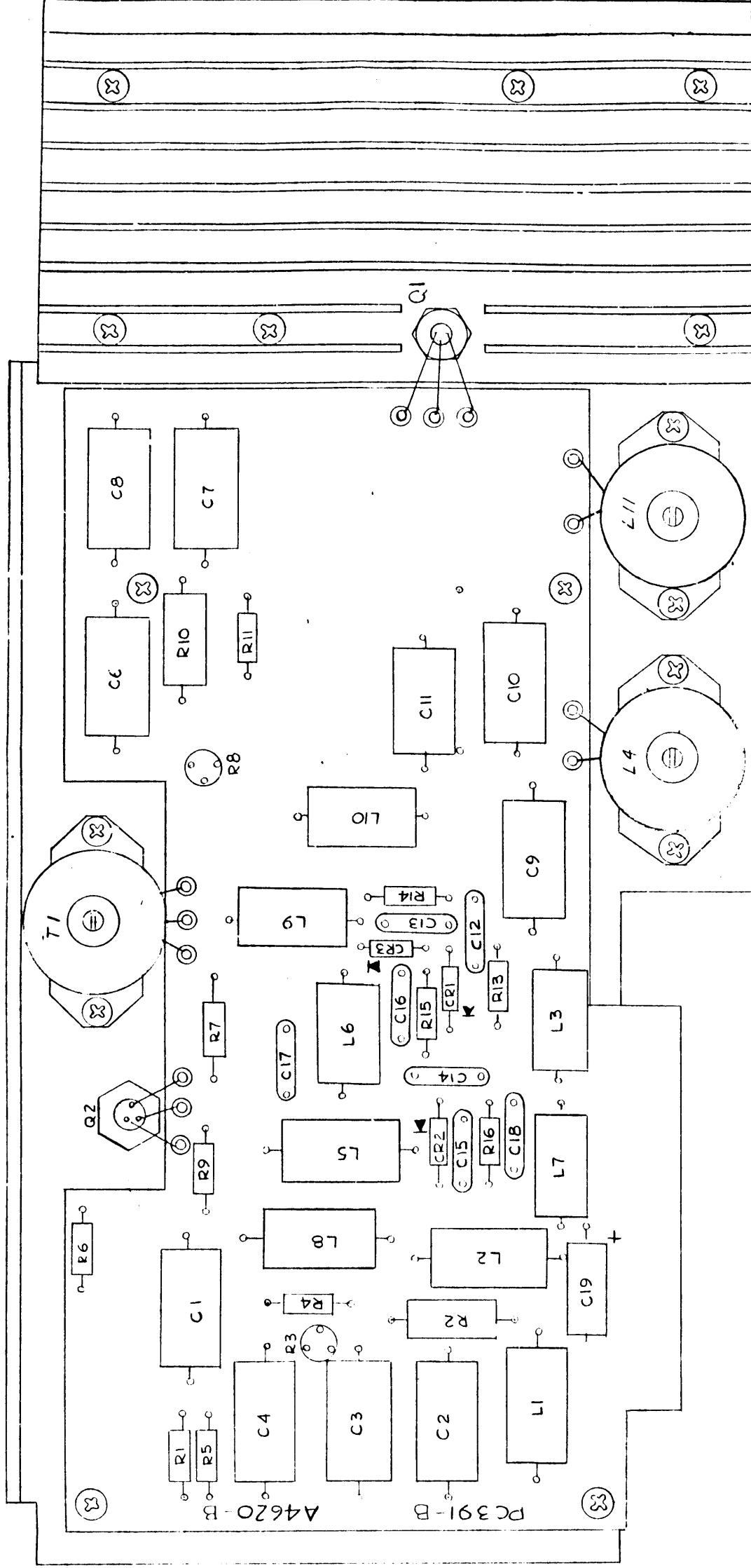
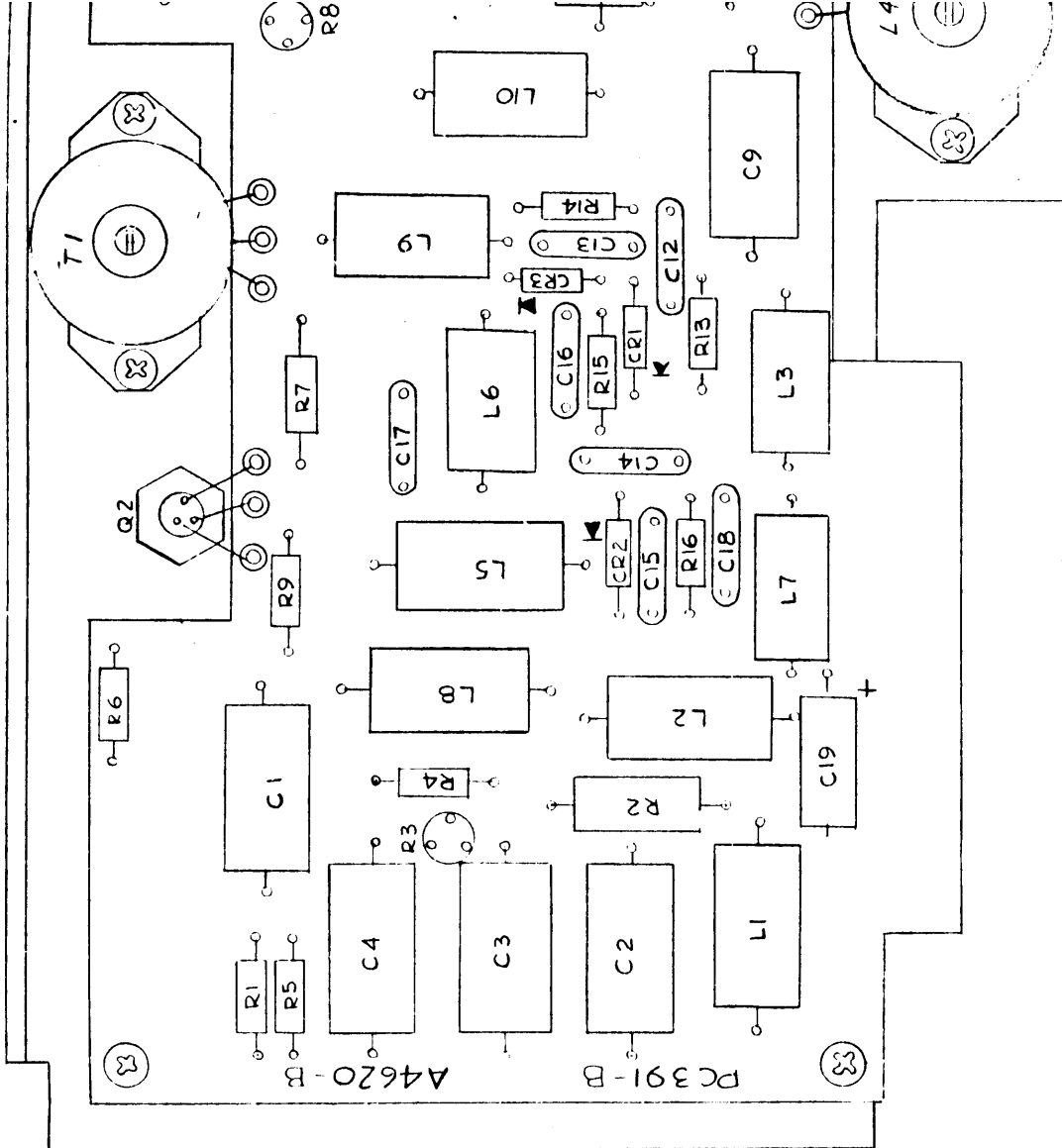


FIGURE 26. COMPONENT LOCATION AND PARTS LIST.  
RF OUTPUT ASSEMBLY Z115

Parts List for A-4620

SYMBOL	DESCRIPTION	TMC P/N
C1	Capacitor, Fixed, MilZ	CNI14-IR0-5J
thru C4	Not Used	
C5	Same as C1	
C6	Same as C1	
thru C11	Capacitor, Fixed, Ceramic	CC100-28
C12	Capacitor, Fixed, Ceramic	CC100-16
C13	Same as C12	
C14	Same as C12	
thru C18	Capacitor, Fixed, Electrolytic	CE105-15-50
C19	Semiconductor, Device, Diode	IN4864
CR1	Same as CR1	
CR2	Semiconductor, Device, Diode	INI00
CR3	Coil, Rf, Fixed	CL140-1
L1	Same as L1	
L2	Coil, Rf, Fixed	CL270-39
L3	Choke, Rf, Adjust	CL240
L4	Same as L1	
L5	Same as L1	
thru L7	Coil, Rf, Fixed	CL240-120
L8	Same as L8	
L9	Same as L1	
L10	Same as L1	
L11	Same as L4	
Q1	Transistor	2N5070
Q2	Transistor	2N3296
R1	Resistor, Fixed, Composition	RC20GF470J
R2	Resistor, Fixed, Composition	RC32GF220J
R3	Resistor, Variable	RV124-1-502
R4	Resistor, Fixed, Composition	RC20GF392J
R5	Resistor, Fixed, Composition	RC20GF102J
R6	Resistor, Fixed, Composition	RC20GF3R3J
R7	Resistor, Fixed, Composition	RC20GF10J
R8	Resistor, Variable	RV124-1-252
R9	Resistor, Fixed, Composition	RC20GF150J
R10	Resistor, Fixed, Composition	RC32GF152J
R11	Resistor, Fixed, Composition	RC20GF222J
R12	Not Used	
R13	Same as R5	
R14	Resistor, Fixed, Composition	RC20GF473J
R15	Resistor, Fixed, Composition	RC20GF221J
R16	Resistor, Fixed, Composition	RC20GF433J
T1	Transformer, Rf, Adjust	TT288



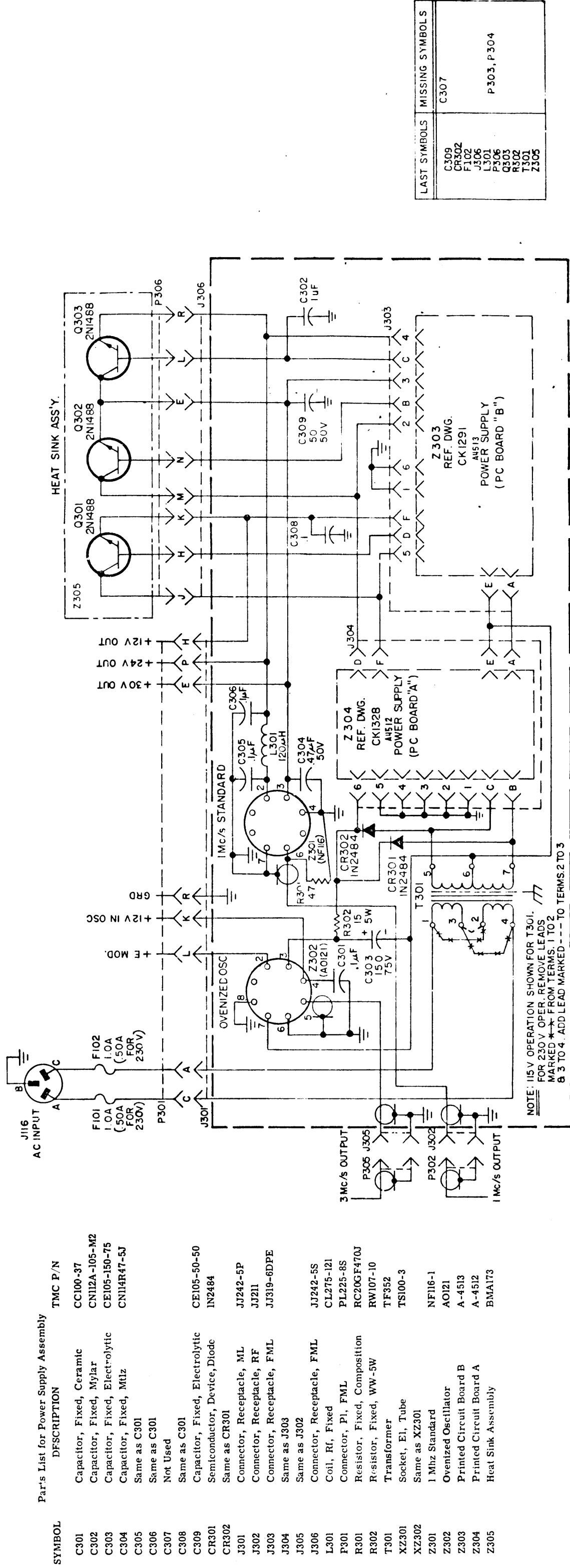
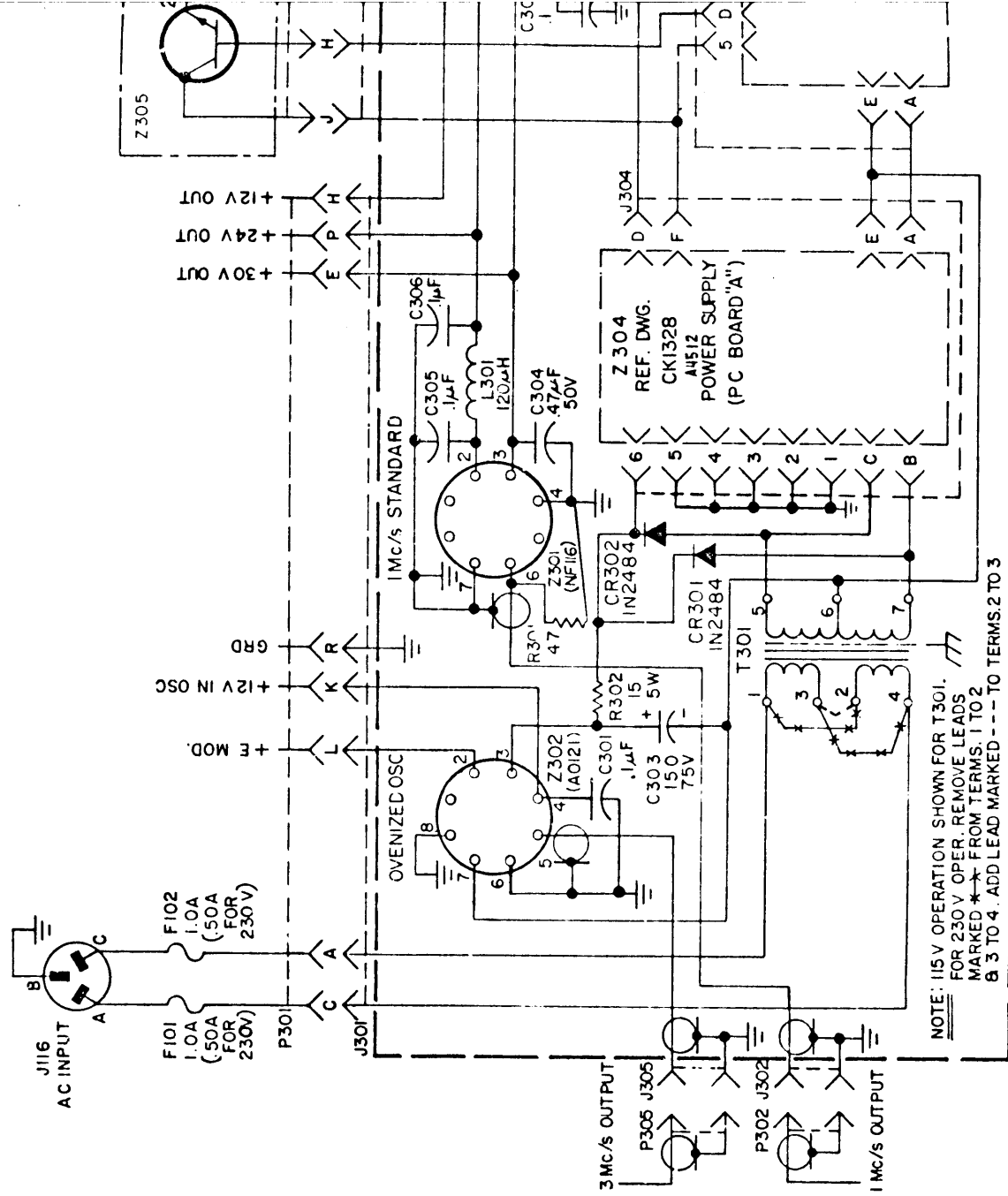


FIGURE 27. OVERALL SCHEMATIC DIAGRAM AND PARTS LIST.  
POWER SUPPLY ASSEMBLY Z300 SERIES

Part's List for Power Supply Assembly

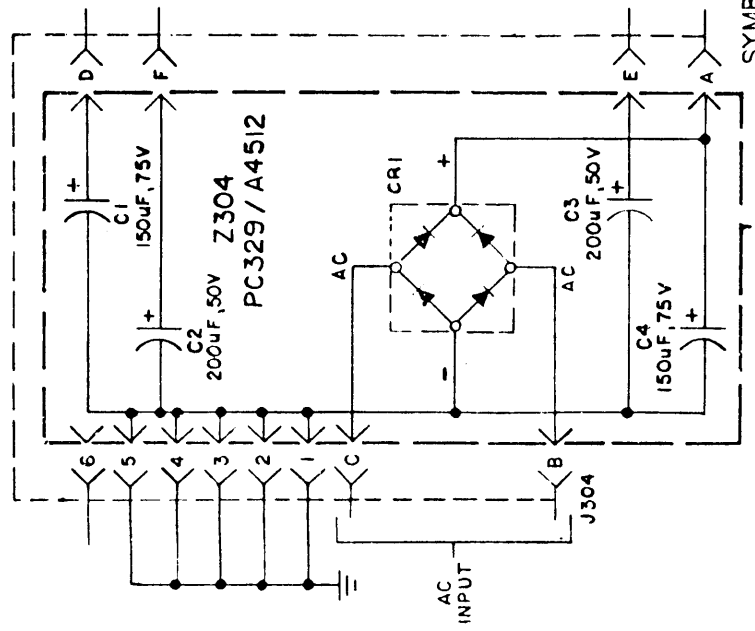
SYMBOL	DESCRIPTION	TMC P/N
C301	Capacitor, Fixed, Ceramic	CC100-37
C302	Capacitor, Fixed, Mylar	CN112A-105-M2
C303	Capacitor, Fixed, Electrolytic	CE105-150-75
C304	Capacitor, Fixed, Mtlz	CN114R47-5J
C305	Same as C301	
C306	Same as C301	
C307	Not Used	
C308	Same as C301	
C309	Capacitor, Fixed, Electrolytic	CE105-50-50
CR301	Semiconductor, Device, Diode	IN2484
CR302	Same as CR301	
J301	Connector, Receptacle, ML	JJ242-5P
J302	Connector, Receptacle, RF	JJ211
J303	Connector, Receptacle, FML	JJ319-6DPE
J304	Same as J303	
J305	Same as J302	
J306	Connector, Receptacle, FML	JJ242-5S
L301	Coil, Rf, Fixed	CL275-121
P301	Connector, Pl, FML	PL225-8S
R301	Resistor, Fixed, Composition	RC20GF470J
R302	Resistor, Fixed, WW-5W	RW107-10
T301	Transformer	TF352
XZ301	Socket, El, Tube	TS100-3
XZ302	Same as XZ301	
Z301	1 Mhz Standard	NF116-1
Z302	Ovenized Oscillator	AO121
Z303	Printed Circuit Board B	A-4513
Z304	Printed Circuit Board A	A-4512
Z305	Heat Sink Assembly	BMA173



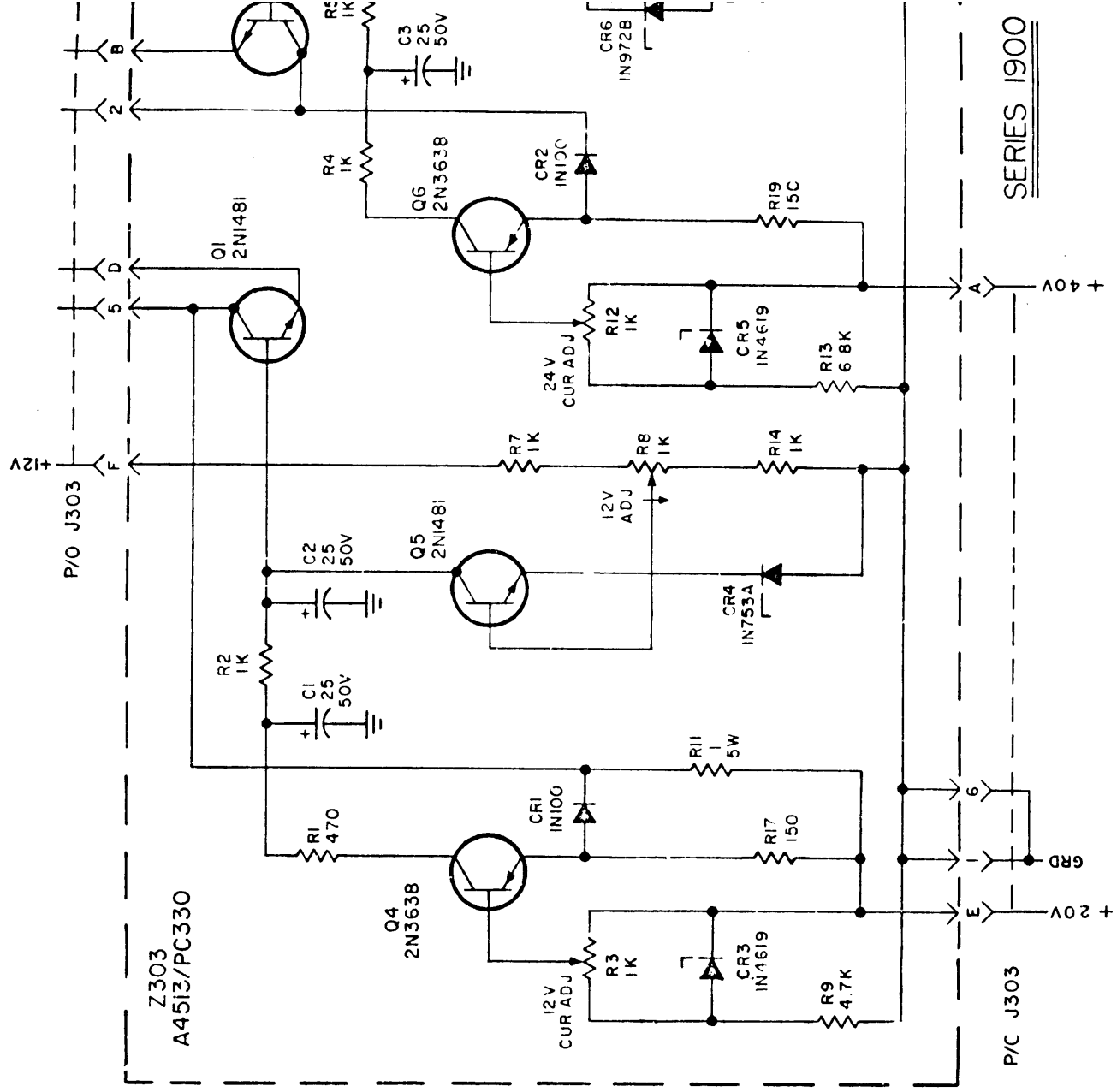
NOTE: 115V OPERATION SHOWN FOR T301.  
FOR 230V OPER. REMOVE LEADS  
MARKED \* FROM TERMS. 1 TO 2  
& 3 TO 4. ADD LEAD MARKED --- TO TERMS. 2 TO 3







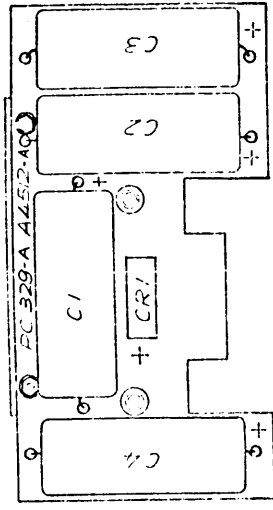
SYMBOL SERIES 1800



SERIES 1900

Parts List for Power Supply Board A

SYMBOL	DESCRIPTION	TMC P/N
C1	Capacitor, Fixed, Electrolytic	CE105-150-75
C2	Capacitor, Fixed, Electrolytic	CE105-200-50
C3	Same as C2	
C4	Same as C1	
CR1	Semiconductor, Rectifier	DD146-6



Parts List for Power Supply Board B

SYMBOL	DESCRIPTION	TMC P/N
C1	Capacitor, Fixed, Electrolytic	CE107-6
thru		
C5		
CR1	Semiconductor, Device, Diode	IN100
CR2	Same as CR1	
CR3	Semiconductor, Device, Diode	IN4619
CR4	Semiconductor, Device, Diode	IN753A
CR5	Same as CR3	
CR6	Semiconductor, Device, Diode	IN972B
CR7	Same as CR4	
Q1	Transistor	2N1481
thru		
Q3		
Q4	Transistor	2N3638
Q5	Same as Q1	
Q6	Same as Q4	
Q7	Same as Q1	
R1	Resistor, Fixed, Composition	RC07GF47J
R2	Resistor, Fixed, Composition	RC07GF102J
R3	Resistor, Variable, Composition	RV124-1-102
R4	Same as R2	
R5	Same as R2	
R6	Resistor, Fixed, Composition	RC07GF103J
R7	Same as R2	
R8	Same as R3	
R9	Resistor, Fixed, Composition	RC07GF472J
R10	Resistor, Fixed, Composition	RC07GF152J
R11	Resistor, Fixed, WW-5W	RR14-1-0W
R12	Same as R3	
R13	Resistor, Fixed, Composition	RC07GF682J
R14	Same as R2	
R15	Not Used	
R16	Same as R9	
R17	Resistor, Fixed, Composition	RC07GF15J
R18	Resistor, Variable, Composition	RV124-1-103
R19	Same as R17	

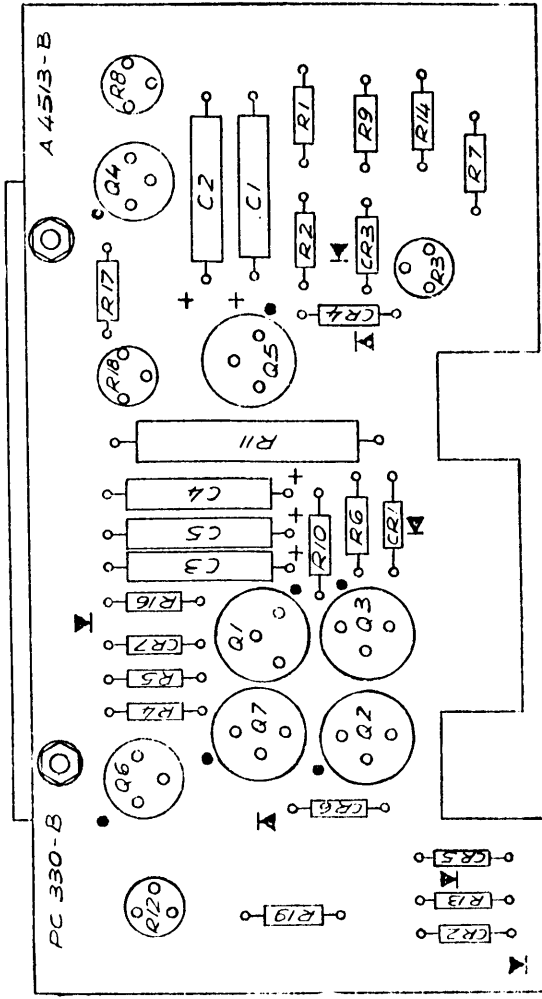


FIGURE 29. COMPONENT LOCATIONS AND PARTS LIST.  
POWER SUPPLY A Z304, POWER SUPPLY B Z303